

# Kinetis K22F 128 KB/256 KB Flash 64-pin WLCSP

120 MHz ARM® Cortex®-M4-Based Microcontroller with FPU

The Kinetis K22 WLCSP product family members are optimized for space-constrained, cost-sensitive applications requiring low power, USB connectivity, and processing efficiency with a floating point unit. These devices share the comprehensive enablement and scalability of the Kinetis family. This product offers:

- Run power consumption down to 153  $\mu$ A/MHz and static power consumption down to 2.6  $\mu$ A with full state retention and 6  $\mu$ s wakeup. Lowest static mode down to 120 nA
- USB LS/FS OTG 2.0 w/ embedded 3.3 V, 120 mA LDO voltage regulator. USB FS device crystal-less functionality.

**MK22FN256CAH12R**  
**MK22FN128CAH12R**



64 WLCSP (AH)  
3.36 x 3.33 x 0.56 Pitch 0.4 mm

## Performance

- 120 MHz ARM® Cortex®-M4 core with DSP instructions delivering 1.25 Dhrystone MIPS per MHz

## Memories and memory interfaces

- Up to 256 KB of embedded flash and 48 KB of RAM
- Serial programming interface (EzPort)
- Preprogrammed Kinetis flashloader for one-time, in-system factory programming

## System peripherals

- Flexible low-power modes, multiple wake up sources
- 16-channel DMA controller
- Independent external and software watchdog monitor

## Clocks

- Two crystal oscillators: 32 kHz (RTC) and 32-40 kHz or 3-32 MHz
- Three internal oscillators: 32kHz, 4MHz, and 48MHz
- Multipurpose clock generator with PLL and FLL

## Security and integrity modules

- Hardware CRC module
- 128-bit unique identification (ID) number per chip
- Hardware random-number generator
- Flash access control to protect proprietary software

## Human-machine interface

- Up to 40 general-purpose I/O (GPIO)

## Analog modules

- Two 16-bit SAR ADCs (1.2 MS/s in 12-bit mode)
- One 12-bit DAC
- Two analog comparators (CMP) with 6-bit DAC
- Accurate internal voltage reference

## Communication interfaces

- USB LS/FS OTG 2.0 with on-chip transceiver and USB LDO voltage regulator
- USB full-speed device crystal-less operation
- Two SPI modules
- Three UART modules and one low-power UART
- Two I2C: Support for up to 1 Mbps operation
- I2S module

## Timers

- One 8-ch general-purpose PWM timer
- Two 2-ch general-purpose timers with quadrature decoder functionality
- Periodic interrupt timers
- 16-bit low-power timer
- Real-time clock with independent power domain
- Programmable delay block

## Operating Characteristics

- Voltage range (including flash writes): 1.71 to 3.6 V
- Temperature range (ambient): -40 to 85°C



### Ordering Information

| Part Number     | Memory     |           | Number of GPIOs |
|-----------------|------------|-----------|-----------------|
|                 | Flash (KB) | SRAM (KB) |                 |
| MK22FN256CAH12R | 256        | 48        | 40              |
| MK22FN128CAH12R | 128        | 48        | 40              |

### Device Revision Number

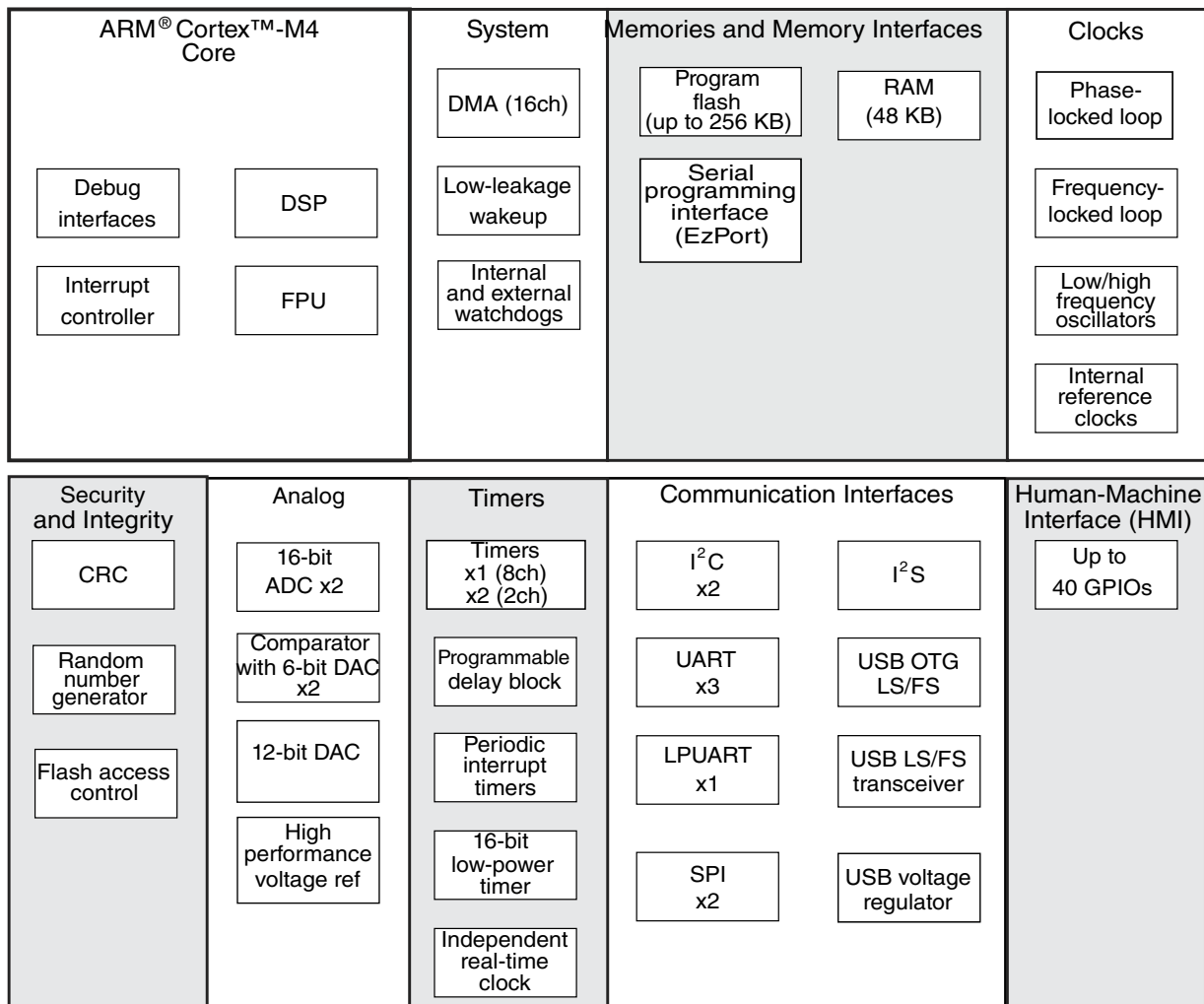
| Device Mask Set Number | SIM_SDID[REVID] | JTAG ID Register[PRN] |
|------------------------|-----------------|-----------------------|
| 0N51M                  | 0001            | 0001                  |

### Related Resources

| Type             | Description                                                                                                                                | Document                                                                                                                            |
|------------------|--------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| Selector Guide   | The NXP Solution Advisor is a web-based tool that features interactive application wizards and a dynamic product selector                  | <a href="#">KINETISKMCUSELGD</a>                                                                                                    |
| Reference Manual | The Reference Manual contains a comprehensive description of the structure and function (operation) of a device.                           | <a href="#">K22P121M120SF8RM</a>                                                                                                    |
| Data Sheet       | The Data Sheet is this document. It includes electrical characteristics and signal connections.                                            | <a href="#">K22P64M120SF8</a>                                                                                                       |
| Chip Errata      | The chip mask set Errata provides additional or corrective information for a particular device mask set.                                   | KINETIS_K_xN51M <sup>1</sup>                                                                                                        |
| Package drawing  | Package dimensions are provided by part number: <ul style="list-style-type: none"> <li>MK22FN256CAH12R</li> <li>MK22FN128CAH12R</li> </ul> | Package drawing: <ul style="list-style-type: none"> <li><a href="#">98ASA00650D</a></li> <li><a href="#">98ASA00650D</a></li> </ul> |

1. To find the associated resource, go to [nxp.com](http://nxp.com) and perform a search using this term with the x replaced by the revision of the device you are using.

[Figure 1](#) shows the functional modules in the chip.



**Figure 1. Functional block diagram**

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# 1 Ratings

## 1.1 Thermal handling ratings

| Symbol           | Description                   | Min. | Max. | Unit | Notes |
|------------------|-------------------------------|------|------|------|-------|
| T <sub>STG</sub> | Storage temperature           | −55  | 150  | °C   | 1     |
| T <sub>SDR</sub> | Solder temperature, lead-free | —    | 260  | °C   | 2     |

1. Determined according to JEDEC Standard JESD22-A103, *High Temperature Storage Life*.
2. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

## 1.2 Moisture handling ratings

| Symbol | Description                | Min. | Max. | Unit | Notes |
|--------|----------------------------|------|------|------|-------|
| MSL    | Moisture sensitivity level | —    | 1    | —    | 1     |

1. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

## 1.3 ESD handling ratings

| Symbol           | Description                                           | Min.  | Max.  | Unit | Notes |
|------------------|-------------------------------------------------------|-------|-------|------|-------|
| V <sub>HBM</sub> | Electrostatic discharge voltage, human body model     | −2000 | +2000 | V    | 1     |
| V <sub>CDM</sub> | Electrostatic discharge voltage, charged-device model | −500  | +500  | V    | 2     |
| I <sub>LAT</sub> | Latch-up current at ambient temperature of 105°C      | −100  | +100  | mA   | 3     |

1. Determined according to JEDEC Standard JESD22-A114, *Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)*.
2. Determined according to JEDEC Standard JESD22-C101, *Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components*.
3. Determined according to JEDEC Standard JESD78, *IC Latch-Up Test*.

## 1.4 Voltage and current operating ratings

## General

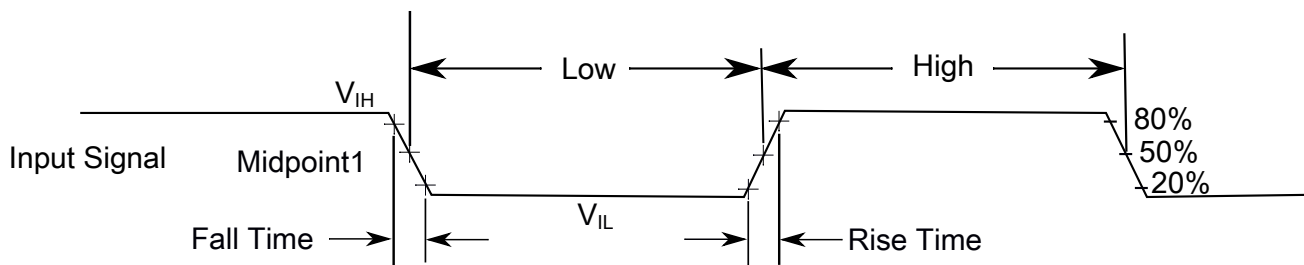
| Symbol         | Description                                                    | Min.           | Max.           | Unit |
|----------------|----------------------------------------------------------------|----------------|----------------|------|
| $V_{DD}$       | Digital supply voltage                                         | -0.3           | 3.8            | V    |
| $I_{DD}$       | Digital supply current                                         | —              | 158            | mA   |
| $V_{DIO}$      | Digital input voltage                                          | -0.3           | $V_{DD} + 0.3$ | V    |
| $V_{AIO}$      | Analog <sup>1</sup>                                            | -0.3           | $V_{DD} + 0.3$ | V    |
| $I_D$          | Maximum current single pin limit (applies to all digital pins) | -25            | 25             | mA   |
| $V_{DDA}$      | Analog supply voltage                                          | $V_{DD} - 0.3$ | $V_{DD} + 0.3$ | V    |
| $V_{USB0\_DP}$ | USB0_DP input voltage                                          | -0.3           | 3.63           | V    |
| $V_{USB0\_DM}$ | USB0_DM input voltage                                          | -0.3           | 3.63           | V    |
| VREGIN         | USB regulator input                                            | -0.3           | 6.0            | V    |
| $V_{BAT}$      | RTC battery supply voltage                                     | -0.3           | 3.8            | V    |

1. Analog pins are defined as pins that do not have an associated general purpose I/O port function.

## 2 General

### 2.1 AC electrical characteristics

Unless otherwise specified, propagation delays are measured from the 50% to the 50% point, and rise and fall times are measured at the 20% and 80% points, as shown in the following figure.



The midpoint is  $V_{IL} + (V_{IH} - V_{IL}) / 2$

**Figure 2. Input signal measurement reference**

### 2.2 Nonswitching electrical specifications

## 2.2.1 Voltage and current operating requirements

**Table 1. Voltage and current operating requirements**

| Symbol             | Description                                                                                                                                                                                                                                | Min.                 | Max.                 | Unit | Notes |
|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|----------------------|------|-------|
| $V_{DD}$           | Supply voltage                                                                                                                                                                                                                             | 1.71                 | 3.6                  | V    |       |
| $V_{DDA}$          | Analog supply voltage                                                                                                                                                                                                                      | 1.71                 | 3.6                  | V    |       |
| $V_{DD} - V_{DDA}$ | $V_{DD}$ -to- $V_{DDA}$ differential voltage                                                                                                                                                                                               | -0.1                 | 0.1                  | V    |       |
| $V_{SS} - V_{SSA}$ | $V_{SS}$ -to- $V_{SSA}$ differential voltage                                                                                                                                                                                               | -0.1                 | 0.1                  | V    |       |
| $V_{BAT}$          | RTC battery supply voltage                                                                                                                                                                                                                 | 1.71                 | 3.6                  | V    |       |
| $V_{IH}$           | Input high voltage <ul style="list-style-type: none"> <li><math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math></li> <li><math>1.7\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math></li> </ul>                                              | $0.7 \times V_{DD}$  | —                    | V    |       |
|                    |                                                                                                                                                                                                                                            | $0.75 \times V_{DD}$ | —                    | V    |       |
| $V_{IL}$           | Input low voltage <ul style="list-style-type: none"> <li><math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math></li> <li><math>1.7\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math></li> </ul>                                               | —                    | $0.35 \times V_{DD}$ | V    |       |
|                    |                                                                                                                                                                                                                                            | —                    | $0.3 \times V_{DD}$  | V    |       |
| $V_{HYS}$          | Input hysteresis                                                                                                                                                                                                                           | $0.06 \times V_{DD}$ | —                    | V    |       |
| $I_{ICIO}$         | Analog and I/O pin DC injection current — single pin <ul style="list-style-type: none"> <li><math>V_{IN} &lt; V_{SS} - 0.3\text{V}</math> (Negative current injection)</li> </ul>                                                          | -3                   | —                    | mA   | 1     |
| $I_{ICcont}$       | Contiguous pin DC injection current — regional limit, includes sum of negative injection currents or sum of positive injection currents of 16 contiguous pins <ul style="list-style-type: none"> <li>Negative current injection</li> </ul> | -25                  | —                    | mA   |       |
| $V_{ODPU}$         | Open drain pullup voltage level                                                                                                                                                                                                            | $V_{DD}$             | $V_{DD}$             | V    | 2     |
| $V_{RAM}$          | $V_{DD}$ voltage required to retain RAM                                                                                                                                                                                                    | 1.2                  | —                    | V    |       |
| $V_{RFVBAT}$       | $V_{BAT}$ voltage required to retain the VBAT register file                                                                                                                                                                                | $V_{POR\_VBAT}$      | —                    | V    |       |

1. All analog and I/O pins are internally clamped to  $V_{SS}$  through ESD protection diodes. If  $V_{IN}$  is less than  $V_{IO\_MIN}$  or greater than  $V_{IO\_MAX}$ , a current limiting resistor is required. The negative DC injection current limiting resistor is calculated as  $R = (V_{IO\_MIN} - V_{IN}) / |I_{ICIO}|$ .
2. Open drain outputs must be pulled to  $V_{DD}$ .

## 2.2.2 LVD and POR operating requirements

**Table 2.  $V_{DD}$  supply LVD and POR operating requirements**

| Symbol      | Description                                                                                                             | Min. | Typ. | Max. | Unit | Notes |
|-------------|-------------------------------------------------------------------------------------------------------------------------|------|------|------|------|-------|
| $V_{POR}$   | Falling $V_{DD}$ POR detect voltage                                                                                     | 0.8  | 1.1  | 1.5  | V    |       |
| $V_{LVDH}$  | Falling low-voltage detect threshold — high range (LVDV=01)                                                             | 2.48 | 2.56 | 2.64 | V    |       |
| $V_{LVW1H}$ | Low-voltage warning thresholds — high range <ul style="list-style-type: none"> <li>Level 1 falling (LVWV=00)</li> </ul> | 2.62 | 2.70 | 2.78 | V    | 1     |

Table continues on the next page...

**Table 2. V<sub>DD</sub> supply LVD and POR operating requirements (continued)**

| Symbol             | Description                                                | Min. | Typ. | Max. | Unit | Notes |
|--------------------|------------------------------------------------------------|------|------|------|------|-------|
| V <sub>LVW2H</sub> | • Level 2 falling (LVWV=01)                                | 2.72 | 2.80 | 2.88 | V    |       |
| V <sub>LVW3H</sub> | • Level 3 falling (LVWV=10)                                | 2.82 | 2.90 | 2.98 | V    |       |
| V <sub>LVW4H</sub> | • Level 4 falling (LVWV=11)                                | 2.92 | 3.00 | 3.08 | V    |       |
| V <sub>HYSH</sub>  | Low-voltage inhibit reset/recover hysteresis — high range  | —    | 80   | —    | mV   |       |
| V <sub>LVDL</sub>  | Falling low-voltage detect threshold — low range (LVDV=00) | 1.54 | 1.60 | 1.66 | V    |       |
| V <sub>LVW1L</sub> | Low-voltage warning thresholds — low range                 |      |      |      |      | 1     |
| V <sub>LVW2L</sub> | • Level 1 falling (LVWV=00)                                | 1.74 | 1.80 | 1.86 | V    |       |
| V <sub>LVW3L</sub> | • Level 2 falling (LVWV=01)                                | 1.84 | 1.90 | 1.96 | V    |       |
| V <sub>LVW4L</sub> | • Level 3 falling (LVWV=10)                                | 1.94 | 2.00 | 2.06 | V    |       |
| V <sub>HYSL</sub>  | Low-voltage inhibit reset/recover hysteresis — low range   | —    | 60   | —    | mV   |       |
| V <sub>BG</sub>    | Bandgap voltage reference                                  | 0.97 | 1.00 | 1.03 | V    |       |
| t <sub>LPO</sub>   | Internal low power oscillator period — factory trimmed     | 900  | 1000 | 1100 | μs   |       |

1. Rising threshold is the sum of falling threshold and hysteresis voltage

**Table 3. VBAT power operating requirements**

| Symbol                | Description                            | Min. | Typ. | Max. | Unit | Notes |
|-----------------------|----------------------------------------|------|------|------|------|-------|
| V <sub>POR_VBAT</sub> | Falling VBAT supply POR detect voltage | 0.8  | 1.1  | 1.5  | V    |       |

## 2.2.3 Voltage and current operating behaviors

**Table 4. Voltage and current operating behaviors**

| Symbol           | Description                                                 | Min.                  | Typ. | Max. | Unit | Notes |
|------------------|-------------------------------------------------------------|-----------------------|------|------|------|-------|
| V <sub>OH</sub>  | Output high voltage — Normal drive pad except RESET_B       |                       |      |      |      |       |
|                  | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V, I <sub>OH</sub> = -5 mA    | V <sub>DD</sub> - 0.5 | —    | —    | V    | 1     |
|                  | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V, I <sub>OH</sub> = -2.5 mA | V <sub>DD</sub> - 0.5 | —    | —    | V    |       |
| V <sub>OH</sub>  | Output high voltage — High drive pad except RESET_B         |                       |      |      |      |       |
|                  | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V, I <sub>OH</sub> = -20 mA   | V <sub>DD</sub> - 0.5 | —    | —    | V    | 1     |
|                  | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V, I <sub>OH</sub> = -10 mA  | V <sub>DD</sub> - 0.5 | —    | —    | V    |       |
| I <sub>OHT</sub> | Output high current total for all ports                     | —                     | —    | 100  | mA   |       |

Table continues on the next page...

**Table 4. Voltage and current operating behaviors (continued)**

| Symbol           | Description                                                       | Min. | Typ.  | Max. | Unit | Notes |
|------------------|-------------------------------------------------------------------|------|-------|------|------|-------|
| V <sub>OL</sub>  | Output low voltage — Normal drive pad except RESET_B              |      |       |      |      |       |
|                  | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V, I <sub>OL</sub> = 5 mA           | —    | —     | 0.5  | V    | 1     |
|                  | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V, I <sub>OL</sub> = 2.5 mA        | —    | —     | 0.5  | V    |       |
| V <sub>OL</sub>  | Output low voltage — High drive pad except RESET_B                |      |       |      |      |       |
|                  | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V, I <sub>OL</sub> = 20 mA          | —    | —     | 0.5  | V    | 1     |
|                  | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V, I <sub>OL</sub> = 10 mA         | —    | —     | 0.5  | V    |       |
| V <sub>OL</sub>  | Output low voltage — RESET_B                                      |      |       |      |      |       |
|                  | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V, I <sub>OL</sub> = 3 mA           | —    | —     | 0.5  | V    |       |
|                  | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V, I <sub>OL</sub> = 1.5 mA        | —    | —     | 0.5  | V    |       |
| I <sub>OLT</sub> | Output low current total for all ports                            | —    | —     | 100  | mA   |       |
| I <sub>IN</sub>  | Input leakage current (per pin) for full temperature range        |      |       |      |      |       |
|                  | All pins other than high drive port pins                          | —    | 0.002 | 0.5  | μA   | 1, 2  |
|                  | High drive port pins                                              | —    | 0.004 | 0.5  | μA   |       |
| I <sub>IN</sub>  | Input leakage current (total all pins) for full temperature range | —    | —     | 1.0  | μA   | 2     |
| R <sub>PU</sub>  | Internal pullup resistors                                         | 20   | —     | 50   | kΩ   | 3     |
| R <sub>PD</sub>  | Internal pulldown resistors                                       | 20   | —     | 50   | kΩ   | 4     |

1. PTB0, PTB1, PTC3, PTC4, PTD4, PTD5, PTD6, and PTD7 I/O have both high drive and normal drive capability selected by the associated PTx\_PCRn[DSE] control bit. All other GPIOs are normal drive only.

2. Measured at V<sub>DD</sub>=3.6V

3. Measured at V<sub>DD</sub> supply voltage = V<sub>DD</sub> min and V<sub>input</sub> = V<sub>SS</sub>

4. Measured at V<sub>DD</sub> supply voltage = V<sub>DD</sub> min and V<sub>input</sub> = V<sub>DD</sub>

## 2.2.4 Power mode transition operating behaviors

All specifications except t<sub>POR</sub>, and VLLSx→RUN recovery times in the following table assume this clock configuration:

- CPU and system clocks = 80 MHz
- Bus clock = 40 MHz
- Flash clock = 20 MHz
- MCG mode: FEI

**Table 5. Power mode transition operating behaviors**

| Symbol           | Description                                                                                         | Min. | Typ. | Max. | Unit | Notes |
|------------------|-----------------------------------------------------------------------------------------------------|------|------|------|------|-------|
| t <sub>POR</sub> | After a POR event, amount of time from the point V <sub>DD</sub> reaches 1.71 V to execution of the | —    | —    | 300  | μs   | 1     |

Table continues on the next page...

**Table 5. Power mode transition operating behaviors (continued)**

| Symbol | Description                                                           | Min. | Typ. | Max. | Unit | Notes |
|--------|-----------------------------------------------------------------------|------|------|------|------|-------|
|        | first instruction across the operating temperature range of the chip. |      |      |      |      |       |
|        | • VLLS0 → RUN                                                         | —    | —    | 140  | μs   |       |
|        | • VLLS1 → RUN                                                         | —    | —    | 140  | μs   |       |
|        | • VLLS2 → RUN                                                         | —    | —    | 80   | μs   |       |
|        | • VLLS3 → RUN                                                         | —    | —    | 80   | μs   |       |
|        | • LLS2 → RUN                                                          | —    | —    | 6    | μs   |       |
|        | • LLS3 → RUN                                                          | —    | —    | 6    | μs   |       |
|        | • VLPS → RUN                                                          | —    | —    | 5.7  | μs   |       |
|        | • STOP → RUN                                                          | —    | —    | 5.7  | μs   |       |

1. Normal boot (FTFA\_OPT[LPBOOT]=1)

## 2.2.5 Power consumption operating behaviors

The current parameters in the table below are derived from code executing a while(1) loop from flash, unless otherwise noted.

The IDD typical values represent the statistical mean at 25°C, and the IDD maximum values for RUN, WAIT, VLPR, and VLPW represent data collected at 125°C junction temperature unless otherwise noted. The maximum values represent characterized results equivalent to the mean plus three times the standard deviation (mean + 3 sigma).

**Table 6. Power consumption operating behaviors**

| Symbol                | Description                                                                                                          | Min. | Typ.  | Max.     | Unit | Notes   |
|-----------------------|----------------------------------------------------------------------------------------------------------------------|------|-------|----------|------|---------|
| I <sub>DDA</sub>      | Analog supply current                                                                                                | —    | —     | See note | mA   | 1       |
| I <sub>DD_HSRUN</sub> | High Speed Run mode current - all peripheral clocks disabled, CoreMark benchmark code executing from flash<br>@ 1.8V | —    | 25.66 | 26.35    | mA   | 2, 3, 4 |

Table continues on the next page...

**Table 6. Power consumption operating behaviors (continued)**

| Symbol                | Description                                                                             | Min. | Typ.  | Max.  | Unit | Notes   |
|-----------------------|-----------------------------------------------------------------------------------------|------|-------|-------|------|---------|
|                       | @ 3.0V                                                                                  | —    | 25.75 | 26.44 | mA   |         |
| I <sub>DD_HSRUN</sub> | High Speed Run mode current - all peripheral clocks disabled, code executing from flash |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 23.6  | 24.29 | mA   | 2       |
|                       | @ 3.0V                                                                                  | —    | 23.7  | 24.39 | mA   |         |
| I <sub>DD_HSRUN</sub> | High Speed Run mode current — all peripheral clocks enabled, code executing from flash  |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 31.9  | 32.59 | mA   | 5       |
|                       | @ 3.0V                                                                                  | —    | 32.0  | 32.69 | mA   |         |
| I <sub>DD_RUN</sub>   | Run mode current in Compute operation — CoreMark benchmark code executing from flash    |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 15.8  | 16.49 | mA   | 3, 4, 6 |
|                       | @ 3.0V                                                                                  | —    | 15.8  | 16.49 | mA   |         |
| I <sub>DD_RUN</sub>   | Run mode current in Compute operation — code executing from flash                       |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 14.00 | 15.50 | mA   | 6       |
|                       | @ 3.0V                                                                                  | —    | 14.00 | 15.69 | mA   |         |
| I <sub>DD_RUN</sub>   | Run mode current — all peripheral clocks disabled, code executing from flash            |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 15.3  | 15.99 | mA   | 7       |
|                       | @ 3.0V                                                                                  | —    | 15.4  | 16.09 | mA   |         |
| I <sub>DD_RUN</sub>   | Run mode current — all peripheral clocks enabled, code executing from flash             |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 20.4  | 21.09 | mA   | 8       |
|                       | @ 3.0V                                                                                  |      |       |       |      |         |
|                       | • @ 25°C                                                                                | —    | 20.5  | 21.19 | mA   |         |
|                       | • @ 70°C                                                                                | —    | 20.5  | 21.19 | mA   |         |
|                       | • @ 85°C                                                                                | —    | 20.5  | 21.19 | mA   |         |
| I <sub>DD_RUN</sub>   | Run mode current — Compute operation, code executing from flash                         |      |       |       |      |         |
|                       | @ 1.8V                                                                                  | —    | 14.0  | 14.69 | mA   | 9       |
|                       | @ 3.0V                                                                                  |      |       |       |      |         |
|                       | • @ 25°C                                                                                | —    | 14.0  | 14.69 | mA   |         |
|                       | • @ 70°C                                                                                | —    | 14.0  | 14.69 | mA   |         |
|                       | • @ 85°C                                                                                | —    | 14.0  | 14.69 | mA   |         |
| I <sub>DD_WAIT</sub>  | Wait mode high frequency current at 3.0 V — all peripheral clocks disabled              | —    | 8.1   | 8.79  | mA   | 7       |
| I <sub>DD_WAIT</sub>  | Wait mode reduced frequency current at 3.0 V — all peripheral clocks disabled           | —    | 4.4   | 5.09  | mA   | 10      |

Table continues on the next page...

**Table 6. Power consumption operating behaviors (continued)**

| Symbol                | Description                                                                                         | Min. | Typ. | Max.  | Unit | Notes    |
|-----------------------|-----------------------------------------------------------------------------------------------------|------|------|-------|------|----------|
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current in Compute operation — CoreMark benchmark code executing from flash |      |      |       |      |          |
|                       | @ 1.8V                                                                                              | —    | 0.70 | 0.88  | mA   | 3, 4, 11 |
|                       | @ 3.0V                                                                                              | —    | 0.70 | 0.88  | mA   |          |
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current in Compute operation, code executing from flash                     |      | 0.61 | 0.79  |      |          |
|                       | @ 1.8V                                                                                              | —    |      |       | mA   | 11       |
|                       | @ 3.0V                                                                                              | —    | 0.61 | 0.79  | mA   |          |
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current at 3.0 V — all peripheral clocks disabled                           | —    | 0.68 | 0.87  | mA   | 12       |
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current at 3.0 V — all peripheral clocks enabled                            | —    | 1.10 | 1.28  | mA   | 13       |
| I <sub>DD_VLPW</sub>  | Very-low-power wait mode current at 3.0 V — all peripheral clocks disabled                          | —    | 0.38 | 0.57  | mA   | 14       |
| I <sub>DD_STOP</sub>  | Stop mode current at 3.0 V                                                                          |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 0.27 | 0.35  | mA   |          |
|                       | @ 70°C                                                                                              | —    | 0.32 | 0.47  | mA   |          |
|                       | @ 85°C                                                                                              | —    | 0.32 | 0.51  | mA   |          |
| I <sub>DD_VLPS</sub>  | Very-low-power stop mode current at 3.0 V                                                           |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 4.5  | 12.00 | μA   |          |
|                       | @ 70°C                                                                                              | —    | 16.8 | 42.40 | μA   |          |
|                       | @ 85°C                                                                                              | —    | 28.9 | 73.45 | μA   |          |
| I <sub>DD_LLS3</sub>  | Low leakage stop mode 3 current at 3.0 V                                                            |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 2.6  | 3.75  | μA   |          |
|                       | @ 70°C                                                                                              | —    | 6.6  | 12.00 | μA   |          |
|                       | @ 85°C                                                                                              | —    | 10.5 | 17.25 | μA   |          |
| I <sub>DD_LLS2</sub>  | Low leakage stop mode 2 current at 3.0 V                                                            |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 2.4  | 3.40  | μA   |          |
|                       | @ 70°C                                                                                              | —    | 5.3  | 8.90  | μA   |          |
|                       | @ 85°C                                                                                              | —    | 5.1  | 10.05 | μA   |          |
| I <sub>DD_VLLS3</sub> | Very low-leakage stop mode 3 current at 3.0 V                                                       |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 1.9  | 2.30  | μA   |          |
|                       | @ 70°C                                                                                              | —    | 4.8  | 8.10  | μA   |          |
|                       | @ 85°C                                                                                              | —    | 7.6  | 11.30 | μA   |          |
| I <sub>DD_VLLS2</sub> | Very low-leakage stop mode 2 current at 3.0 V                                                       |      |      |       |      |          |
|                       | @ -40°C to 25°C                                                                                     | —    | 1.7  | 2.10  | μA   |          |
|                       | @ 70°C                                                                                              | —    | 3.4  | 4.85  | μA   |          |
|                       | @ 85°C                                                                                              | —    | 5.1  | 8.80  | μA   |          |
| I <sub>DD_VLLS1</sub> | Very low-leakage stop mode 1 current at 3.0 V                                                       |      |      |       |      |          |

Table continues on the next page...

**Table 6. Power consumption operating behaviors (continued)**

| Symbol                | Description                                                                    | Min. | Typ. | Max. | Unit | Notes |
|-----------------------|--------------------------------------------------------------------------------|------|------|------|------|-------|
|                       | @ -40°C to 25°C                                                                | —    | 0.71 | 0.96 | μA   |       |
|                       | @ 70°C                                                                         | —    | 1.79 | 2.10 | μA   |       |
|                       | @ 85°C                                                                         | —    | 2.9  | 4.70 | μA   |       |
| I <sub>DD_VLLS0</sub> | Very low-leakage stop mode 0 current at 3.0 V with POR detect circuit enabled  |      |      |      |      |       |
|                       | @ -40°C to 25°C                                                                | —    | 0.40 | 0.56 | μA   |       |
|                       | @ 70°C                                                                         | —    | 1.39 | 1.70 | μA   |       |
|                       | @ 85°C                                                                         | —    | 2.5  | 4.25 | μA   |       |
| I <sub>DD_VLLS0</sub> | Very low-leakage stop mode 0 current at 3.0 V with POR detect circuit disabled |      |      |      |      |       |
|                       | @ -40°C to 25°C                                                                | —    | 0.12 | 0.38 | μA   |       |
|                       | @ 70°C                                                                         | —    | 1.05 | 1.38 | μA   |       |
|                       | @ 85°C                                                                         | —    | 2.20 | 3.95 | μA   |       |
| I <sub>DD_VBAT</sub>  | Average current with RTC and 32kHz disabled at 3.0 V                           |      |      |      |      |       |
|                       | @ -40°C to 25°C                                                                | —    | 0.18 | 0.21 | μA   |       |
|                       | @ 70°C                                                                         | —    | 0.66 | 0.86 | μA   |       |
|                       | @ 85°C                                                                         | —    | 1.52 | 2.24 | μA   |       |
| I <sub>DD_VBAT</sub>  | Average current when CPU is not accessing RTC registers                        |      |      |      |      |       |
|                       | @ 1.8V                                                                         |      |      |      |      |       |
|                       | • @ -40°C to 25°C                                                              | —    | 0.59 | 0.70 | μA   | 15    |
|                       | • @ 70°C                                                                       | —    | 1.00 | 1.3  | μA   |       |
|                       | • @ 85°C                                                                       | —    | 1.76 | 2.59 | μA   |       |
|                       | @ 3.0V                                                                         |      |      |      |      |       |
|                       | • @ -40°C to 25°C                                                              | —    | 0.71 | 0.84 | μA   |       |
|                       | • @ 70°C                                                                       | —    | 1.22 | 1.59 | μA   |       |
|                       | • @ 85°C                                                                       | —    | 2.08 | 3.06 | μA   |       |

1. The analog supply current is the sum of the active or disabled current for each of the analog modules on the device. See each module's specification for its supply current.
2. 120MHz core and system clock, 60MHz bus clock, and 24MHz flash clock. MCG configured for PEE mode. All peripheral clocks disabled.
3. Cache on and prefetch on, low compiler optimization.
4. Coremark benchmark compiled using IAR 7.2 with optimization level low.
5. 120MHz core and system clock, 60MHz bus clock, and 24MHz flash clock. MCG configured for PEE mode. All peripheral clocks enabled.
6. 80 MHz core and system clock, 40 MHz bus clock, and 26.67 MHz flash clock. MCG configured for PEE mode. Compute operation.
7. 80MHz core and system clock, 40MHz bus clock, and 26.67MHz flash clock. MCG configured for FEI mode. All peripheral clocks disabled.
8. 80MHz core and system clock, 40MHz bus clock, and 26.67MHz flash clock. MCG configured for FEI mode. All peripheral clocks enabled.

## General

9. 80MHz core and system clock, 40MHz bus clock, and 26.67MHz flash clock. MCG configured for FEI mode. Compute operation.
10. 25MHz core and system clock, 25MHz bus clock, and 25MHz flash clock. MCG configured for FEI mode.
11. 4 MHz core, system, and bus clock and 1MHz flash clock. MCG configured for BLPE mode. Compute operation. Code executing from flash.
12. 4 MHz core, system, and bus clock and 1MHz flash clock. MCG configured for BLPE mode. All peripheral clocks disabled. Code executing from flash.
13. 4 MHz core, system, and bus clock and 1MHz flash clock. MCG configured for BLPE mode. All peripheral clocks enabled but peripherals are not in active operation. Code executing from flash.
14. 4 MHz core, system, and bus clock and 1MHz flash clock. MCG configured for BLPE mode. All peripheral clocks disabled.
15. Includes 32kHz oscillator current and RTC operation.

**Table 7. Low power mode peripheral adders—typical value**

| Symbol                     | Description                                                                                                                                                                                                                                | Temperature (°C) |     |     |     |     |     | Unit |
|----------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-----|-----|-----|-----|-----|------|
|                            |                                                                                                                                                                                                                                            | -40              | 25  | 50  | 70  | 85  | 105 |      |
| I <sub>IREFSTEN4MHz</sub>  | 4 MHz internal reference clock (IRC) adder. Measured by entering STOP or VLPS mode with 4 MHz IRC enabled.                                                                                                                                 | 56               | 56  | 56  | 56  | 56  | 56  | μA   |
| I <sub>IREFSTEN32KHz</sub> | 32 kHz internal reference clock (IRC) adder. Measured by entering STOP mode with the 32 kHz IRC enabled.                                                                                                                                   | 52               | 52  | 52  | 52  | 52  | 52  | μA   |
| I <sub>EREFSTEN4MHz</sub>  | External 4 MHz crystal clock adder. Measured by entering STOP or VLPS mode with the crystal enabled.                                                                                                                                       | 206              | 228 | 237 | 245 | 251 | 258 | uA   |
| I <sub>EREFSTEN32KHz</sub> | External 32 kHz crystal clock adder by means of the OSC0_CR[EREFSTEN and EREFSTEN] bits. Measured by entering all modes with the crystal enabled.                                                                                          |                  |     |     |     |     |     |      |
|                            | VLLS1                                                                                                                                                                                                                                      | 440              | 490 | 540 | 560 | 570 | 580 | nA   |
|                            | VLLS3                                                                                                                                                                                                                                      | 440              | 490 | 540 | 560 | 570 | 580 |      |
|                            | LLS                                                                                                                                                                                                                                        | 490              | 490 | 540 | 560 | 570 | 680 |      |
|                            | VLPS                                                                                                                                                                                                                                       | 510              | 560 | 560 | 560 | 610 | 680 |      |
|                            | STOP                                                                                                                                                                                                                                       | 510              | 560 | 560 | 560 | 610 | 680 |      |
| I <sub>48MIRC</sub>        | 48 Mhz internal reference clock                                                                                                                                                                                                            | 350              | 350 | 350 | 350 | 350 | 350 | μA   |
| I <sub>CMP</sub>           | CMP peripheral adder measured by placing the device in VLLS1 mode with CMP enabled using the 6-bit DAC and a single external input for compare. Includes 6-bit DAC power consumption.                                                      | 22               | 22  | 22  | 22  | 22  | 22  | μA   |
| I <sub>RTC</sub>           | RTC peripheral adder measured by placing the device in VLLS1 mode with external 32 kHz crystal enabled by means of the RTC_CR[OSCE] bit and the RTC ALARM set for 1 minute. Includes ERCLK32K (32 kHz external crystal) power consumption. | 432              | 357 | 388 | 475 | 532 | 810 | nA   |
| I <sub>UART</sub>          | UART peripheral adder measured by placing the device in STOP or VLPS                                                                                                                                                                       |                  |     |     |     |     |     |      |

*Table continues on the next page...*

**Table 7. Low power mode peripheral adders—typical value (continued)**

| Symbol           | Description                                                                                                                                                                                                                      | Temperature (°C) |           |           |           |           |           | Unit |
|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-----------|-----------|-----------|-----------|-----------|------|
|                  |                                                                                                                                                                                                                                  | -40              | 25        | 50        | 70        | 85        | 105       |      |
|                  | mode with selected clock source waiting for RX data at 115200 baud rate. Includes selected clock source power consumption.<br>MCGIRCLK (4 MHz internal reference clock)<br>>OSCERCLK (4 MHz external crystal)                    | 66<br>214        | 66<br>237 | 66<br>246 | 66<br>254 | 66<br>260 | 66<br>268 | μA   |
| I <sub>BG</sub>  | Bandgap adder when BGEN bit is set and device is placed in VLPx, LLS, or VLLSx mode.                                                                                                                                             | 45               | 45        | 45        | 45        | 45        | 45        | μA   |
| I <sub>ADC</sub> | ADC peripheral adder combining the measured values at V <sub>DD</sub> and V <sub>DDA</sub> by placing the device in STOP or VLPS mode. ADC is configured for low power mode using the internal clock and continuous conversions. | 42               | 42        | 42        | 42        | 42        | 42        | μA   |

### 2.2.5.1 Diagram: Typical IDD\_RUN operating behavior

The following data was measured under these conditions:

- MCG in FBE mode for 50 MHz and lower frequencies. MCG in FEE mode at frequencies between 50 MHz and 100MHz. MCG in PEE mode at frequencies greater than 100 MHz.
- USB regulator disabled
- No GPIOs toggled
- Code execution from flash with cache enabled
- For the ALLOFF curve, all peripheral clocks are disabled except FTFA

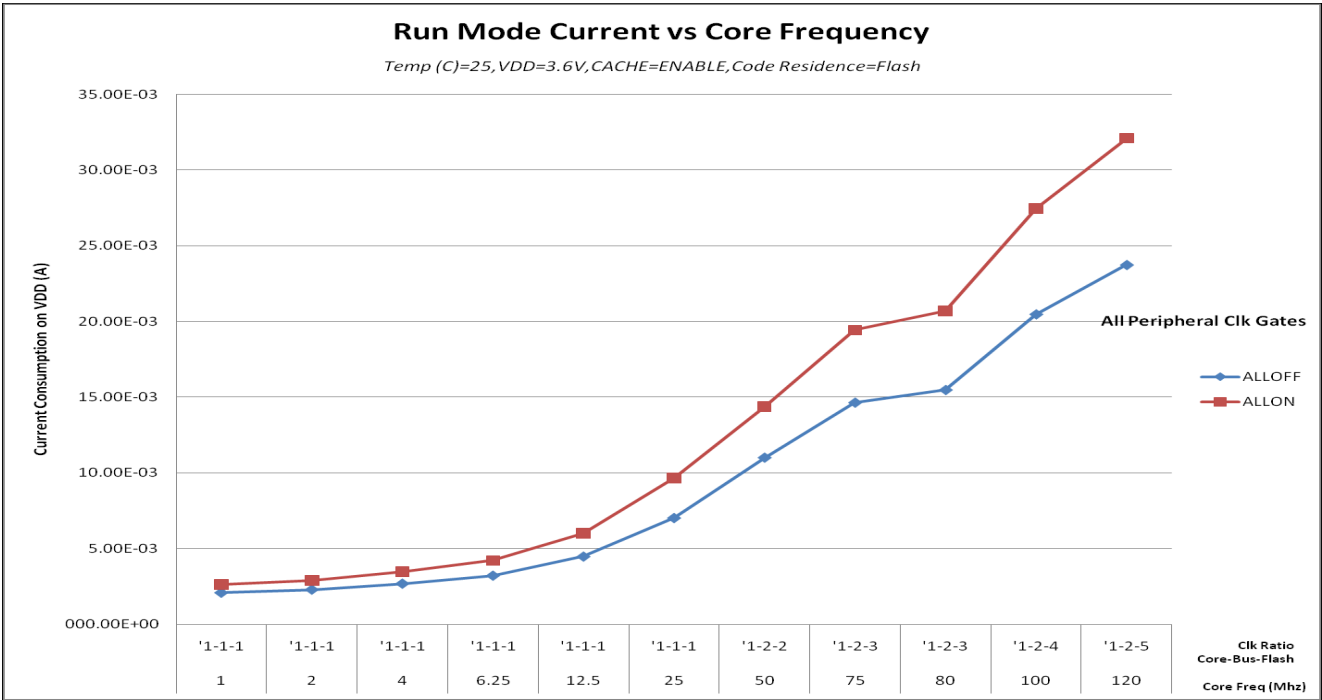


Figure 3. Run mode supply current vs. core frequency

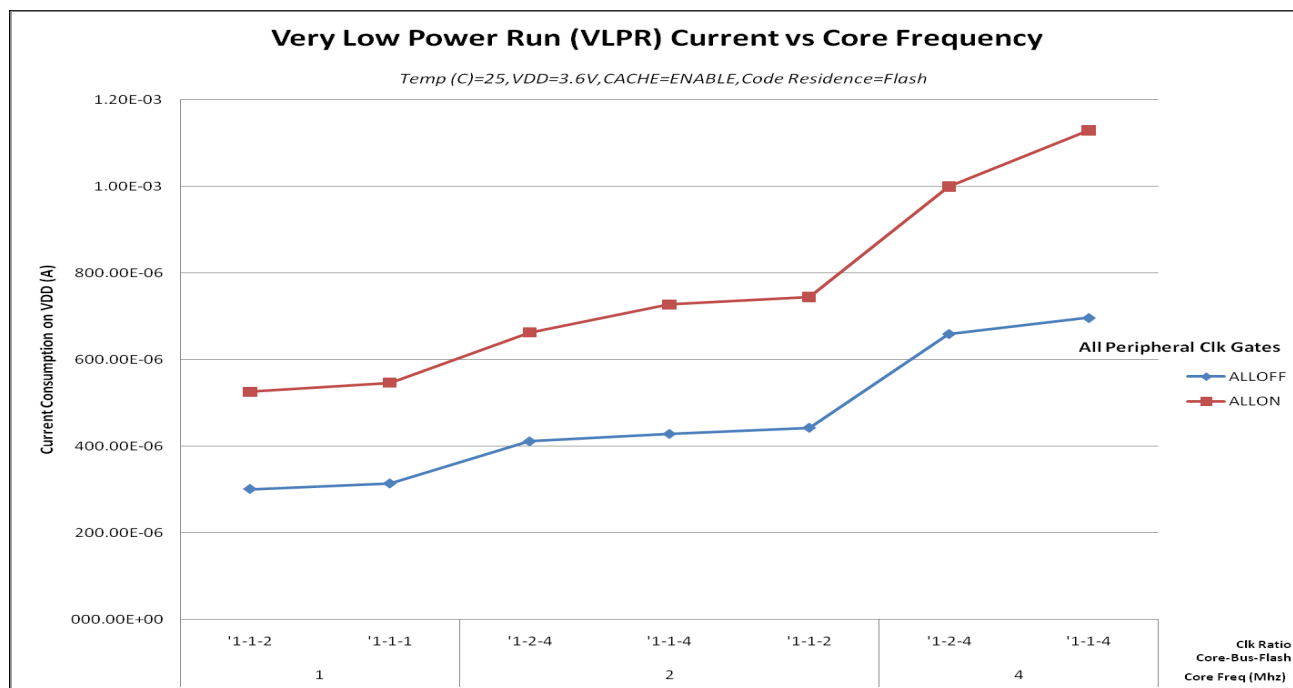


Figure 4. VLPR mode supply current vs. core frequency

## 2.2.6 EMC radiated emissions operating behaviors

Table 8. EMC radiated emissions operating behaviors for 64 LQFP package

| Parameter        | Conditions                                                                                                                                                                                                        | Clocks                                                      | Frequency range  | Level (Typ.) | Unit | Notes   |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------|------------------|--------------|------|---------|
| V <sub>EME</sub> | Device configuration, test conditions and EM testing per standard IEC 61967-2.<br><br>Supply voltages:<br><ul style="list-style-type: none"> <li>VREGIN (USB) = 5.0 V</li> <li>VDD = 3.3 V</li> </ul> Temp = 25°C | FSYS = 120 MHz<br>FBUS = 60 MHz<br>External crystal = 8 MHz | 150 kHz–50 MHz   | 14           | dBuV | 1, 2, 3 |
|                  |                                                                                                                                                                                                                   |                                                             | 50 MHz–150 MHz   | 23           |      |         |
|                  |                                                                                                                                                                                                                   |                                                             | 150 MHz–500 MHz  | 23           |      |         |
|                  |                                                                                                                                                                                                                   |                                                             | 500 MHz–1000 MHz | 9            |      |         |
|                  |                                                                                                                                                                                                                   |                                                             | IEC level        | L            |      | 4       |

1. Measurements were made per IEC 61967-2 while the device was running typical application code.
2. Measurements were performed on the 64LQFP device, MK22FN512VLH12.

## General

3. The reported emission level is the value of the maximum measured emission, rounded up to the next whole number, from among the measured orientations in each frequency range.
4. IEC Level Maximums: M  $\leq$  18dBmV, L  $\leq$  24dBmV, K  $\leq$  30dBmV, I  $\leq$  36dBmV, H  $\leq$  42dBmV .

## 2.2.7 Designing with radiated emissions in mind

To find application notes that provide guidance on designing your system to minimize interference from radiated emissions:

- Go to [nxp.com](http://nxp.com)
- Perform a keyword search for “EMC design.”

## 2.2.8 Capacitance attributes

Table 9. Capacitance attributes

| Symbol            | Description                     | Min. | Max. | Unit |
|-------------------|---------------------------------|------|------|------|
| C <sub>IN_A</sub> | Input capacitance: analog pins  | —    | 7    | pF   |
| C <sub>IN_D</sub> | Input capacitance: digital pins | —    | 7    | pF   |

## 2.3 Switching specifications

### 2.3.1 Device clock specifications

Table 10. Device clock specifications

| Symbol                                                                     | Description                                            | Min. | Max.  | Unit | Notes |
|----------------------------------------------------------------------------|--------------------------------------------------------|------|-------|------|-------|
| High Speed run mode                                                        |                                                        |      |       |      |       |
| f <sub>SYS</sub>                                                           | System and core clock                                  | —    | 120   | MHz  |       |
| f <sub>BUS</sub>                                                           | Bus clock                                              | —    | 60    | MHz  |       |
| Normal run mode (and High Speed run mode unless otherwise specified above) |                                                        |      |       |      |       |
| f <sub>SYS</sub>                                                           | System and core clock                                  | —    | 80    | MHz  |       |
| f <sub>SYS_USB</sub>                                                       | System and core clock when Full Speed USB in operation | 20   | —     | MHz  |       |
| f <sub>BUS</sub>                                                           | Bus clock                                              | —    | 50    | MHz  |       |
| f <sub>FLASH</sub>                                                         | Flash clock                                            | —    | 26.67 | MHz  |       |
| f <sub>LPTMR</sub>                                                         | LPTMR clock                                            | —    | 25    | MHz  |       |
| VLPR mode <sup>1</sup>                                                     |                                                        |      |       |      |       |
| f <sub>SYS</sub>                                                           | System and core clock                                  | —    | 4     | MHz  |       |

Table continues on the next page...

**Table 10. Device clock specifications (continued)**

| Symbol                   | Description                    | Min. | Max. | Unit | Notes |
|--------------------------|--------------------------------|------|------|------|-------|
| f <sub>BUS</sub>         | Bus clock                      | —    | 4    | MHz  |       |
| f <sub>FLASH</sub>       | Flash clock                    | —    | 1    | MHz  |       |
| f <sub>ERCLK</sub>       | External reference clock       | —    | 16   | MHz  |       |
| f <sub>LPTMR_pin</sub>   | LPTMR clock                    | —    | 25   | MHz  |       |
| f <sub>LPTMR_ERCLK</sub> | LPTMR external reference clock | —    | 16   | MHz  |       |
| f <sub>I2S_MCLK</sub>    | I2S master clock               | —    | 12.5 | MHz  |       |
| f <sub>I2S_BCLK</sub>    | I2S bit clock                  | —    | 4    | MHz  |       |

1. The frequency limitations in VLPR mode here override any frequency specification listed in the timing specification for any other module.

## 2.3.2 General switching specifications

These general purpose specifications apply to all signals configured for GPIO, UART, and timers.

**Table 11. General switching specifications**

| Symbol | Description                                                                                                                                                                                                                                                                                                                                                                                                     | Min.             | Max.                | Unit                 | Notes |
|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------------------|----------------------|-------|
|        | GPIO pin interrupt pulse width (digital glitch filter disabled) — Synchronous path                                                                                                                                                                                                                                                                                                                              | 1.5              | —                   | Bus clock cycles     | 1, 2  |
|        | External RESET and NMI pin interrupt pulse width — Asynchronous path                                                                                                                                                                                                                                                                                                                                            | 100              | —                   | ns                   | 3     |
|        | GPIO pin interrupt pulse width (digital glitch filter disabled, passive filter disabled) — Asynchronous path                                                                                                                                                                                                                                                                                                    | 50               | —                   | ns                   | 4     |
|        | Mode select (EZP_CS) hold time after reset deassertion                                                                                                                                                                                                                                                                                                                                                          | 2                | —                   | Bus clock cycles     |       |
|        | Port rise and fall time <ul style="list-style-type: none"> <li>• Slew disabled <ul style="list-style-type: none"> <li>• <math>1.71 \leq V_{DD} \leq 2.7V</math></li> <li>• <math>2.7 \leq V_{DD} \leq 3.6V</math></li> </ul> </li> <li>• Slew enabled <ul style="list-style-type: none"> <li>• <math>1.71 \leq V_{DD} \leq 2.7V</math></li> <li>• <math>2.7 \leq V_{DD} \leq 3.6V</math></li> </ul> </li> </ul> | —<br>—<br>—<br>— | 10<br>5<br>30<br>16 | ns<br>ns<br>ns<br>ns | 5     |

1. This is the minimum pulse width that is guaranteed to pass through the pin synchronization circuitry. Shorter pulses may or may not be recognized. In Stop, VLPS, LLS, and VLLSx modes, the synchronizer is bypassed so shorter pulses can be recognized in that case.
2. The greater of synchronous and asynchronous timing must be met.
3. These pins have a passive filter enabled on the inputs. This is the shortest pulse width that is guaranteed to be recognized.

## General

- These pins do not have a passive filter on the inputs. This is the shortest pulse width that is guaranteed to be recognized.
- 25 pF load

## 2.4 Thermal specifications

### 2.4.1 Thermal operating requirements

Table 12. Thermal operating requirements

| Symbol | Description              | Min. | Max. | Unit | Notes |
|--------|--------------------------|------|------|------|-------|
| $T_J$  | Die junction temperature | -40  | 95   | °C   |       |
| $T_A$  | Ambient temperature      | -40  | 85   | °C   | 1     |

- Maximum  $T_A$  can be exceeded only if the user ensures that  $T_J$  does not exceed maximum  $T_J$ . The simplest method to determine  $T_J$  is:  $T_J = T_A + R_{\theta JA} \times \text{chip power dissipation}$ .

### 2.4.2 Thermal attributes

| Board type        | Symbol           | Description                                                      | 64 WLCSP | Unit | Notes |
|-------------------|------------------|------------------------------------------------------------------|----------|------|-------|
| Single-layer (1s) | $R_{\theta JA}$  | Thermal resistance, junction to ambient (natural convection)     | 50.7     | °C/W | 1     |
| Four-layer (2s2p) | $R_{\theta JA}$  | Thermal resistance, junction to ambient (natural convection)     | 39.1     | °C/W | 2     |
| Single-layer (1s) | $R_{\theta JMA}$ | Thermal resistance, junction to ambient (200 ft./min. air speed) | 41.4     | °C/W | 3     |
| Four-layer (2s2p) | $R_{\theta JMA}$ | Thermal resistance, junction to ambient (200 ft./min. air speed) | 34.6     | °C/W | 3     |
| —                 | $R_{\theta JB}$  | Thermal resistance, junction to board                            | 43.2     | °C/W | 4     |

Table continues on the next page...

| Board type | Symbol          | Description                                                                                     | 64 WLCSP | Unit | Notes |
|------------|-----------------|-------------------------------------------------------------------------------------------------|----------|------|-------|
| —          | $R_{\theta JC}$ | Thermal resistance, junction to case                                                            | 0.1      | °C/W | 5     |
| —          | $\Psi_{JT}$     | Thermal characterization parameter, junction to package top outside center (natural convection) | 0.1      | °C/W | 6     |

1. Determined according to JEDEC Standard JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions—Natural Convection (Still Air)* with the single layer board horizontal. Board meets JESD51-9 specification.
2. Determined according to JEDEC Standard JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions—Natural Convection (Still Air)*.
3. Determined according to JEDEC Standard JESD51-6, *Integrated Circuits Thermal Test Method Environmental Conditions—Forced Convection (Moving Air)* with the board horizontal.
4. Determined according to JEDEC Standard JESD51-8, *Integrated Circuit Thermal Test Method Environmental Conditions—Junction-to-Board*.
5. Thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC-883 Method 1012.1).
6. Thermal characterization parameter indicating the temperature difference between package top and the junction temperature per JEDEC JESD51-2.

## 3 Peripheral operating requirements and behaviors

### 3.1 Core modules

#### 3.1.1 SWD electricals

Table 13. SWD full voltage range electricals

| Symbol | Description                                                                                        | Min. | Max. | Unit |
|--------|----------------------------------------------------------------------------------------------------|------|------|------|
|        | Operating voltage                                                                                  | 1.71 | 3.6  | V    |
| S1     | SWD_CLK frequency of operation <ul style="list-style-type: none"> <li>Serial wire debug</li> </ul> | 0    | 33   | MHz  |
| S2     | SWD_CLK cycle period                                                                               | 1/S1 | —    | ns   |
| S3     | SWD_CLK clock pulse width <ul style="list-style-type: none"> <li>Serial wire debug</li> </ul>      | 15   | —    | ns   |
| S4     | SWD_CLK rise and fall times                                                                        | —    | 3    | ns   |
| S9     | SWD_DIO input data setup time to SWD_CLK rise                                                      | 8    | —    | ns   |
| S10    | SWD_DIO input data hold time after SWD_CLK rise                                                    | 1.4  | —    | ns   |

Table continues on the next page...

Table 13. SWD full voltage range electricals (continued)

| Symbol | Description                        | Min. | Max. | Unit |
|--------|------------------------------------|------|------|------|
| S11    | SWD_CLK high to SWD_DIO data valid | —    | 25   | ns   |
| S12    | SWD_CLK high to SWD_DIO high-Z     | 5    | —    | ns   |

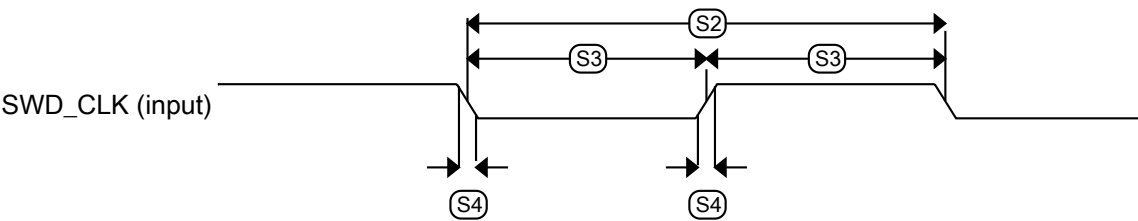


Figure 5. Serial wire clock input timing

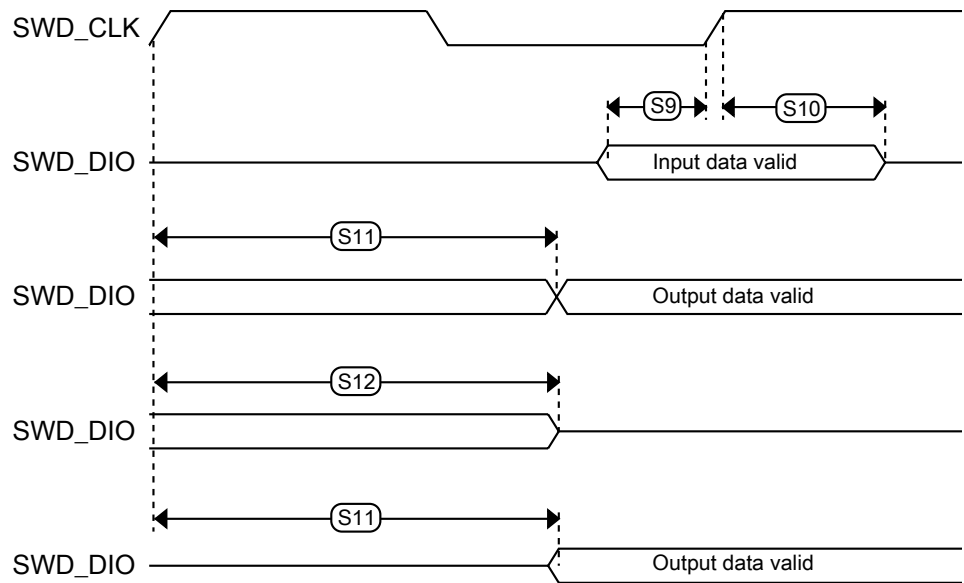


Figure 6. Serial wire data timing

3.1.2 JTAG electricals

Table 14. JTAG limited voltage range electricals

| Symbol | Description                 | Min. | Max. | Unit |
|--------|-----------------------------|------|------|------|
|        | Operating voltage           | 2.7  | 3.6  | V    |
| J1     | TCLK frequency of operation |      |      | MHz  |

Table continues on the next page...

**Table 14. JTAG limited voltage range electricals (continued)**

| Symbol | Description                                                                             | Min. | Max. | Unit |
|--------|-----------------------------------------------------------------------------------------|------|------|------|
|        | <ul style="list-style-type: none"> <li>Boundary Scan</li> <li>JTAG and CJTAG</li> </ul> | 0    | 10   |      |
|        |                                                                                         | 0    | 20   |      |
| J2     | TCLK cycle period                                                                       | 1/J1 | —    | ns   |
| J3     | TCLK clock pulse width                                                                  |      |      |      |
|        | <ul style="list-style-type: none"> <li>Boundary Scan</li> <li>JTAG and CJTAG</li> </ul> | 50   | —    | ns   |
|        |                                                                                         | 25   | —    | ns   |
| J4     | TCLK rise and fall times                                                                | —    | 3    | ns   |
| J5     | Boundary scan input data setup time to TCLK rise                                        | 20   | —    | ns   |
| J6     | Boundary scan input data hold time after TCLK rise                                      | 1    | —    | ns   |
| J7     | TCLK low to boundary scan output data valid                                             | —    | 25   | ns   |
| J8     | TCLK low to boundary scan output high-Z                                                 | —    | 25   | ns   |
| J9     | TMS, TDI input data setup time to TCLK rise                                             | 8    | —    | ns   |
| J10    | TMS, TDI input data hold time after TCLK rise                                           | 1    | —    | ns   |
| J11    | TCLK low to TDO data valid                                                              | —    | 19   | ns   |
| J12    | TCLK low to TDO high-Z                                                                  | —    | 19   | ns   |
| J13    | TRST assert time                                                                        | 100  | —    | ns   |
| J14    | TRST setup time (negation) to TCLK high                                                 | 8    | —    | ns   |

**Table 15. JTAG full voltage range electricals**

| Symbol | Description                                                                             | Min. | Max. | Unit |
|--------|-----------------------------------------------------------------------------------------|------|------|------|
|        | Operating voltage                                                                       | 1.71 | 3.6  | V    |
| J1     | TCLK frequency of operation                                                             |      |      | MHz  |
|        | <ul style="list-style-type: none"> <li>Boundary Scan</li> <li>JTAG and CJTAG</li> </ul> | 0    | 10   |      |
|        |                                                                                         | 0    | 15   |      |
| J2     | TCLK cycle period                                                                       | 1/J1 | —    | ns   |
| J3     | TCLK clock pulse width                                                                  |      |      |      |
|        | <ul style="list-style-type: none"> <li>Boundary Scan</li> <li>JTAG and CJTAG</li> </ul> | 50   | —    | ns   |
|        |                                                                                         | 33   | —    | ns   |
| J4     | TCLK rise and fall times                                                                | —    | 3    | ns   |
| J5     | Boundary scan input data setup time to TCLK rise                                        | 20   | —    | ns   |
| J6     | Boundary scan input data hold time after TCLK rise                                      | 1.4  | —    | ns   |
| J7     | TCLK low to boundary scan output data valid                                             | —    | 27   | ns   |
| J8     | TCLK low to boundary scan output high-Z                                                 | —    | 27   | ns   |
| J9     | TMS, TDI input data setup time to TCLK rise                                             | 8    | —    | ns   |
| J10    | TMS, TDI input data hold time after TCLK rise                                           | 1.4  | —    | ns   |

*Table continues on the next page...*

Table 15. JTAG full voltage range electricals (continued)

| Symbol | Description                             | Min. | Max. | Unit |
|--------|-----------------------------------------|------|------|------|
| J11    | TCLK low to TDO data valid              | —    | 26.2 | ns   |
| J12    | TCLK low to TDO high-Z                  | —    | 26.2 | ns   |
| J13    | TRST assert time                        | 100  | —    | ns   |
| J14    | TRST setup time (negation) to TCLK high | 8    | —    | ns   |

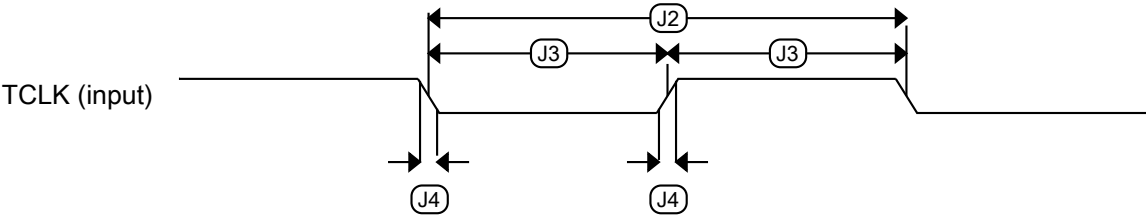


Figure 7. Test clock input timing

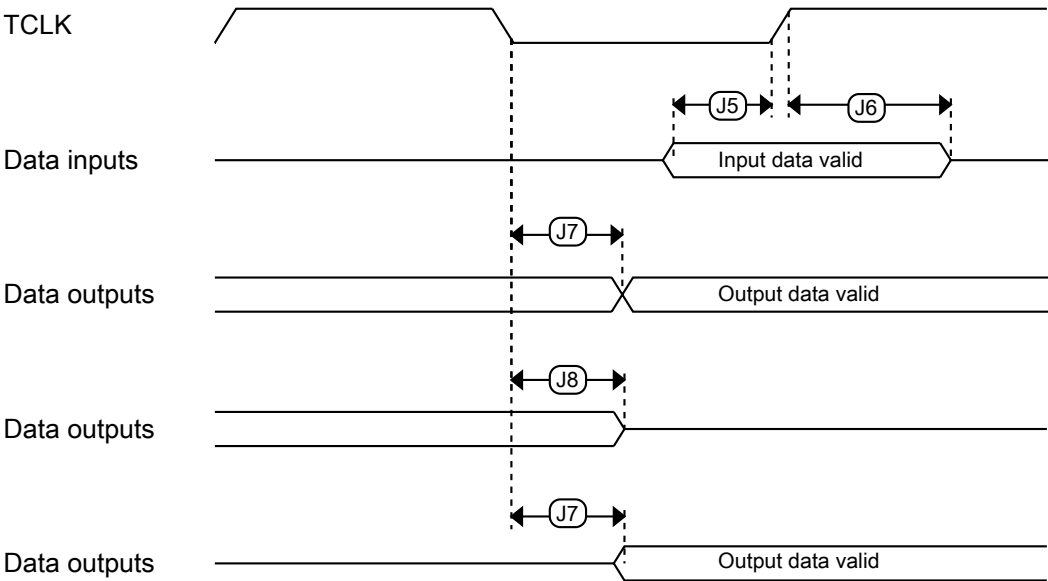


Figure 8. Boundary scan (JTAG) timing

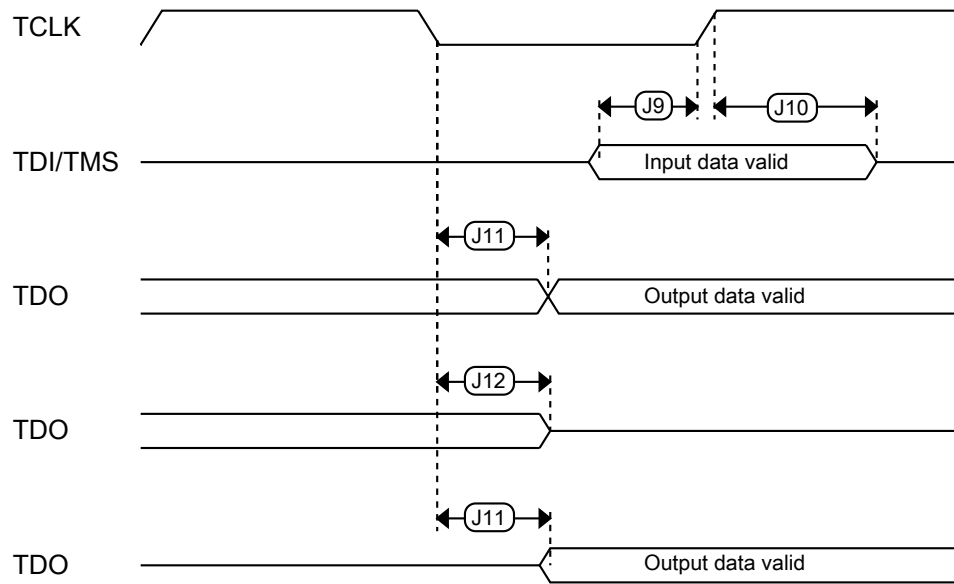
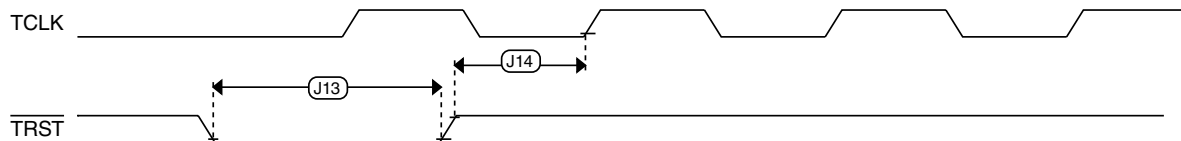


Figure 9. Test Access Port timing

Figure 10.  $\overline{\text{TRST}}$  timing

## 3.2 System modules

There are no specifications necessary for the device's system modules.

## 3.3 Clock modules

### 3.3.1 MCG specifications

Table 16. MCG specifications

| Symbol                       | Description                                                                                                                          |                                                        | Min.                         | Typ.      | Max.    | Unit                  | Notes |
|------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------|------------------------------|-----------|---------|-----------------------|-------|
| f <sub>ints_ft</sub>         | Internal reference frequency (slow clock) — factory trimmed at nominal VDD and 25 °C                                                 |                                                        | —                            | 32.768    | —       | kHz                   |       |
| Δf <sub>ints_t</sub>         | Total deviation of internal reference frequency (slow clock) over voltage and temperature                                            |                                                        | —                            | +0.5/-0.7 | ± 2     | %                     |       |
| f <sub>ints_t</sub>          | Internal reference frequency (slow clock) — user trimmed                                                                             |                                                        | 31.25                        | —         | 39.0625 | kHz                   |       |
| Δf <sub>dco_res_t</sub>      | Resolution of trimmed average DCO output frequency at fixed voltage and temperature — using SCTRIM and SCFTRIM                       |                                                        | —                            | ± 0.3     | ± 0.6   | %f <sub>dco</sub>     | 1     |
| Δf <sub>dco_t</sub>          | Total deviation of trimmed average DCO output frequency over voltage and temperature                                                 |                                                        | —                            | +0.5/-0.7 | ± 2     | %f <sub>dco</sub>     | 1, 2  |
| Δf <sub>dco_t</sub>          | Total deviation of trimmed average DCO output frequency over fixed voltage and temperature range of 0–70°C                           |                                                        | —                            | ± 0.3     | ± 1.5   | %f <sub>dco</sub>     | 1     |
| f <sub>intf_ft</sub>         | Internal reference frequency (fast clock) — factory trimmed at nominal VDD and 25°C                                                  |                                                        | —                            | 4         | —       | MHz                   |       |
| Δf <sub>intf_ft</sub>        | Frequency deviation of internal reference clock (fast clock) over temperature and voltage — factory trimmed at nominal VDD and 25 °C |                                                        | —                            | +1/-2     | ± 5     | %f <sub>intf_ft</sub> |       |
| f <sub>intf_t</sub>          | Internal reference frequency (fast clock) — user trimmed at nominal VDD and 25 °C                                                    |                                                        | 3                            | —         | 5       | MHz                   |       |
| f <sub>loc_low</sub>         | Loss of external clock minimum frequency — RANGE = 00                                                                                |                                                        | (3/5) x f <sub>ints_t</sub>  | —         | —       | kHz                   |       |
| f <sub>loc_high</sub>        | Loss of external clock minimum frequency — RANGE = 01, 10, or 11                                                                     |                                                        | (16/5) x f <sub>ints_t</sub> | —         | —       | kHz                   |       |
| FLL                          |                                                                                                                                      |                                                        |                              |           |         |                       |       |
| f <sub>fll_ref</sub>         | FLL reference frequency range                                                                                                        |                                                        | 31.25                        | —         | 39.0625 | kHz                   |       |
| f <sub>dco</sub>             | DCO output frequency range                                                                                                           | Low range (DRS=00)<br>640 × f <sub>fll_ref</sub>       | 20                           | 20.97     | 25      | MHz                   | 3, 4  |
|                              |                                                                                                                                      | Mid range (DRS=01)<br>1280 × f <sub>fll_ref</sub>      | 40                           | 41.94     | 50      | MHz                   |       |
|                              |                                                                                                                                      | Mid-high range (DRS=10)<br>1920 × f <sub>fll_ref</sub> | 60                           | 62.91     | 75      | MHz                   |       |
|                              |                                                                                                                                      | High range (DRS=11)<br>2560 × f <sub>fll_ref</sub>     | 80                           | 83.89     | 100     | MHz                   |       |
| f <sub>dco_t_DMx3</sub><br>2 | DCO output frequency                                                                                                                 | Low range (DRS=00)<br>732 × f <sub>fll_ref</sub>       | —                            | 23.99     | —       | MHz                   | 5, 6  |
|                              |                                                                                                                                      | Mid range (DRS=01)<br>1464 × f <sub>fll_ref</sub>      | —                            | 47.97     | —       | MHz                   |       |
|                              |                                                                                                                                      | Mid-high range (DRS=10)                                | —                            | 71.99     | —       | MHz                   |       |

Table continues on the next page...

**Table 16. MCG specifications (continued)**

| Symbol                    | Description                                                                                                                                                                                                       | Min.                               | Typ.            | Max.                                               | Unit | Notes |
|---------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|-----------------|----------------------------------------------------|------|-------|
|                           |                                                                                                                                                                                                                   | $2197 \times f_{\text{fill\_ref}}$ |                 |                                                    |      |       |
|                           |                                                                                                                                                                                                                   | High range (DRS=11)                | —               | 95.98                                              | —    |       |
|                           |                                                                                                                                                                                                                   | $2929 \times f_{\text{fill\_ref}}$ |                 |                                                    | MHz  |       |
| $J_{\text{cyc\_fll}}$     | FLL period jitter <ul style="list-style-type: none"> <li><math>f_{\text{VCO}} = 48 \text{ MHz}</math></li> <li><math>f_{\text{VCO}} = 98 \text{ MHz}</math></li> </ul>                                            | —<br>—                             | —<br>180<br>150 | —<br>—                                             | ps   |       |
| $t_{\text{fll\_acquire}}$ | FLL target frequency acquisition time                                                                                                                                                                             | —                                  | —               | 1                                                  | ms   | 7     |
| PLL                       |                                                                                                                                                                                                                   |                                    |                 |                                                    |      |       |
| $f_{\text{vco}}$          | VCO operating frequency                                                                                                                                                                                           | 48.0                               | —               | 120                                                | MHz  |       |
| $I_{\text{pll}}$          | PLL operating current <ul style="list-style-type: none"> <li>PLL @ 96 MHz (<math>f_{\text{osc\_hi\_1}} = 8 \text{ MHz}</math>, <math>f_{\text{pll\_ref}} = 2 \text{ MHz}</math>, VDIV multiplier = 48)</li> </ul> | —                                  | 1060            | —                                                  | μA   | 8     |
| $I_{\text{pll}}$          | PLL operating current <ul style="list-style-type: none"> <li>PLL @ 48 MHz (<math>f_{\text{osc\_hi\_1}} = 8 \text{ MHz}</math>, <math>f_{\text{pll\_ref}} = 2 \text{ MHz}</math>, VDIV multiplier = 24)</li> </ul> | —                                  | 600             | —                                                  | μA   | 8     |
| $f_{\text{pll\_ref}}$     | PLL reference frequency range                                                                                                                                                                                     | 2.0                                | —               | 4.0                                                | MHz  |       |
| $J_{\text{cyc\_pll}}$     | PLL period jitter (RMS) <ul style="list-style-type: none"> <li><math>f_{\text{VCO}} = 48 \text{ MHz}</math></li> <li><math>f_{\text{VCO}} = 100 \text{ MHz}</math></li> </ul>                                     | —                                  | 120             | —                                                  | ps   | 9     |
|                           |                                                                                                                                                                                                                   | —                                  | 75              | —                                                  | ps   |       |
|                           |                                                                                                                                                                                                                   |                                    |                 |                                                    |      |       |
| $J_{\text{acc\_pll}}$     | PLL accumulated jitter over 1μs (RMS) <ul style="list-style-type: none"> <li><math>f_{\text{VCO}} = 48 \text{ MHz}</math></li> <li><math>f_{\text{VCO}} = 100 \text{ MHz}</math></li> </ul>                       | —                                  | 1350            | —                                                  | ps   | 9     |
|                           |                                                                                                                                                                                                                   | —                                  | 600             | —                                                  | ps   |       |
|                           |                                                                                                                                                                                                                   |                                    |                 |                                                    |      |       |
| $D_{\text{lock}}$         | Lock entry frequency tolerance                                                                                                                                                                                    | ± 1.49                             | —               | ± 2.98                                             | %    |       |
| $D_{\text{unl}}$          | Lock exit frequency tolerance                                                                                                                                                                                     | ± 4.47                             | —               | ± 5.97                                             | %    |       |
| $t_{\text{pll\_lock}}$    | Lock detector detection time                                                                                                                                                                                      | —                                  | —               | $150 \times 10^{-6} + 1075(1/f_{\text{pll\_ref}})$ | s    | 10    |

1. This parameter is measured with the internal reference (slow clock) being used as a reference to the FLL (FEI clock mode).
2.  $2.0 \text{ V} \leq \text{VDD} \leq 3.6 \text{ V}$ .
3. These typical values listed are with the slow internal reference clock (FEI) using factory trim and DMX32=0.
4. The resulting system clock frequencies should not exceed their maximum specified values. The DCO frequency deviation ( $\Delta f_{\text{dco\_t}}$ ) over voltage and temperature should be considered.
5. These typical values listed are with the slow internal reference clock (FEI) using factory trim and DMX32=1.
6. The resulting clock frequency must not exceed the maximum specified clock frequency of the device.
7. This specification applies to any time the FLL reference source or reference divider is changed, trim value is changed, DMX32 bit is changed, DRS bits are changed, or changing from FLL disabled (BLPE, BLPI) to FLL enabled (FEI, FEE, FBE, FBI). If a crystal/resonator is being used as the reference, this specification assumes it is already running.
8. Excludes any oscillator currents that are also consuming power while PLL is in operation.
9. This specification was obtained using a NXP developed PCB. PLL jitter is dependent on the noise characteristics of each PCB and results will vary.
10. This specification applies to any time the PLL VCO divider or reference divider is changed, or changing from PLL disabled (BLPE, BLPI) to PLL enabled (PBE, PEE). If a crystal/resonator is being used as the reference, this specification assumes it is already running.

### 3.3.2 IRC48M specifications

Table 17. IRC48M specifications

| Symbol                      | Description                                                                                                                                                                                                                                                    | Min. | Typ.                   | Max.                   | Unit           | Notes |
|-----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------------------|------------------------|----------------|-------|
| $V_{DD}$                    | Supply voltage                                                                                                                                                                                                                                                 | 1.71 | —                      | 3.6                    | V              |       |
| $I_{DD48M}$                 | Supply current                                                                                                                                                                                                                                                 | —    | 400                    | 500                    | $\mu A$        |       |
| $f_{irc48m}$                | Internal reference frequency                                                                                                                                                                                                                                   | —    | 48                     | —                      | MHz            |       |
| $\Delta f_{irc48m\_ol\_hv}$ | Open loop total deviation of IRC48M frequency at high voltage ( $V_{DD}=1.89V-3.6V$ ) over $0^{\circ}C$ to $70^{\circ}C$<br>Regulator enable<br>( <code>USB_CLK_RECOVER_IRC_EN[REG_EN]=1</code> )                                                              | —    | $\pm 0.2$              | $\pm 0.5$              | $\%f_{irc48m}$ | 1     |
| $\Delta f_{irc48m\_ol\_hv}$ | Open loop total deviation of IRC48M frequency at high voltage ( $V_{DD}=1.89V-3.6V$ ) over full temperature<br>Regulator enable<br>( <code>USB_CLK_RECOVER_IRC_EN[REG_EN]=1</code> )                                                                           | —    | $\pm 0.4$              | $\pm 1.0$              | $\%f_{irc48m}$ | 1     |
| $\Delta f_{irc48m\_ol\_lv}$ | Open loop total deviation of IRC48M frequency at low voltage ( $V_{DD}=1.71V-1.89V$ ) over full temperature<br>Regulator disable<br>( <code>USB_CLK_RECOVER_IRC_EN[REG_EN]=0</code> )<br>Regulator enable<br>( <code>USB_CLK_RECOVER_IRC_EN[REG_EN]=1</code> ) | —    | $\pm 0.4$<br>$\pm 0.5$ | $\pm 1.0$<br>$\pm 1.5$ | $\%f_{irc48m}$ | 1     |
| $\Delta f_{irc48m\_cl}$     | Closed loop total deviation of IRC48M frequency over voltage and temperature                                                                                                                                                                                   | —    | —                      | $\pm 0.1$              | $\%f_{host}$   | 2     |
| $J_{cyc\_irc48m}$           | Period Jitter (RMS)                                                                                                                                                                                                                                            | —    | 35                     | 150                    | ps             |       |
| $t_{irc48mst}$              | Startup time                                                                                                                                                                                                                                                   | —    | 2                      | 3                      | $\mu s$        | 3     |

1. The maximum value represents characterized results equivalent to the mean plus or minus three times the standard deviation (mean  $\pm 3$  sigma).
2. Closed loop operation of the IRC48M is only feasible for USB device operation; it is not usable for USB host operation. It is enabled by configuring for USB Device, selecting IRC48M as USB clock source, and enabling the clock recover function (`USB_CLK_RECOVER_IRC_CTRL[CLOCK_RECOVER_EN]=1`, `USB_CLK_RECOVER_IRC_EN[IRC_EN]=1`).
3. IRC48M startup time is defined as the time between clock enablement and clock availability for system use. Enable the clock by one of the following settings:
  - `USB_CLK_RECOVER_IRC_EN[IRC_EN]=1` or
  - MCG operating in an external clocking mode and `MCG_C7[OSCSEL]=10` or `MCG_C5[PLLCLKEN0]=1`, or
  - `SIM_SOPT2[PLLFLSEL]=11`

### 3.3.3 Oscillator electrical specifications

### 3.3.3.1 Oscillator DC electrical specifications

**Table 18. Oscillator DC electrical specifications**

| Symbol                | Description                                                                                     | Min. | Typ. | Max. | Unit | Notes |
|-----------------------|-------------------------------------------------------------------------------------------------|------|------|------|------|-------|
| $V_{DD}$              | Supply voltage                                                                                  | 1.71 | —    | 3.6  | V    |       |
| $I_{DDOSC}$           | Supply current — low-power mode (HGO=0)                                                         |      |      |      |      | 1     |
|                       | • 32 kHz                                                                                        | —    | 500  | —    | nA   |       |
|                       | • 4 MHz                                                                                         | —    | 200  | —    | μA   |       |
|                       | • 8 MHz (RANGE=01)                                                                              | —    | 300  | —    | μA   |       |
|                       | • 16 MHz                                                                                        | —    | 950  | —    | μA   |       |
|                       | • 24 MHz                                                                                        | —    | 1.2  | —    | mA   |       |
|                       | • 32 MHz                                                                                        | —    | 1.5  | —    | mA   |       |
| $I_{DDOSC}$           | Supply current — high-gain mode (HGO=1)                                                         |      |      |      |      | 1     |
|                       | • 32 kHz                                                                                        | —    | 25   | —    | μA   |       |
|                       | • 4 MHz                                                                                         | —    | 400  | —    | μA   |       |
|                       | • 8 MHz (RANGE=01)                                                                              | —    | 500  | —    | μA   |       |
|                       | • 16 MHz                                                                                        | —    | 2.5  | —    | mA   |       |
|                       | • 24 MHz                                                                                        | —    | 3    | —    | mA   |       |
|                       | • 32 MHz                                                                                        | —    | 4    | —    | mA   |       |
| $C_x$                 | EXTAL load capacitance                                                                          | —    | —    | —    |      | 2, 3  |
| $C_y$                 | XTAL load capacitance                                                                           | —    | —    | —    |      | 2, 3  |
| $R_F$                 | Feedback resistor — low-frequency, low-power mode (HGO=0)                                       | —    | —    | —    | MΩ   | 2, 4  |
|                       | Feedback resistor — low-frequency, high-gain mode (HGO=1)                                       | —    | 10   | —    | MΩ   |       |
|                       | Feedback resistor — high-frequency, low-power mode (HGO=0)                                      | —    | —    | —    | MΩ   |       |
|                       | Feedback resistor — high-frequency, high-gain mode (HGO=1)                                      | —    | 1    | —    | MΩ   |       |
| $R_S$                 | Series resistor — low-frequency, low-power mode (HGO=0)                                         | —    | —    | —    | kΩ   |       |
|                       | Series resistor — low-frequency, high-gain mode (HGO=1)                                         | —    | 200  | —    | kΩ   |       |
|                       | Series resistor — high-frequency, low-power mode (HGO=0)                                        | —    | —    | —    | kΩ   |       |
|                       | Series resistor — high-frequency, high-gain mode (HGO=1)                                        | —    | 0    | —    | kΩ   |       |
| $V_{pp}$ <sup>5</sup> | Peak-to-peak amplitude of oscillation (oscillator mode) — low-frequency, low-power mode (HGO=0) | —    | 0.6  | —    | V    |       |

Table continues on the next page...

**Table 18. Oscillator DC electrical specifications (continued)**

| Symbol | Description                                                                                      | Min. | Typ.            | Max. | Unit | Notes |
|--------|--------------------------------------------------------------------------------------------------|------|-----------------|------|------|-------|
|        | Peak-to-peak amplitude of oscillation (oscillator mode) — low-frequency, high-gain mode (HGO=1)  | —    | V <sub>DD</sub> | —    | V    |       |
|        | Peak-to-peak amplitude of oscillation (oscillator mode) — high-frequency, low-power mode (HGO=0) | —    | 0.6             | —    | V    |       |
|        | Peak-to-peak amplitude of oscillation (oscillator mode) — high-frequency, high-gain mode (HGO=1) | —    | V <sub>DD</sub> | —    | V    |       |

1. V<sub>DD</sub>=3.3 V, Temperature =25 °C
2. See crystal or resonator manufacturer's recommendation
3. C<sub>x</sub> and C<sub>y</sub> can be provided by using either integrated capacitors or external components.
4. When low-power mode is selected, R<sub>F</sub> is integrated and must not be attached externally.
5. The EXTAL and XTAL pins should only be connected to required oscillator components and must not be connected to any other device.

### 3.3.3.2 Oscillator frequency specifications

**Table 19. Oscillator frequency specifications**

| Symbol                | Description                                                                                     | Min. | Typ. | Max. | Unit | Notes |
|-----------------------|-------------------------------------------------------------------------------------------------|------|------|------|------|-------|
| f <sub>osc_lo</sub>   | Oscillator crystal or resonator frequency — low-frequency mode (MCG_C2[RANGE]=00)               | 32   | —    | 40   | kHz  |       |
| f <sub>osc_hi_1</sub> | Oscillator crystal or resonator frequency — high-frequency mode (low range) (MCG_C2[RANGE]=01)  | 3    | —    | 8    | MHz  |       |
| f <sub>osc_hi_2</sub> | Oscillator crystal or resonator frequency — high-frequency mode (high range) (MCG_C2[RANGE]=1x) | 8    | —    | 32   | MHz  |       |
| f <sub>ec_extal</sub> | Input clock frequency (external clock mode)                                                     | —    | —    | 50   | MHz  | 1, 2  |
| t <sub>dc_extal</sub> | Input clock duty cycle (external clock mode)                                                    | 40   | 50   | 60   | %    |       |
| t <sub>cst</sub>      | Crystal startup time — 32 kHz low-frequency, low-power mode (HGO=0)                             | —    | 750  | —    | ms   | 3, 4  |
|                       | Crystal startup time — 32 kHz low-frequency, high-gain mode (HGO=1)                             | —    | 250  | —    | ms   |       |
|                       | Crystal startup time — 8 MHz high-frequency (MCG_C2[RANGE]=01), low-power mode (HGO=0)          | —    | 0.6  | —    | ms   |       |
|                       | Crystal startup time — 8 MHz high-frequency (MCG_C2[RANGE]=01), high-gain mode (HGO=1)          | —    | 1    | —    | ms   |       |

1. Other frequency limits may apply when external clock is being used as a reference for the FLL or PLL.
2. When transitioning from FEI or FBI to FBE mode, restrict the frequency of the input clock so that, when it is divided by FRDIV, it remains within the limits of the DCO input clock frequency.
3. Proper PC board layout procedures must be followed to achieve specifications.

- Crystal startup time is defined as the time between the oscillator being enabled and the OSCINIT bit in the MCG\_S register being set.

### 3.3.4 32 kHz oscillator electrical characteristics

#### 3.3.4.1 32 kHz oscillator DC electrical specifications

Table 20. 32kHz oscillator DC electrical specifications

| Symbol                | Description                                   | Min. | Typ. | Max. | Unit      |
|-----------------------|-----------------------------------------------|------|------|------|-----------|
| $V_{BAT}$             | Supply voltage                                | 1.71 | —    | 3.6  | V         |
| $R_F$                 | Internal feedback resistor                    | —    | 100  | —    | $M\Omega$ |
| $C_{para}$            | Parasitical capacitance of EXTAL32 and XTAL32 | —    | 5    | 7    | pF        |
| $V_{pp}$ <sup>1</sup> | Peak-to-peak amplitude of oscillation         | —    | 0.6  | —    | V         |

- When a crystal is being used with the 32 kHz oscillator, the EXTAL32 and XTAL32 pins should only be connected to required oscillator components and must not be connected to any other devices.

#### 3.3.4.2 32 kHz oscillator frequency specifications

Table 21. 32 kHz oscillator frequency specifications

| Symbol            | Description                               | Min. | Typ.   | Max.      | Unit | Notes |
|-------------------|-------------------------------------------|------|--------|-----------|------|-------|
| $f_{osc\_lo}$     | Oscillator crystal                        | —    | 32.768 | —         | kHz  |       |
| $t_{start}$       | Crystal start-up time                     | —    | 1000   | —         | ms   | 1     |
| $f_{ec\_extal32}$ | Externally provided input clock frequency | —    | 32.768 | —         | kHz  | 2     |
| $V_{ec\_extal32}$ | Externally provided input clock amplitude | 700  | —      | $V_{BAT}$ | mV   | 2, 3  |

- Proper PC board layout procedures must be followed to achieve specifications.
- This specification is for an externally supplied clock driven to EXTAL32 and does not apply to any other clock input. The oscillator remains enabled and XTAL32 must be left unconnected.
- The parameter specified is a peak-to-peak value and  $V_{IH}$  and  $V_{IL}$  specifications do not apply. The voltage of the applied clock must be within the range of  $V_{SS}$  to  $V_{BAT}$ .

## 3.4 Memories and memory interfaces

### 3.4.1 Flash electrical specifications

This section describes the electrical characteristics of the flash memory module.

### 3.4.1.1 Flash timing specifications — program and erase

The following specifications represent the amount of time the internal charge pumps are active and do not include command overhead.

**Table 22. NVM program/erase timing specifications**

| Symbol                | Description                        | Min. | Typ. | Max. | Unit          | Notes |
|-----------------------|------------------------------------|------|------|------|---------------|-------|
| $t_{hvp\text{gm}4}$   | Longword Program high-voltage time | —    | 7.5  | 18   | $\mu\text{s}$ | —     |
| $t_{h\text{versscr}}$ | Sector Erase high-voltage time     | —    | 13   | 113  | ms            | 1     |
| $t_{h\text{versall}}$ | Erase All high-voltage time        | —    | 104  | 904  | ms            | 1     |

1. Maximum time based on expectations at cycling end-of-life.

### 3.4.1.2 Flash timing specifications — commands

**Table 23. Flash command timing specifications**

| Symbol                | Description                                   | Min. | Typ. | Max. | Unit          | Notes |
|-----------------------|-----------------------------------------------|------|------|------|---------------|-------|
| $t_{rd1\text{sec}2k}$ | Read 1s Section execution time (flash sector) | —    | —    | 60   | $\mu\text{s}$ | 1     |
| $t_{pgmchk}$          | Program Check execution time                  | —    | —    | 45   | $\mu\text{s}$ | 1     |
| $t_{rd\text{rsrc}}$   | Read Resource execution time                  | —    | —    | 30   | $\mu\text{s}$ | 1     |
| $t_{pgm4}$            | Program Longword execution time               | —    | 65   | 145  | $\mu\text{s}$ | —     |
| $t_{er\text{sscr}}$   | Erase Flash Sector execution time             | —    | 14   | 114  | ms            | 2     |
| $t_{rd1\text{all}}$   | Read 1s All Blocks execution time             | —    | —    | 1.8  | ms            | 1     |
| $t_{rd\text{once}}$   | Read Once execution time                      | —    | —    | 30   | $\mu\text{s}$ | 1     |
| $t_{pgm\text{once}}$  | Program Once execution time                   | —    | 100  | —    | $\mu\text{s}$ | —     |
| $t_{er\text{all}}$    | Erase All Blocks execution time               | —    | 175  | 1300 | ms            | 2     |
| $t_{vfy\text{key}}$   | Verify Backdoor Access Key execution time     | —    | —    | 30   | $\mu\text{s}$ | 1     |

1. Assumes 25 MHz flash clock frequency.
2. Maximum times for erase parameters based on expectations at cycling end-of-life.

### 3.4.1.3 Flash high voltage current behaviors

**Table 24. Flash high voltage current behaviors**

| Symbol        | Description                                                           | Min. | Typ. | Max. | Unit |
|---------------|-----------------------------------------------------------------------|------|------|------|------|
| $I_{DD\_PGM}$ | Average current adder during high voltage flash programming operation | —    | 2.5  | 6.0  | mA   |
| $I_{DD\_ERS}$ | Average current adder during high voltage flash erase operation       | —    | 1.5  | 4.0  | mA   |

### 3.4.1.4 Reliability specifications

**Table 25. NVM reliability specifications**

| Symbol                  | Description                            | Min. | Typ. <sup>1</sup> | Max. | Unit   | Notes |
|-------------------------|----------------------------------------|------|-------------------|------|--------|-------|
| Program Flash           |                                        |      |                   |      |        |       |
| $t_{\text{nvmretp10k}}$ | Data retention after up to 10 K cycles | 5    | 50                | —    | years  | —     |
| $t_{\text{nvmretp1k}}$  | Data retention after up to 1 K cycles  | 20   | 100               | —    | years  | —     |
| $n_{\text{nvmcycp}}$    | Cycling endurance                      | 10 K | 50 K              | —    | cycles | 2     |

1. Typical data retention values are based on measured response accelerated at high temperature and derated to a constant 25 °C use profile. Engineering Bulletin EB618 does not apply to this technology. Typical endurance defined in Engineering Bulletin EB619.
2. Cycling endurance represents number of program/erase cycles at  $-40\text{ °C} \leq T_j \leq 125\text{ °C}$ .

### 3.4.2 EzPort switching specifications

**Table 26. EzPort switching specifications**

| Num  | Description                                                     | Min.                          | Max.               | Unit |
|------|-----------------------------------------------------------------|-------------------------------|--------------------|------|
|      | Operating voltage                                               | 1.71                          | 3.6                | V    |
| EP1  | EZP_CK frequency of operation (all commands except READ)        | —                             | $f_{\text{SYS}}/2$ | MHz  |
| EP1a | EZP_CK frequency of operation (READ command)                    | —                             | $f_{\text{SYS}}/8$ | MHz  |
| EP2  | $\overline{\text{EZP\_CS}}$ negation to next EZP_CS assertion   | $2 \times t_{\text{EZP\_CK}}$ | —                  | ns   |
| EP3  | $\overline{\text{EZP\_CS}}$ input valid to EZP_CK high (setup)  | 5                             | —                  | ns   |
| EP4  | EZP_CK high to $\overline{\text{EZP\_CS}}$ input invalid (hold) | 5                             | —                  | ns   |
| EP5  | EZP_D input valid to EZP_CK high (setup)                        | 2                             | —                  | ns   |
| EP6  | EZP_CK high to EZP_D input invalid (hold)                       | 5                             | —                  | ns   |
| EP7  | EZP_CK low to EZP_Q output valid                                | —                             | 25                 | ns   |
| EP8  | EZP_CK low to EZP_Q output invalid (hold)                       | 0                             | —                  | ns   |
| EP9  | $\overline{\text{EZP\_CS}}$ negation to EZP_Q tri-state         | —                             | 12                 | ns   |

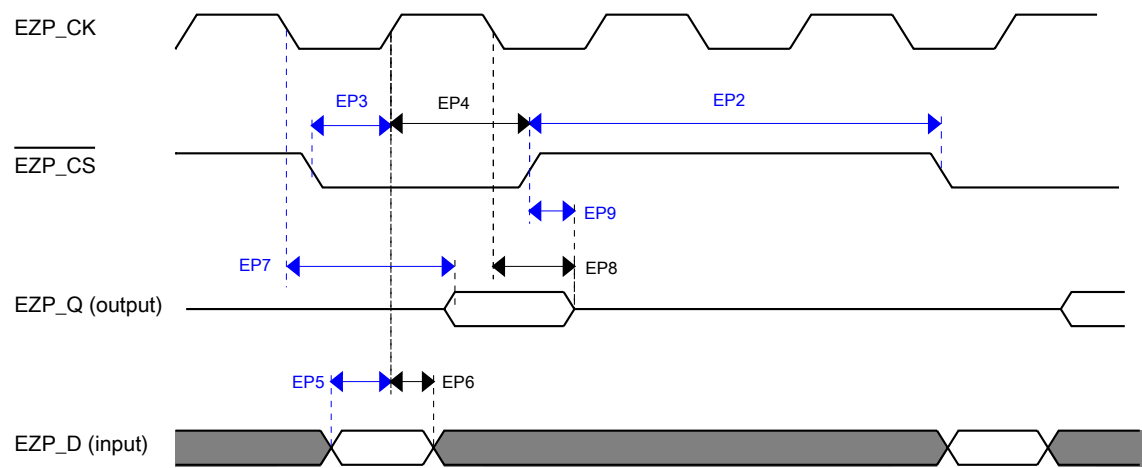


Figure 11. EzPort Timing Diagram

### 3.5 Security and integrity modules

There are no specifications necessary for the device's security and integrity modules.

### 3.6 Analog

#### 3.6.1 ADC electrical specifications

The 16-bit accuracy specifications listed in [Table 27](#) and [Table 28](#) are achievable on the differential pins ADCx\_DPx, ADCx\_DMx.

All other ADC channels meet the 13-bit differential/12-bit single-ended accuracy specifications.

##### 3.6.1.1 16-bit ADC operating conditions

Table 27. 16-bit ADC operating conditions

| Symbol            | Description    | Conditions                                                     | Min. | Typ. <sup>1</sup> | Max. | Unit | Notes             |
|-------------------|----------------|----------------------------------------------------------------|------|-------------------|------|------|-------------------|
| V <sub>DDA</sub>  | Supply voltage | Absolute                                                       | 1.71 | —                 | 3.6  | V    |                   |
| ΔV <sub>DDA</sub> | Supply voltage | Delta to V <sub>DD</sub> (V <sub>DD</sub> – V <sub>DDA</sub> ) | -100 | 0                 | +100 | mV   | <a href="#">2</a> |

Table continues on the next page...

**Table 27. 16-bit ADC operating conditions (continued)**

| Symbol           | Description                         | Conditions                                                                                                     | Min.           | Typ. <sup>1</sup> | Max.                      | Unit       | Notes |
|------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------|----------------|-------------------|---------------------------|------------|-------|
| $\Delta V_{SSA}$ | Ground voltage                      | Delta to $V_{SS}$ ( $V_{SS} - V_{SSA}$ )                                                                       | -100           | 0                 | +100                      | mV         | 2     |
| $V_{REFH}$       | ADC reference voltage high          |                                                                                                                | 1.13           | $V_{DDA}$         | $V_{DDA}$                 | V          |       |
| $V_{REFL}$       | ADC reference voltage low           |                                                                                                                | $V_{SSA}$      | $V_{SSA}$         | $V_{SSA}$                 | V          |       |
| $V_{ADIN}$       | Input voltage                       | <ul style="list-style-type: none"> <li>16-bit differential mode</li> <li>All other modes</li> </ul>            | VREFL<br>VREFL | —<br>—            | 31/32 *<br>VREFH<br>VREFH | V          |       |
| $C_{ADIN}$       | Input capacitance                   | <ul style="list-style-type: none"> <li>16-bit mode</li> <li>8-bit / 10-bit / 12-bit modes</li> </ul>           | —<br>—         | 8<br>4            | 10<br>5                   | pF         |       |
| $R_{ADIN}$       | Input series resistance             |                                                                                                                | —              | 2                 | 5                         | k $\Omega$ |       |
| $R_{AS}$         | Analog source resistance (external) | 13-bit / 12-bit modes<br>$f_{ADCK} < 4$ MHz                                                                    | —              | —                 | 5                         | k $\Omega$ | 3     |
| $f_{ADCK}$       | ADC conversion clock frequency      | $\leq$ 13-bit mode                                                                                             | 1.0            | —                 | 24.0                      | MHz        | 4     |
| $f_{ADCK}$       | ADC conversion clock frequency      | 16-bit mode                                                                                                    | 2.0            | —                 | 12.0                      | MHz        | 4     |
| $C_{rate}$       | ADC conversion rate                 | $\leq$ 13-bit modes<br>No ADC hardware averaging<br>Continuous conversions enabled, subsequent conversion time | 20             | —                 | 1200                      | Ksps       | 5     |
| $C_{rate}$       | ADC conversion rate                 | 16-bit mode<br>No ADC hardware averaging<br>Continuous conversions enabled, subsequent conversion time         | 37             | —                 | 461                       | Ksps       | 5     |

1. Typical values assume  $V_{DDA} = 3.0$  V, Temp = 25 °C,  $f_{ADCK} = 1.0$  MHz, unless otherwise stated. Typical values are for reference only, and are not tested in production.
2. DC potential difference.
3. This resistance is external to MCU. To achieve the best results, the analog source resistance must be kept as low as possible. The results in this data sheet were derived from a system that had  $< 8 \Omega$  analog source resistance. The  $R_{AS}/C_{AS}$  time constant should be kept to  $< 1$  ns.
4. To use the maximum ADC conversion clock frequency, CFG2[ADHSC] must be set and CFG1[ADLPC] must be clear.
5. For guidelines and examples of conversion rate calculation, download the [ADC calculator tool](#).

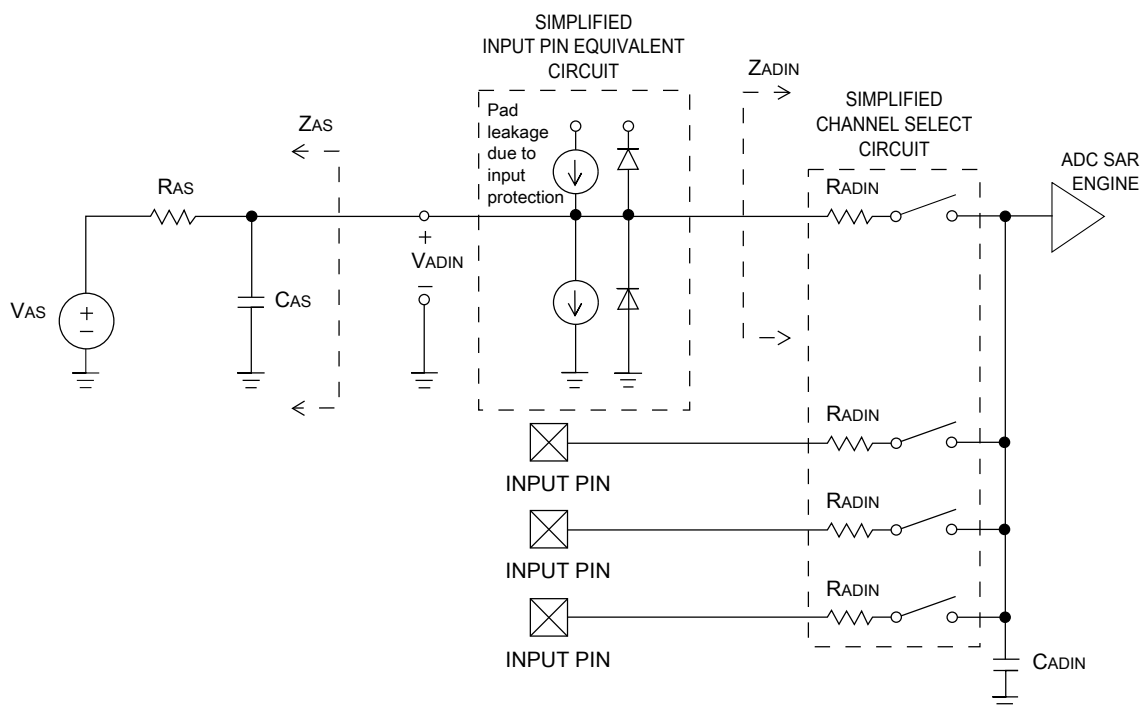


Figure 12. ADC input impedance equivalency diagram

### 3.6.1.2 16-bit ADC electrical characteristics

Table 28. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ )

| Symbol         | Description                   | Conditions <sup>1</sup>                                                                                                                                                  | Min.                     | Typ. <sup>2</sup>        | Max.                        | Unit                     | Notes                     |
|----------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|--------------------------|-----------------------------|--------------------------|---------------------------|
| $I_{DDA\_ADC}$ | Supply current                |                                                                                                                                                                          | 0.215                    | —                        | 1.7                         | mA                       | 3                         |
| $f_{ADACK}$    | ADC asynchronous clock source | <ul style="list-style-type: none"> <li>• ADLPC = 1, ADHSC = 0</li> <li>• ADLPC = 1, ADHSC = 1</li> <li>• ADLPC = 0, ADHSC = 0</li> <li>• ADLPC = 0, ADHSC = 1</li> </ul> | 1.2<br>2.4<br>3.0<br>4.4 | 2.4<br>4.0<br>5.2<br>6.2 | 3.9<br>6.1<br>7.3<br>9.5    | MHz<br>MHz<br>MHz<br>MHz | $t_{ADACK} = 1/f_{ADACK}$ |
|                | Sample Time                   | See Reference Manual chapter for sample times                                                                                                                            |                          |                          |                             |                          |                           |
| TUE            | Total unadjusted error        | <ul style="list-style-type: none"> <li>• 12-bit modes</li> <li>• &lt;12-bit modes</li> </ul>                                                                             | —<br>—                   | $\pm 4$<br>$\pm 1.4$     | $\pm 6.8$<br>$\pm 2.1$      | LSB <sup>4</sup>         | 5                         |
| DNL            | Differential non-linearity    | <ul style="list-style-type: none"> <li>• 12-bit modes</li> <li>• &lt;12-bit modes</li> </ul>                                                                             | —<br>—                   | $\pm 0.7$<br>$\pm 0.2$   | -1.1 to +1.9<br>-0.3 to 0.5 | LSB <sup>4</sup>         | 5                         |
| INL            | Integral non-linearity        | <ul style="list-style-type: none"> <li>• 12-bit modes</li> </ul>                                                                                                         | —                        | $\pm 1.0$                | -2.7 to +1.9                | LSB <sup>4</sup>         | 5                         |

Table continues on the next page...

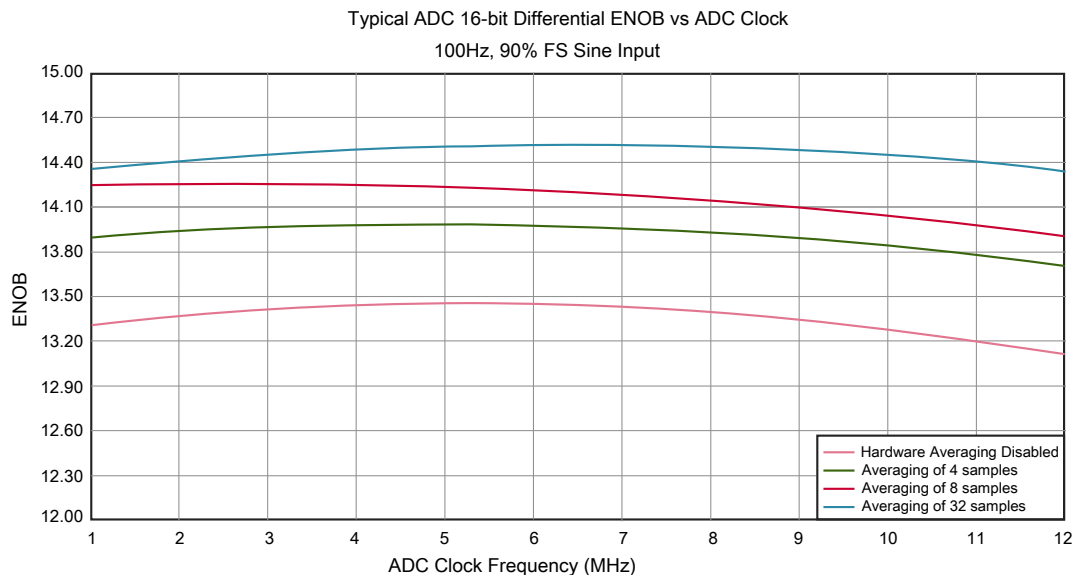
**Table 28. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ ) (continued)**

| Symbol       | Description                     | Conditions <sup>1</sup>                                                                                                                                                                                   | Min.                      | Typ. <sup>2</sup> | Max.         | Unit             | Notes                                                                                    |
|--------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|-------------------|--------------|------------------|------------------------------------------------------------------------------------------|
|              |                                 | <ul style="list-style-type: none"> <li>&lt;12-bit modes</li> </ul>                                                                                                                                        | —                         | ±0.5              | –0.7 to +0.5 |                  |                                                                                          |
| $E_{FS}$     | Full-scale error                | <ul style="list-style-type: none"> <li>12-bit modes</li> <li>&lt;12-bit modes</li> </ul>                                                                                                                  | —                         | –4                | –5.4         | LSB <sup>4</sup> | $V_{ADIN} = V_{DDA}$ <sup>5</sup>                                                        |
| $E_Q$        | Quantization error              | <ul style="list-style-type: none"> <li>16-bit modes</li> <li>≤13-bit modes</li> </ul>                                                                                                                     | —                         | –1 to 0           | —            | LSB <sup>4</sup> |                                                                                          |
| $ENOB$       | Effective number of bits        | 16-bit differential mode <ul style="list-style-type: none"> <li>Avg = 32</li> <li>Avg = 4</li> </ul> 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg = 32</li> <li>Avg = 4</li> </ul> | 12.8<br>11.9              | 14.5<br>13.8      | —<br>—       | bits<br>bits     | 6                                                                                        |
|              |                                 |                                                                                                                                                                                                           |                           |                   |              | bits             |                                                                                          |
|              |                                 |                                                                                                                                                                                                           |                           |                   |              | bits             |                                                                                          |
|              |                                 |                                                                                                                                                                                                           |                           |                   |              | bits             |                                                                                          |
| $SINAD$      | Signal-to-noise plus distortion | See ENOB                                                                                                                                                                                                  | $6.02 \times ENOB + 1.76$ |                   |              | dB               |                                                                                          |
| $THD$        | Total harmonic distortion       | 16-bit differential mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>                                   | —                         | –94               | —            | dB<br>dB         | 7                                                                                        |
|              |                                 |                                                                                                                                                                                                           | —                         | –85               | —            |                  |                                                                                          |
| $SFDR$       | Spurious free dynamic range     | 16-bit differential mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>                                   | 82                        | 95                | —            | dB<br>dB         | 7                                                                                        |
|              |                                 |                                                                                                                                                                                                           | 78                        | 90                | —            |                  |                                                                                          |
| $E_{IL}$     | Input leakage error             |                                                                                                                                                                                                           | $I_{in} \times R_{AS}$    |                   |              | mV               | $I_{in}$ = leakage current<br>(refer to the MCU's voltage and current operating ratings) |
|              | Temp sensor slope               | Across the full temperature range of the device                                                                                                                                                           | 1.55                      | 1.62              | 1.69         | mV/°C            | 8                                                                                        |
| $V_{TEMP25}$ | Temp sensor voltage             | 25 °C                                                                                                                                                                                                     | 706                       | 716               | 726          | mV               | 8                                                                                        |

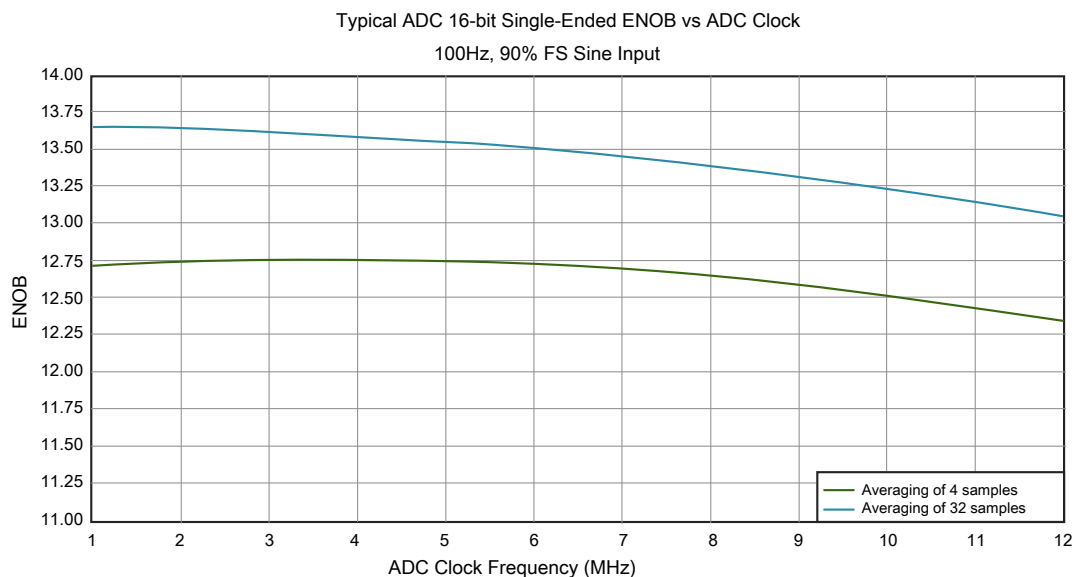
1. All accuracy numbers assume the ADC is calibrated with  $V_{REFH} = V_{DDA}$
2. Typical values assume  $V_{DDA} = 3.0$  V, Temp = 25 °C,  $f_{ADCK} = 2.0$  MHz unless otherwise stated. Typical values are for reference only and are not tested in production.
3. The ADC supply current depends on the ADC conversion clock speed, conversion rate and ADC\_CFG1[ADLPC] (low power). For lowest power operation, ADC\_CFG1[ADLPC] must be set, the ADC\_CFG2[ADHSC] bit must be clear with 1 MHz ADC conversion clock speed.

## Peripheral operating requirements and behaviors

4.  $1 \text{ LSB} = (V_{\text{REFH}} - V_{\text{REFL}})/2^N$
5. ADC conversion clock < 16 MHz, Max hardware averaging (AVGE = %1, AVGS = %11)
6. Input data is 100 Hz sine wave. ADC conversion clock < 12 MHz.
7. Input data is 1 kHz sine wave. ADC conversion clock < 12 MHz.
8. ADC conversion clock < 3 MHz



**Figure 13. Typical ENOB vs. ADC\_CLK for 16-bit differential mode**



**Figure 14. Typical ENOB vs. ADC\_CLK for 16-bit single-ended mode**

### 3.6.2 CMP and 6-bit DAC electrical specifications

**Table 29. Comparator and 6-bit DAC electrical specifications**

| Symbol      | Description                                                                                                                                                                                    | Min.           | Typ. | Max.     | Unit             |
|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|------|----------|------------------|
| $V_{DD}$    | Supply voltage                                                                                                                                                                                 | 1.71           | —    | 3.6      | V                |
| $I_{DDHS}$  | Supply current, High-speed mode (EN=1, PMODE=1)                                                                                                                                                | —              | —    | 200      | $\mu$ A          |
| $I_{DLS}$   | Supply current, low-speed mode (EN=1, PMODE=0)                                                                                                                                                 | —              | —    | 20       | $\mu$ A          |
| $V_{AIN}$   | Analog input voltage                                                                                                                                                                           | $V_{SS} - 0.3$ | —    | $V_{DD}$ | V                |
| $V_{AIO}$   | Analog input offset voltage                                                                                                                                                                    | —              | —    | 20       | mV               |
| $V_H$       | Analog comparator hysteresis <sup>1</sup> <ul style="list-style-type: none"> <li>CR0[HYSTCTR] = 00</li> <li>CR0[HYSTCTR] = 01</li> <li>CR0[HYSTCTR] = 10</li> <li>CR0[HYSTCTR] = 11</li> </ul> | —              | 5    | —        | mV               |
|             |                                                                                                                                                                                                | —              | 10   | —        | mV               |
|             |                                                                                                                                                                                                | —              | 20   | —        | mV               |
|             |                                                                                                                                                                                                | —              | 30   | —        | mV               |
| $V_{CMPOH}$ | Output high                                                                                                                                                                                    | $V_{DD} - 0.5$ | —    | —        | V                |
| $V_{CMPOI}$ | Output low                                                                                                                                                                                     | —              | —    | 0.5      | V                |
| $t_{DHS}$   | Propagation delay, high-speed mode (EN=1, PMODE=1)                                                                                                                                             | 20             | 50   | 200      | ns               |
| $t_{DLS}$   | Propagation delay, low-speed mode (EN=1, PMODE=0)                                                                                                                                              | 80             | 250  | 600      | ns               |
|             | Analog comparator initialization delay <sup>2</sup>                                                                                                                                            | —              | —    | 40       | $\mu$ s          |
| $I_{DAC6b}$ | 6-bit DAC current adder (enabled)                                                                                                                                                              | —              | 7    | —        | $\mu$ A          |
| INL         | 6-bit DAC integral non-linearity                                                                                                                                                               | −0.5           | —    | 0.5      | LSB <sup>3</sup> |
| DNL         | 6-bit DAC differential non-linearity                                                                                                                                                           | −0.3           | —    | 0.3      | LSB              |

1. Typical hysteresis is measured with input voltage range limited to 0.6 to  $V_{DD}-0.6$  V.
2. Comparator initialization delay is defined as the time between software writes to change control inputs (Writes to CMP\_DACCR[DACEN], CMP\_DACCR[VRSEL], CMP\_DACCR[VOSEL], CMP\_MUXCR[PSEL], and CMP\_MUXCR[MSEL]) and the comparator output settling to a stable level.
3. 1 LSB =  $V_{reference}/64$

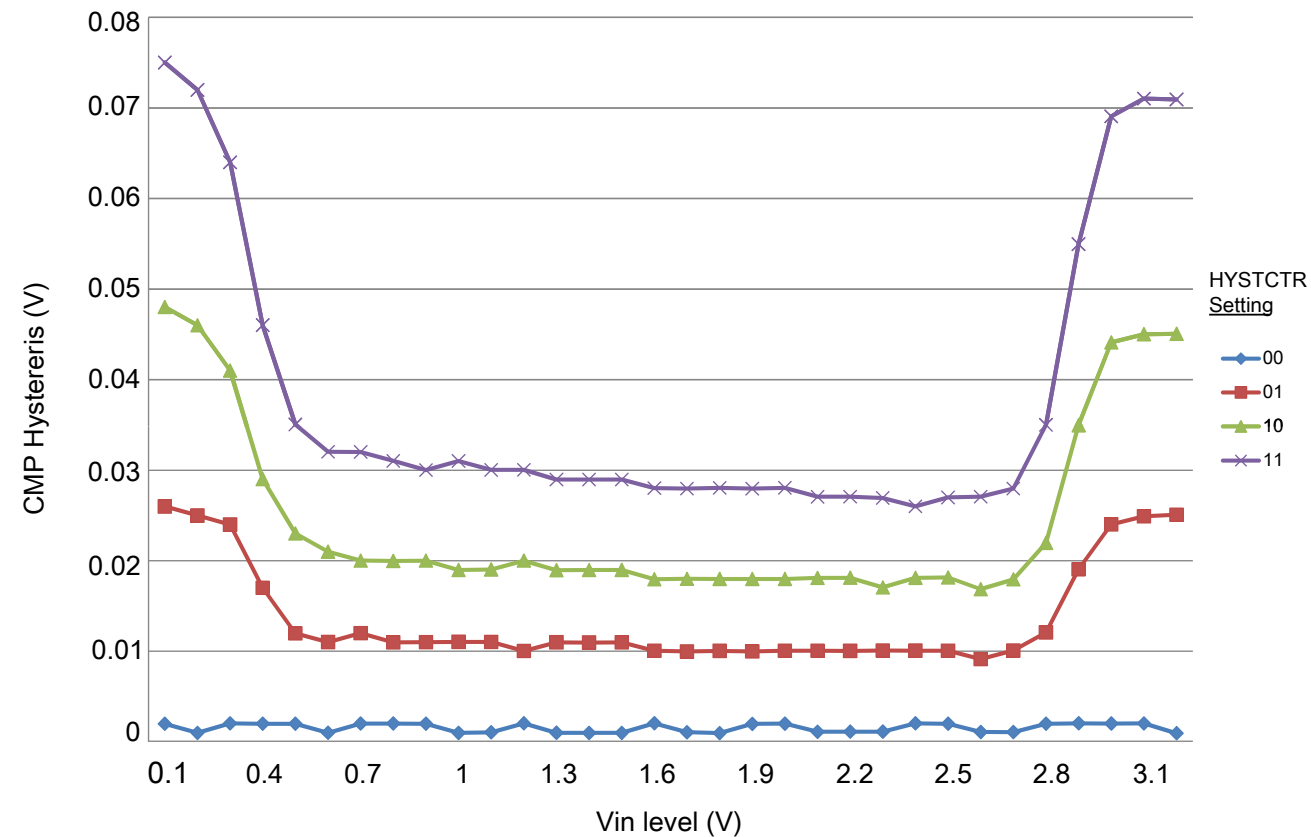


Figure 15. Typical hysteresis vs. Vin level (VDD = 3.3 V, PMODE = 0)

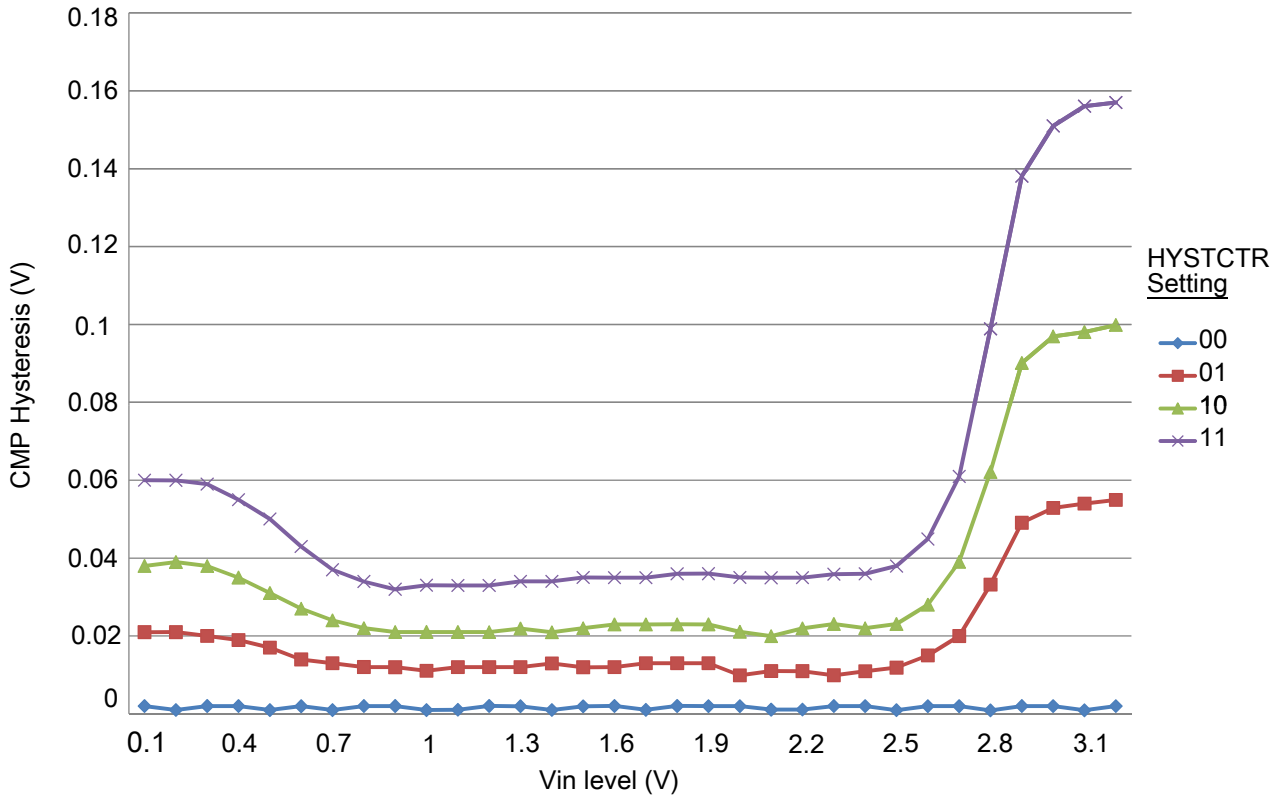


Figure 16. Typical hysteresis vs. Vin level (VDD = 3.3 V, PMODE = 1)

### 3.6.3 12-bit DAC electrical characteristics

#### 3.6.3.1 12-bit DAC operating requirements

Table 30. 12-bit DAC operating requirements

| Symbol     | Description             | Min. | Max. | Unit | Notes |
|------------|-------------------------|------|------|------|-------|
| $V_{DDA}$  | Supply voltage          | 1.71 | 3.6  | V    |       |
| $V_{DACR}$ | Reference voltage       | 1.13 | 3.6  | V    | 1     |
| $C_L$      | Output load capacitance | —    | 100  | pF   | 2     |
| $I_L$      | Output load current     | —    | 1    | mA   |       |

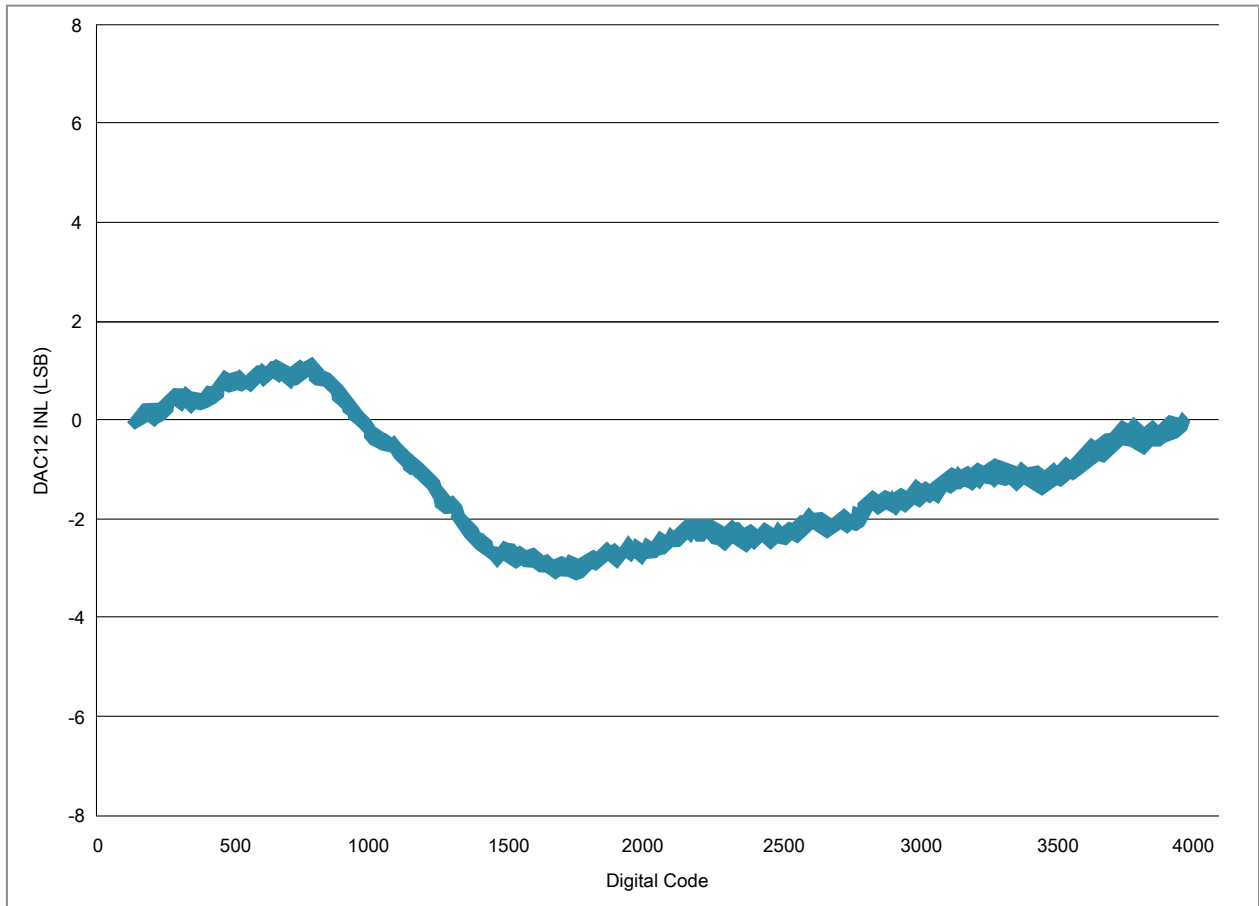
1. The DAC reference can be selected to be  $V_{DDA}$  or  $V_{REFH}$ .
2. A small load capacitance (47 pF) can improve the bandwidth performance of the DAC.

### 3.6.3.2 12-bit DAC operating behaviors

Table 31. 12-bit DAC operating behaviors

| Symbol           | Description                                                                                                                                     | Min.             | Typ.        | Max.       | Unit       | Notes |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-------------|------------|------------|-------|
| $I_{DDA\_DACLP}$ | Supply current — low-power mode                                                                                                                 | —                | —           | 330        | $\mu A$    |       |
| $I_{DDA\_DACHP}$ | Supply current — high-speed mode                                                                                                                | —                | —           | 1200       | $\mu A$    |       |
| $t_{DACLP}$      | Full-scale settling time (0x080 to 0xF7F) — low-power mode                                                                                      | —                | 100         | 200        | $\mu s$    | 1     |
| $t_{DACHP}$      | Full-scale settling time (0x080 to 0xF7F) — high-power mode                                                                                     | —                | 15          | 30         | $\mu s$    | 1     |
| $t_{CCDACLP}$    | Code-to-code settling time (0xBF8 to 0xC08) — low-power mode and high-speed mode                                                                | —                | 0.7         | 1          | $\mu s$    | 1     |
| $V_{dacoutl}$    | DAC output voltage range low — high-speed mode, no load, DAC set to 0x000                                                                       | —                | —           | 100        | mV         |       |
| $V_{dacouth}$    | DAC output voltage range high — high-speed mode, no load, DAC set to 0xFFF                                                                      | $V_{DACR} - 100$ | —           | $V_{DACR}$ | mV         |       |
| INL              | Integral non-linearity error — high speed mode                                                                                                  | —                | —           | $\pm 8$    | LSB        | 2     |
| DNL              | Differential non-linearity error — $V_{DACR} > 2 V$                                                                                             | —                | —           | $\pm 1$    | LSB        | 3     |
| DNL              | Differential non-linearity error — $V_{DACR} = V_{REF\_OUT}$                                                                                    | —                | —           | $\pm 1$    | LSB        | 4     |
| $V_{OFFSET}$     | Offset error                                                                                                                                    | —                | $\pm 0.4$   | $\pm 0.8$  | %FSR       | 5     |
| $E_G$            | Gain error                                                                                                                                      | —                | $\pm 0.1$   | $\pm 0.6$  | %FSR       | 5     |
| PSRR             | Power supply rejection ratio, $V_{DDA} \geq 2.4 V$                                                                                              | 60               | —           | 90         | dB         |       |
| $T_{CO}$         | Temperature coefficient offset voltage                                                                                                          | —                | 3.7         | —          | $\mu V/C$  | 6     |
| $T_{GE}$         | Temperature coefficient gain error                                                                                                              | —                | 0.000421    | —          | %FSR/C     |       |
| R <sub>op</sub>  | Output resistance (load = 3 k $\Omega$ )                                                                                                        | —                | —           | 250        | $\Omega$   |       |
| SR               | Slew rate -80h → F7Fh → 80h <ul style="list-style-type: none"> <li>High power (SP<sub>HP</sub>)</li> <li>Low power (SP<sub>LP</sub>)</li> </ul> | 1.2<br>0.05      | 1.7<br>0.12 | —<br>—     | V/ $\mu s$ |       |
| BW               | 3dB bandwidth <ul style="list-style-type: none"> <li>High power (SP<sub>HP</sub>)</li> <li>Low power (SP<sub>LP</sub>)</li> </ul>               | 550<br>40        | —<br>—      | —<br>—     | kHz        |       |

- Settling within  $\pm 1$  LSB
- The INL is measured for 0 + 100 mV to  $V_{DACR} - 100$  mV
- The DNL is measured for 0 + 100 mV to  $V_{DACR} - 100$  mV
- The DNL is measured for 0 + 100 mV to  $V_{DACR} - 100$  mV with  $V_{DDA} > 2.4 V$
- Calculated by a best fit curve from  $V_{SS} + 100$  mV to  $V_{DACR} - 100$  mV
- $V_{DDA} = 3.0 V$ , reference select set for  $V_{DDA}$  (DACx\_CO:DACRFS = 1), high power mode (DACx\_CO:LPEN = 0), DAC set to 0x800, temperature range is across the full range of the device



**Figure 17. Typical INL error vs. digital code**

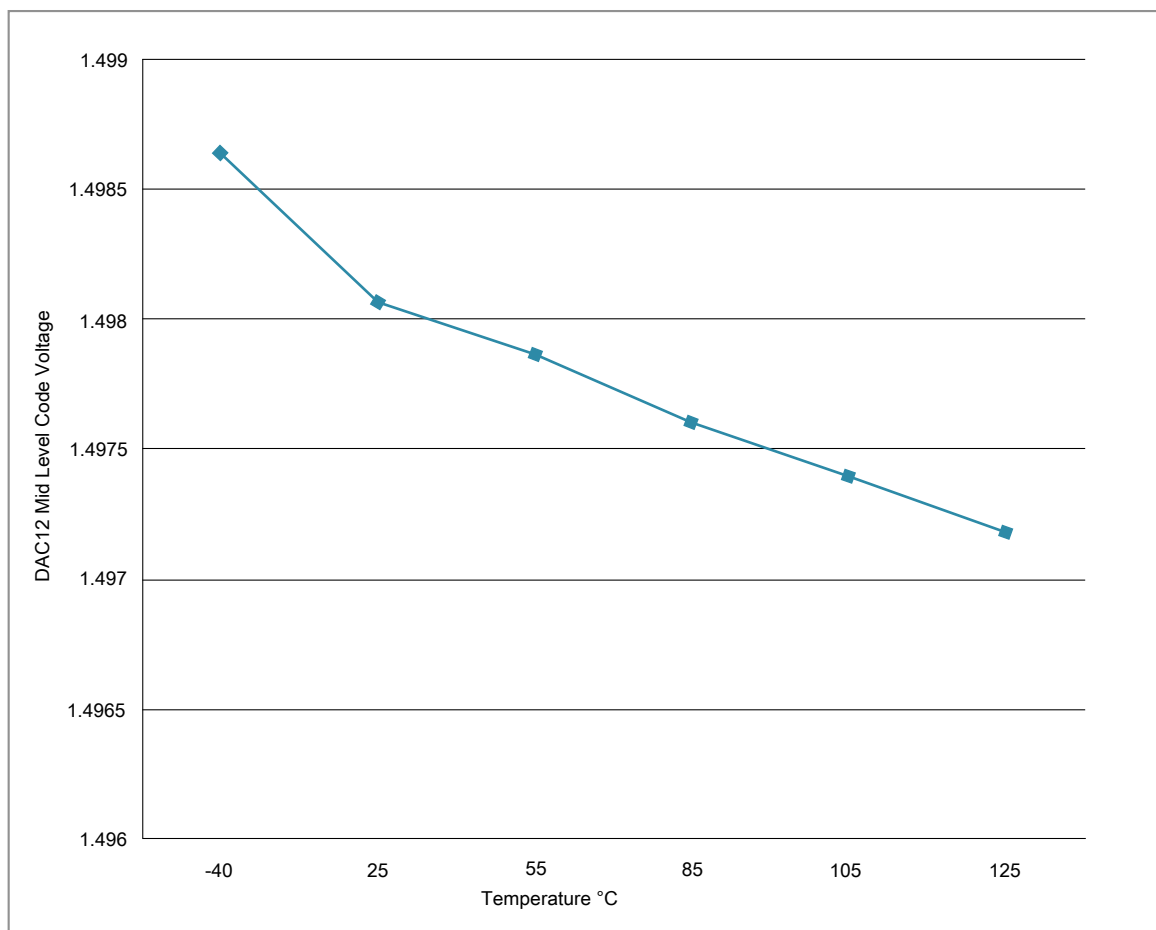


Figure 18. Offset at half scale vs. temperature

### 3.6.4 Voltage reference electrical specifications

Table 32. VREF full-range operating requirements

| Symbol    | Description             | Min.                                      | Max. | Unit | Notes |
|-----------|-------------------------|-------------------------------------------|------|------|-------|
| $V_{DDA}$ | Supply voltage          | 1.71                                      | 3.6  | V    |       |
| $T_A$     | Temperature             | Operating temperature range of the device |      | °C   |       |
| $C_L$     | Output load capacitance | 100                                       |      | nF   | 1, 2  |

1.  $C_L$  must be connected to VREF\_OUT if the VREF\_OUT functionality is being used for either an internal or external reference.
2. The load capacitance should not exceed +/-25% of the nominal specified  $C_L$  value over the operating temperature range of the device.

**Table 33. VREF full-range operating behaviors**

| Symbol                  | Description                                                                          | Min.   | Typ.   | Max.   | Unit | Notes |
|-------------------------|--------------------------------------------------------------------------------------|--------|--------|--------|------|-------|
| $V_{out}$               | Voltage reference output with factory trim at nominal $V_{DDA}$ and temperature=25°C | 1.1920 | 1.1950 | 1.1980 | V    | 1     |
| $V_{out}$               | Voltage reference output with user trim at nominal $V_{DDA}$ and temperature=25°C    | 1.1945 | 1.1950 | 1.1955 | V    | 1     |
| $V_{step}$              | Voltage reference trim step                                                          | —      | 0.5    | —      | mV   | 1     |
| $V_{tdrift}$            | Temperature drift ( $V_{max} - V_{min}$ across the full temperature range)           | —      | —      | 15     | mV   | 1     |
| $I_{bg}$                | Bandgap only current                                                                 | —      | —      | 80     | μA   |       |
| $I_{lp}$                | Low-power buffer current                                                             | —      | —      | 360    | uA   | 1     |
| $I_{hp}$                | High-power buffer current                                                            | —      | —      | 1      | mA   | 1     |
| $\Delta V_{LOAD}$       | Load regulation<br>• current = ± 1.0 mA                                              | —      | 200    | —      | μV   | 1, 2  |
| $T_{stup}$              | Buffer startup time                                                                  | —      | —      | 100    | μs   |       |
| $T_{chop\_osc\_st\_up}$ | Internal bandgap start-up delay with chop oscillator enabled                         | —      | —      | 35     | ms   |       |
| $V_{vdrift}$            | Voltage drift ( $V_{max} - V_{min}$ across the full voltage range)                   | —      | 2      | —      | mV   | 1     |

1. See the chip's Reference Manual for the appropriate settings of the VREF Status and Control register.
2. Load regulation voltage is the difference between the VREF\_OUT voltage with no load vs. voltage with defined load

**Table 34. VREF limited-range operating requirements**

| Symbol | Description | Min. | Max. | Unit | Notes |
|--------|-------------|------|------|------|-------|
| $T_A$  | Temperature | 0    | 70   | °C   |       |

**Table 35. VREF limited-range operating behaviors**

| Symbol       | Description                                                                   | Min. | Max. | Unit | Notes |
|--------------|-------------------------------------------------------------------------------|------|------|------|-------|
| $V_{tdrift}$ | Temperature drift ( $V_{max} - V_{min}$ across the limited temperature range) | —    | 10   | mV   |       |

## 3.7 Timers

See [General switching specifications](#).

## 3.8 Communication interfaces

### 3.8.1 USB electrical specifications

The USB electricals for the USB On-the-Go module conform to the standards documented by the Universal Serial Bus Implementers Forum. For the most up-to-date standards, visit [usb.org](http://usb.org).

#### NOTE

The MCGPLLCLK meets the USB jitter and signaling rate specifications for certification with the use of an external clock/crystal for both Device and Host modes.

The MCGFLLCLK does not meet the USB jitter or signaling rate specifications for certification.

The IRC48M meets the USB jitter and signaling rate specifications for certification in Device mode when the USB clock recovery mode is enabled. It does not meet the USB signaling rate specifications for certification in Host mode operation.

### 3.8.2 USB VREG electrical specifications

**Table 36. USB VREG electrical specifications**

| Symbol                | Description                                                                                                                                                                | Min. | Typ. <sup>1</sup> | Max. | Unit | Notes |
|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-------------------|------|------|-------|
| VREGIN                | Input supply voltage                                                                                                                                                       | 2.7  | —                 | 5.5  | V    |       |
| I <sub>DDon</sub>     | Quiescent current — Run mode, load current equal zero, input supply (VREGIN) > 3.6 V                                                                                       | —    | 125               | 186  | μA   |       |
| I <sub>DDstby</sub>   | Quiescent current — Standby mode, load current equal zero                                                                                                                  | —    | 1.1               | 10   | μA   |       |
| I <sub>DDoff</sub>    | Quiescent current — Shutdown mode <ul style="list-style-type: none"> <li>VREGIN = 5.0 V and temperature=25 °C</li> <li>Across operating voltage and temperature</li> </ul> | —    | 650               | —    | nA   |       |
|                       |                                                                                                                                                                            | —    | —                 | 4    | μA   |       |
| I <sub>LOADrun</sub>  | Maximum load current — Run mode                                                                                                                                            | —    | —                 | 120  | mA   |       |
| I <sub>LOADstby</sub> | Maximum load current — Standby mode                                                                                                                                        | —    | —                 | 1    | mA   |       |
| V <sub>Reg33out</sub> | Regulator output voltage — Input supply (VREGIN) > 3.6 V <ul style="list-style-type: none"> <li>Run mode</li> <li>Standby mode</li> </ul>                                  | 3    | 3.3               | 3.6  | V    |       |
|                       |                                                                                                                                                                            | 2.1  | 2.8               | 3.6  | V    |       |

*Table continues on the next page...*

**Table 36. USB VREG electrical specifications  
(continued)**

| Symbol                | Description                                                                 | Min. | Typ. <sup>1</sup> | Max. | Unit | Notes |
|-----------------------|-----------------------------------------------------------------------------|------|-------------------|------|------|-------|
| V <sub>Reg33out</sub> | Regulator output voltage — Input supply (VREGIN) < 3.6 V, pass-through mode | 2.1  | —                 | 3.6  | V    | 2     |
| C <sub>OUT</sub>      | External output capacitor                                                   | 1.76 | 2.2               | 8.16 | μF   |       |
| ESR                   | External output capacitor equivalent series resistance                      | 1    | —                 | 100  | mΩ   |       |
| I <sub>LIM</sub>      | Short circuit current                                                       | —    | 290               | —    | mA   |       |

1. Typical values assume VREGIN = 5.0 V, Temp = 25 °C unless otherwise stated.

2. Operating in pass-through mode: regulator output voltage equal to the input voltage minus a drop proportional to I<sub>Load</sub>.

### 3.8.3 DSPI switching specifications (limited voltage range)

The Deserial Serial Peripheral Interface (DSPI) provides a synchronous serial bus with master and slave operations. Many of the transfer attributes are programmable. The tables below provide DSPI timing characteristics for classic SPI timing modes. Refer to the SPI chapter of the Reference Manual for information on the modified transfer formats used for communicating with slower peripheral devices.

**Table 37. Master mode DSPI timing (limited voltage range)**

| Num | Description                                     | Min.                       | Max.                      | Unit | Notes |
|-----|-------------------------------------------------|----------------------------|---------------------------|------|-------|
|     | Operating voltage                               | 2.7                        | 3.6                       | V    |       |
|     | Frequency of operation                          | —                          | 30                        | MHz  |       |
| DS1 | DSPI_SCK output cycle time                      | 2 × t <sub>BUS</sub>       | —                         | ns   |       |
| DS2 | DSPI_SCK output high/low time                   | (t <sub>SCK</sub> /2) – 2  | (t <sub>SCK</sub> /2) + 2 | ns   |       |
| DS3 | DSPI_PCS <sub>n</sub> valid to DSPI_SCK delay   | (t <sub>BUS</sub> × 2) – 2 | —                         | ns   | 1     |
| DS4 | DSPI_SCK to DSPI_PCS <sub>n</sub> invalid delay | (t <sub>BUS</sub> × 2) – 2 | —                         | ns   | 2     |
| DS5 | DSPI_SCK to DSPI_SOUT valid                     | —                          | 8.5                       | ns   |       |
| DS6 | DSPI_SCK to DSPI_SOUT invalid                   | -2                         | —                         | ns   |       |
| DS7 | DSPI_SIN to DSPI_SCK input setup                | 16.2                       | —                         | ns   |       |
| DS8 | DSPI_SCK to DSPI_SIN input hold                 | 0                          | —                         | ns   |       |

1. The delay is programmable in SPIx\_CTARn[PSSCK] and SPIx\_CTARn[CSSCK].

2. The delay is programmable in SPIx\_CTARn[PASC] and SPIx\_CTARn[ASC].

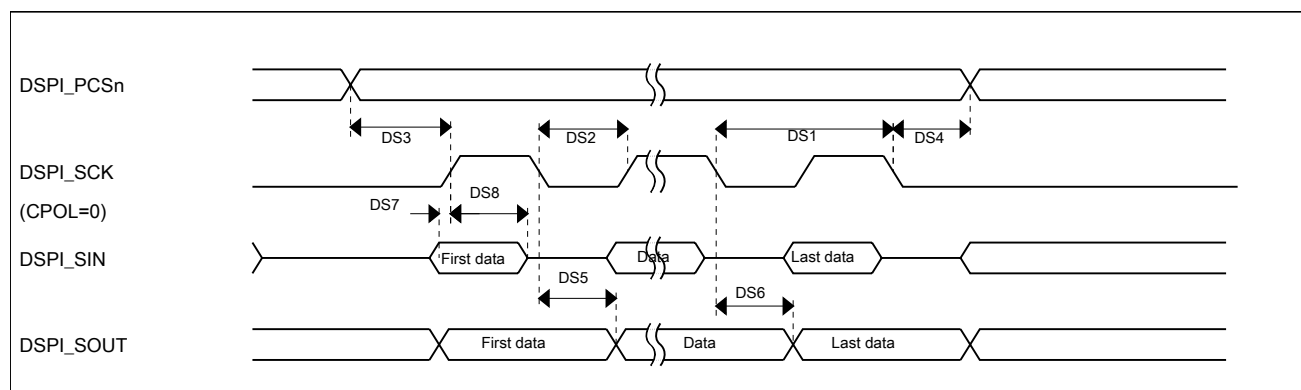


Figure 19. DSPI classic SPI timing — master mode

Table 38. Slave mode DSPI timing (limited voltage range)

| Num  | Description                              | Min.               | Max.              | Unit | Notes |
|------|------------------------------------------|--------------------|-------------------|------|-------|
|      | Operating voltage                        | 2.7                | 3.6               | V    |       |
|      | Frequency of operation                   | —                  | 15                | MHz  | 1     |
| DS9  | DSPI_SCK input cycle time                | $4 \times t_{BUS}$ | —                 | ns   |       |
| DS10 | DSPI_SCK input high/low time             | $(t_{SCK}/2) - 2$  | $(t_{SCK}/2) + 2$ | ns   |       |
| DS11 | DSPI_SCK to DSPI_SOUT valid              | —                  | 21.4              | ns   |       |
| DS12 | DSPI_SCK to DSPI_SOUT invalid            | 0                  | —                 | ns   |       |
| DS13 | DSPI_SS to DSPI_SCK input setup          | 2.6                | —                 | ns   |       |
| DS14 | DSPI_SCK to DSPI_SIN input hold          | 7                  | —                 | ns   |       |
| DS15 | DSPI_SS active to DSPI_SOUT driven       | —                  | 17                | ns   |       |
| DS16 | DSPI_SS inactive to DSPI_SOUT not driven | —                  | 17                | ns   |       |

1. The maximum operating frequency is measured with noncontinuous CS and SCK. When DSPI is configured with continuous CS and SCK, the SPI clock must not be greater than 1/6 of the bus clock. For example, when the bus clock is 60 MHz, the SPI clock must not be greater than 10 MHz.

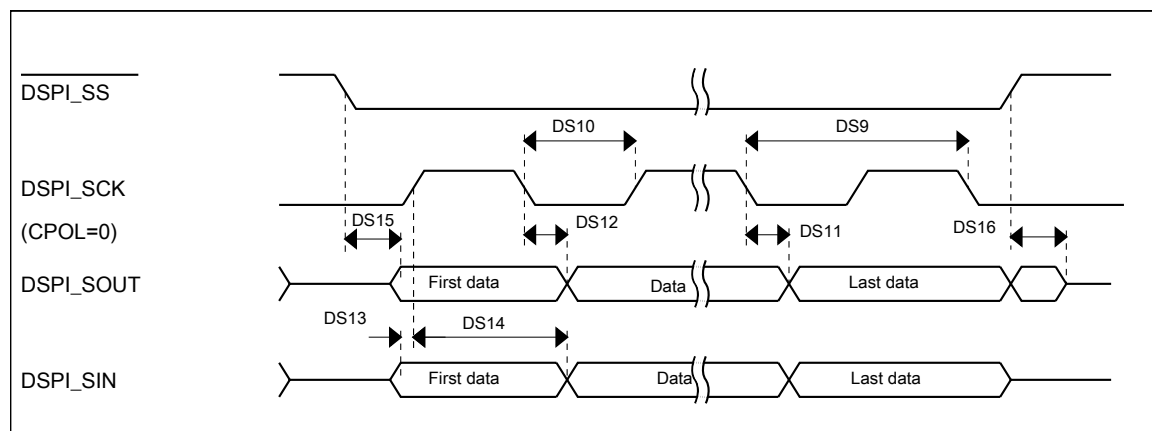


Figure 20. DSPI classic SPI timing — slave mode

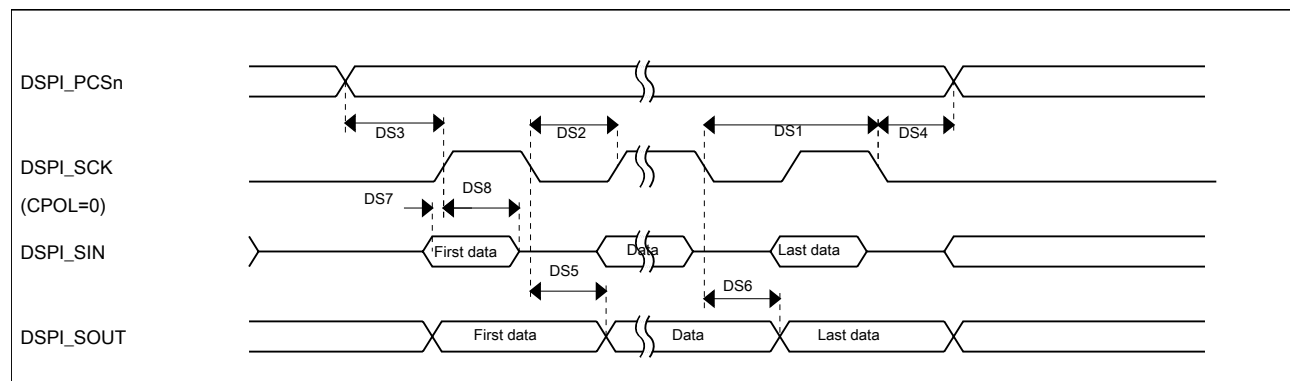
### 3.8.4 DSPI switching specifications (full voltage range)

The Deserial Serial Peripheral Interface (DSPI) provides a synchronous serial bus with master and slave operations. Many of the transfer attributes are programmable. The tables below provides DSPI timing characteristics for classic SPI timing modes. Refer to the SPI chapter of the Reference Manual for information on the modified transfer formats used for communicating with slower peripheral devices.

**Table 39. Master mode DSPI timing (full voltage range)**

| Num | Description                         | Min.                            | Max.                     | Unit | Notes |
|-----|-------------------------------------|---------------------------------|--------------------------|------|-------|
|     | Operating voltage                   | 1.71                            | 3.6                      | V    | 1     |
|     | Frequency of operation              | —                               | 15                       | MHz  |       |
| DS1 | DSPI_SCK output cycle time          | $4 \times t_{\text{BUS}}$       | —                        | ns   |       |
| DS2 | DSPI_SCK output high/low time       | $(t_{\text{SCK}}/2) - 4$        | $(t_{\text{SCK}}/2) + 4$ | ns   |       |
| DS3 | DSPI_PCSn valid to DSPI_SCK delay   | $(t_{\text{BUS}} \times 2) - 4$ | —                        | ns   | 2     |
| DS4 | DSPI_SCK to DSPI_PCSn invalid delay | $(t_{\text{BUS}} \times 2) - 4$ | —                        | ns   | 3     |
| DS5 | DSPI_SCK to DSPI_SOUT valid         | —                               | 10                       | ns   |       |
| DS6 | DSPI_SCK to DSPI_SOUT invalid       | -4.5                            | —                        | ns   |       |
| DS7 | DSPI_SIN to DSPI_SCK input setup    | 24.6                            | —                        | ns   |       |
| DS8 | DSPI_SCK to DSPI_SIN input hold     | 0                               | —                        | ns   |       |

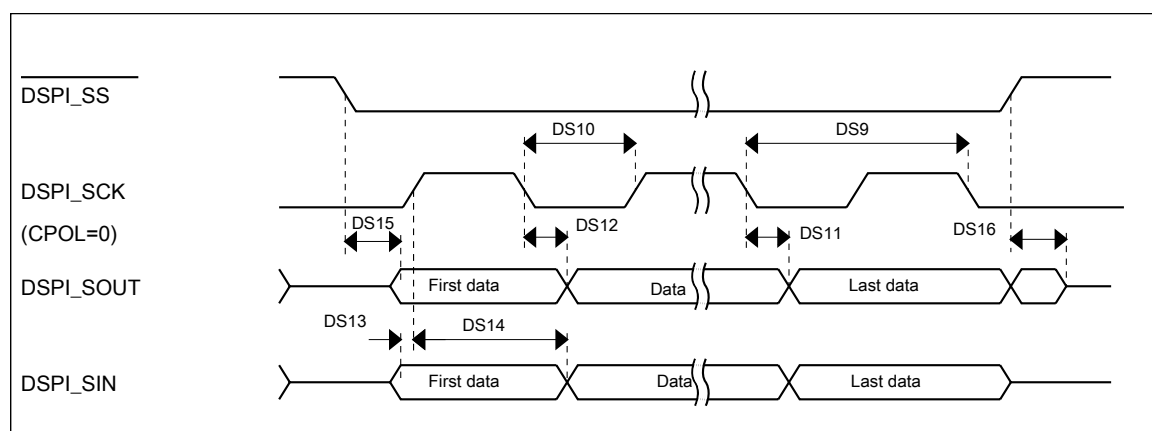
1. The DSPI module can operate across the entire operating voltage for the processor, but to run across the full voltage range the maximum frequency of operation is reduced.
2. The delay is programmable in SPIx\_CTARn[PSSCK] and SPIx\_CTARn[CSSCK].
3. The delay is programmable in SPIx\_CTARn[PASC] and SPIx\_CTARn[ASC].



**Figure 21. DSPI classic SPI timing — master mode**

**Table 40. Slave mode DSPI timing (full voltage range)**

| Num  | Description                              | Min.                      | Max.                     | Unit    |
|------|------------------------------------------|---------------------------|--------------------------|---------|
|      | Operating voltage                        | 1.71                      | 3.6                      | V       |
|      | Frequency of operation                   | —                         | 7.5                      | MHz     |
| DS9  | DSPI_SCK input cycle time                | $8 \times t_{\text{BUS}}$ | —                        | ns      |
| DS10 | DSPI_SCK input high/low time             | $(t_{\text{SCK}}/2) - 4$  | $(t_{\text{SCK}}/2) + 4$ | ns      |
| DS11 | DSPI_SCK to DSPI_SOUT valid              | —                         | 29.5                     | ns      |
| DS12 | DSPI_SCK to DSPI_SOUT invalid            | 0                         | —                        | ns      |
| DS13 | DSPI_SIN to DSPI_SCK input setup         | 3.2                       | —                        | ns      |
| DS14 | DSPI_SCK to DSPI_SIN input hold          | 7                         | —                        | ns      |
| DS15 | DSPI_SS active to DSPI_SOUT driven       | —                         | 25                       | ns </td |
| DS16 | DSPI_SS inactive to DSPI_SOUT not driven | —                         | 25                       | ns      |

**Figure 22. DSPI classic SPI timing — slave mode**

### 3.8.5 Inter-Integrated Circuit Interface (I<sup>2</sup>C) timing

**Table 41. I<sup>2</sup>C timing**

| Characteristic                                                                               | Symbol                | Standard Mode |         | Fast Mode |                  | Unit          |
|----------------------------------------------------------------------------------------------|-----------------------|---------------|---------|-----------|------------------|---------------|
|                                                                                              |                       | Minimum       | Maximum | Minimum   | Maximum          |               |
| SCL Clock Frequency                                                                          | $f_{\text{SCL}}$      | 0             | 100     | 0         | 400 <sup>1</sup> | kHz           |
| Hold time (repeated) START condition. After this period, the first clock pulse is generated. | $t_{\text{HD}}$ ; STA | 4             | —       | 0.6       | —                | $\mu\text{s}$ |
| LOW period of the SCL clock                                                                  | $t_{\text{LOW}}$      | 4.7           | —       | 1.25      | —                | $\mu\text{s}$ |
| HIGH period of the SCL clock                                                                 | $t_{\text{HIGH}}$     | 4             | —       | 0.6       | —                | $\mu\text{s}$ |
| Set-up time for a repeated START condition                                                   | $t_{\text{SU}}$ ; STA | 4.7           | —       | 0.6       | —                | $\mu\text{s}$ |

Table continues on the next page...

**Table 41. I<sup>2</sup>C timing (continued)**

| Characteristic                                                    | Symbol                | Standard Mode    |                   | Fast Mode                           |                  | Unit |
|-------------------------------------------------------------------|-----------------------|------------------|-------------------|-------------------------------------|------------------|------|
|                                                                   |                       | Minimum          | Maximum           | Minimum                             | Maximum          |      |
| Data hold time for I <sup>2</sup> C bus devices                   | t <sub>HD</sub> ; DAT | 0 <sup>2</sup>   | 3.45 <sup>3</sup> | 0 <sup>4</sup>                      | 0.9 <sup>2</sup> | μs   |
| Data set-up time                                                  | t <sub>SU</sub> ; DAT | 250 <sup>5</sup> | —                 | 100 <sup>3, 6</sup>                 | —                | ns   |
| Rise time of SDA and SCL signals                                  | t <sub>r</sub>        | —                | 1000              | 20 + 0.1C <sub>b</sub> <sup>7</sup> | 300              | ns   |
| Fall time of SDA and SCL signals                                  | t <sub>f</sub>        | —                | 300               | 20 + 0.1C <sub>b</sub> <sup>6</sup> | 300              | ns   |
| Set-up time for STOP condition                                    | t <sub>SU</sub> ; STO | 4                | —                 | 0.6                                 | —                | μs   |
| Bus free time between STOP and START condition                    | t <sub>BUF</sub>      | 4.7              | —                 | 1.3                                 | —                | μs   |
| Pulse width of spikes that must be suppressed by the input filter | t <sub>SP</sub>       | N/A              | N/A               | 0                                   | 50               | ns   |

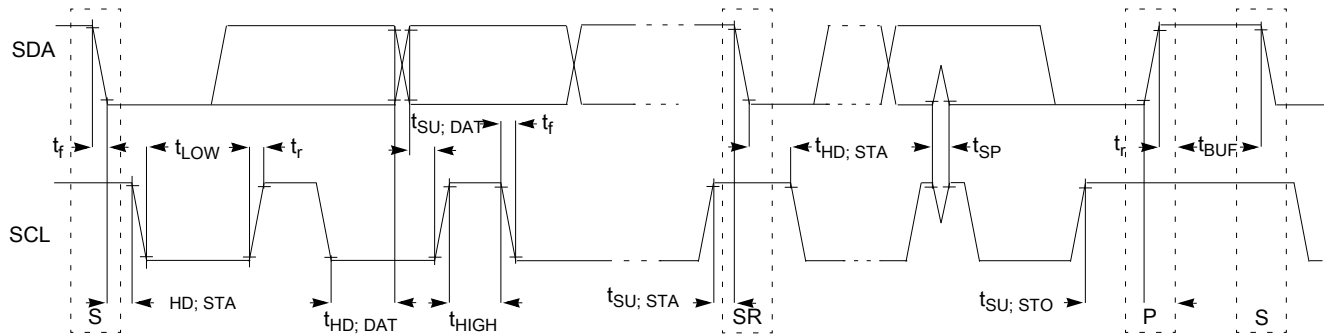
1. The maximum SCL Clock Frequency in Fast mode with maximum bus loading can only be achieved when using the High drive pins across the full voltage range and when using the Normal drive pins and VDD ≥ 2.7 V.
2. The master mode I<sup>2</sup>C deasserts ACK of an address byte simultaneously with the falling edge of SCL. If no slaves acknowledge this address byte, then a negative hold time can result, depending on the edge rates of the SDA and SCL lines.
3. The maximum t<sub>HD</sub>; DAT must be met only if the device does not stretch the LOW period (t<sub>LOW</sub>) of the SCL signal.
4. Input signal Slew = 10 ns and Output Load = 50 pF
5. Set-up time in slave-transmitter mode is 1 IPBus clock period, if the TX FIFO is empty.
6. A Fast mode I<sup>2</sup>C bus device can be used in a Standard mode I<sup>2</sup>C bus system, but the requirement t<sub>SU</sub>; DAT ≥ 250 ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, then it must output the next data bit to the SDA line t<sub>rmax</sub> + t<sub>SU</sub>; DAT = 1000 + 250 = 1250 ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.
7. C<sub>b</sub> = total capacitance of the one bus line in pF.

**Table 42. I<sup>2</sup>C 1 Mbps timing**

| Characteristic                                                                               | Symbol                | Minimum                             | Maximum        | Unit |
|----------------------------------------------------------------------------------------------|-----------------------|-------------------------------------|----------------|------|
| SCL Clock Frequency                                                                          | f <sub>SCL</sub>      | 0                                   | 1 <sup>1</sup> | MHz  |
| Hold time (repeated) START condition. After this period, the first clock pulse is generated. | t <sub>HD</sub> ; STA | 0.26                                | —              | μs   |
| LOW period of the SCL clock                                                                  | t <sub>LOW</sub>      | 0.5                                 | —              | μs   |
| HIGH period of the SCL clock                                                                 | t <sub>HIGH</sub>     | 0.26                                | —              | μs   |
| Set-up time for a repeated START condition                                                   | t <sub>SU</sub> ; STA | 0.26                                | —              | μs   |
| Data hold time for I <sup>2</sup> C bus devices                                              | t <sub>HD</sub> ; DAT | 0                                   | —              | μs   |
| Data set-up time                                                                             | t <sub>SU</sub> ; DAT | 50                                  | —              | ns   |
| Rise time of SDA and SCL signals                                                             | t <sub>r</sub>        | 20 + 0.1C <sub>b</sub> <sup>2</sup> | 120            | ns   |
| Fall time of SDA and SCL signals                                                             | t <sub>f</sub>        | 20 + 0.1C <sub>b</sub> <sup>2</sup> | 120            | ns   |
| Set-up time for STOP condition                                                               | t <sub>SU</sub> ; STO | 0.26                                | —              | μs   |
| Bus free time between STOP and START condition                                               | t <sub>BUF</sub>      | 0.5                                 | —              | μs   |
| Pulse width of spikes that must be suppressed by the input filter                            | t <sub>SP</sub>       | 0                                   | 50             | ns   |

## Peripheral operating requirements and behaviors

1. The maximum SCL clock frequency of 1 Mbps can support maximum bus loading when using the High drive pins across the full voltage range.
2.  $C_b$  = total capacitance of the one bus line in pF.



**Figure 23. Timing definition for devices on the I<sup>2</sup>C bus**

### 3.8.6 UART switching specifications

See [General switching specifications](#).

### 3.8.7 I2S/SAI switching specifications

This section provides the AC timing for the I2S/SAI module in master mode (clocks are driven) and slave mode (clocks are input). All timing is given for noninverted serial clock polarity (TCR2[BCP] is 0, RCR2[BCP] is 0) and a noninverted frame sync (TCR4[FSP] is 0, RCR4[FSP] is 0). If the polarity of the clock and/or the frame sync have been inverted, all the timing remains valid by inverting the bit clock signal (BCLK) and/or the frame sync (FS) signal shown in the following figures.

#### 3.8.7.1 Normal Run, Wait and Stop mode performance over a limited operating voltage range

This section provides the operating performance over a limited operating voltage for the device in Normal Run, Wait and Stop modes.

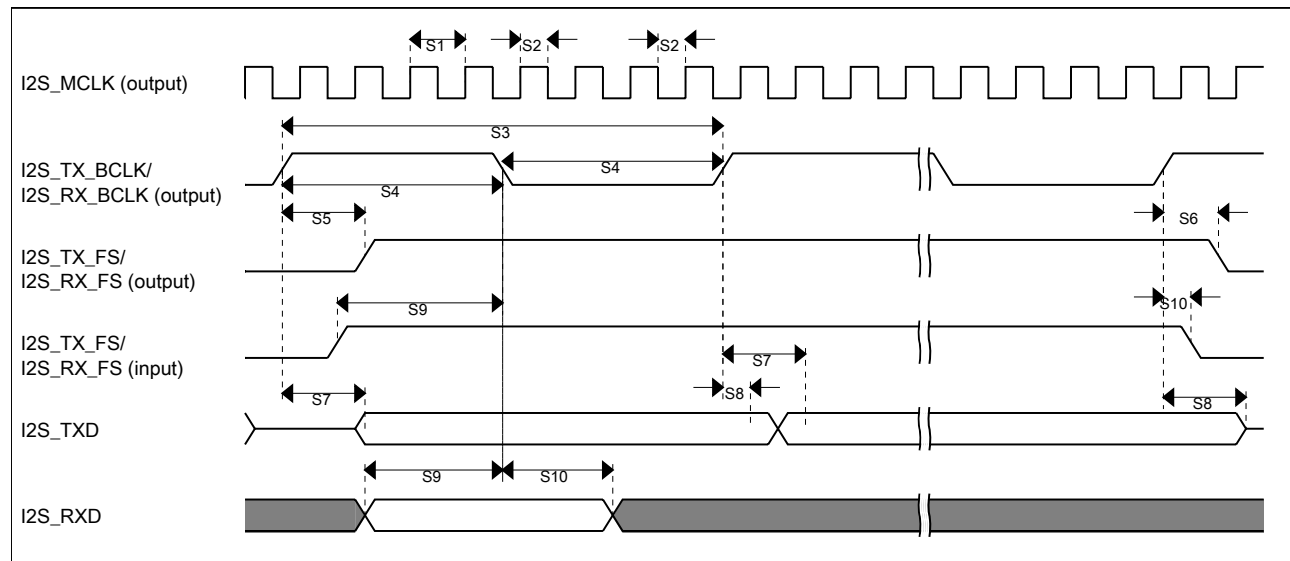
**Table 43. I2S/SAI master mode timing in Normal Run, Wait and Stop modes (limited voltage range)**

| Num. | Characteristic                | Min. | Max. | Unit        |
|------|-------------------------------|------|------|-------------|
|      | Operating voltage             | 2.7  | 3.6  | V           |
| S1   | I2S_MCLK cycle time           | 40   | —    | ns          |
| S2   | I2S_MCLK pulse width high/low | 45%  | 55%  | MCLK period |

*Table continues on the next page...*

**Table 43. I2S/SAI master mode timing in Normal Run, Wait and Stop modes (limited voltage range) (continued)**

| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
| S3   | I2S_TX_BCLK/I2S_RX_BCLK cycle time (output)                       | 80   | —    | ns          |
| S4   | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low                      | 45%  | 55%  | BCLK period |
| S5   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output valid   | —    | 15   | ns          |
| S6   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output invalid | 0    | —    | ns          |
| S7   | I2S_TX_BCLK to I2S_TXD valid                                      | —    | 15   | ns          |
| S8   | I2S_TX_BCLK to I2S_TXD invalid                                    | 0    | —    | ns          |
| S9   | I2S_RXD/I2S_RX_FS input setup before<br>I2S_RX_BCLK               | 18   | —    | ns          |
| S10  | I2S_RXD/I2S_RX_FS input hold after I2S_RX_BCLK                    | 0    | —    | ns          |

**Figure 24. I2S/SAI timing — master modes****Table 44. I2S/SAI slave mode timing in Normal Run, Wait and Stop modes (limited voltage range)**

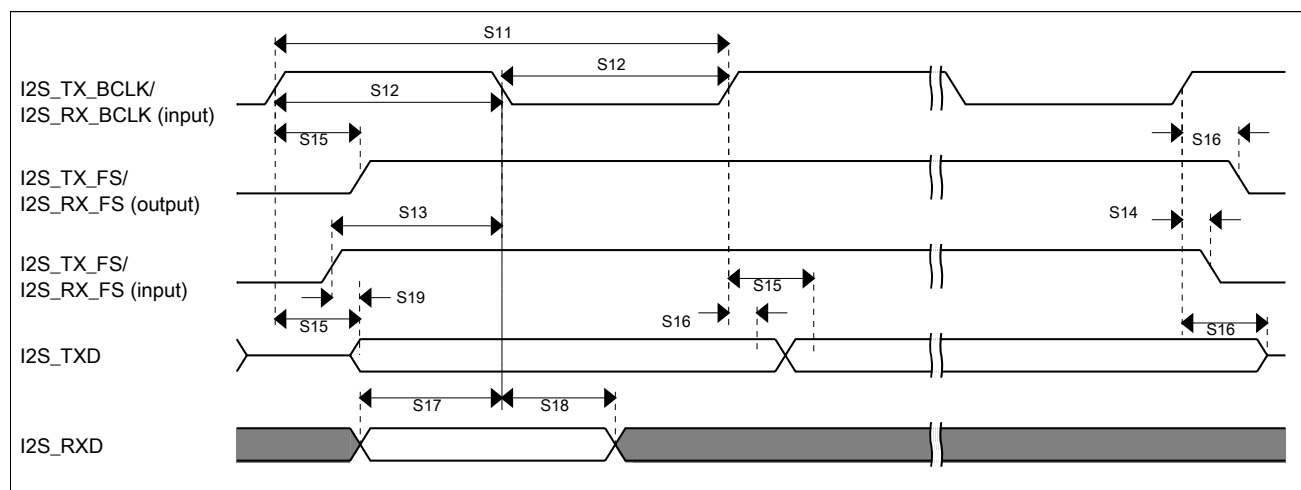
| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
|      | Operating voltage                                                 | 2.7  | 3.6  | V           |
| S11  | I2S_TX_BCLK/I2S_RX_BCLK cycle time (input)                        | 80   | —    | ns          |
| S12  | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low<br>(input)           | 45%  | 55%  | MCLK period |
| S13  | I2S_TX_FS/I2S_RX_FS input setup before<br>I2S_TX_BCLK/I2S_RX_BCLK | 4.5  | —    | ns          |

Table continues on the next page...

**Table 44. I2S/SAI slave mode timing in Normal Run, Wait and Stop modes (limited voltage range) (continued)**

| Num. | Characteristic                                                 | Min. | Max. | Unit |
|------|----------------------------------------------------------------|------|------|------|
| S14  | I2S_TX_FS/I2S_RX_FS input hold after I2S_TX_BCLK/I2S_RX_BCLK   | 2    | —    | ns   |
| S15  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output valid                  | —    | 20   | ns   |
| S16  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output invalid                | 0    | —    | ns   |
| S17  | I2S_RXD setup before I2S_RX_BCLK                               | 4.5  | —    | ns   |
| S18  | I2S_RXD hold after I2S_RX_BCLK                                 | 2    | —    | ns   |
| S19  | I2S_TX_FS input assertion to I2S_TXD output valid <sup>1</sup> | —    | 25   | ns   |

1. Applies to first bit in each frame and only if the TCR4[FSE] bit is clear

**Figure 25. I2S/SAI timing — slave modes**

### 3.8.7.2 Normal Run, Wait and Stop mode performance over the full operating voltage range

This section provides the operating performance over the full operating voltage for the device in Normal Run, Wait and Stop modes.

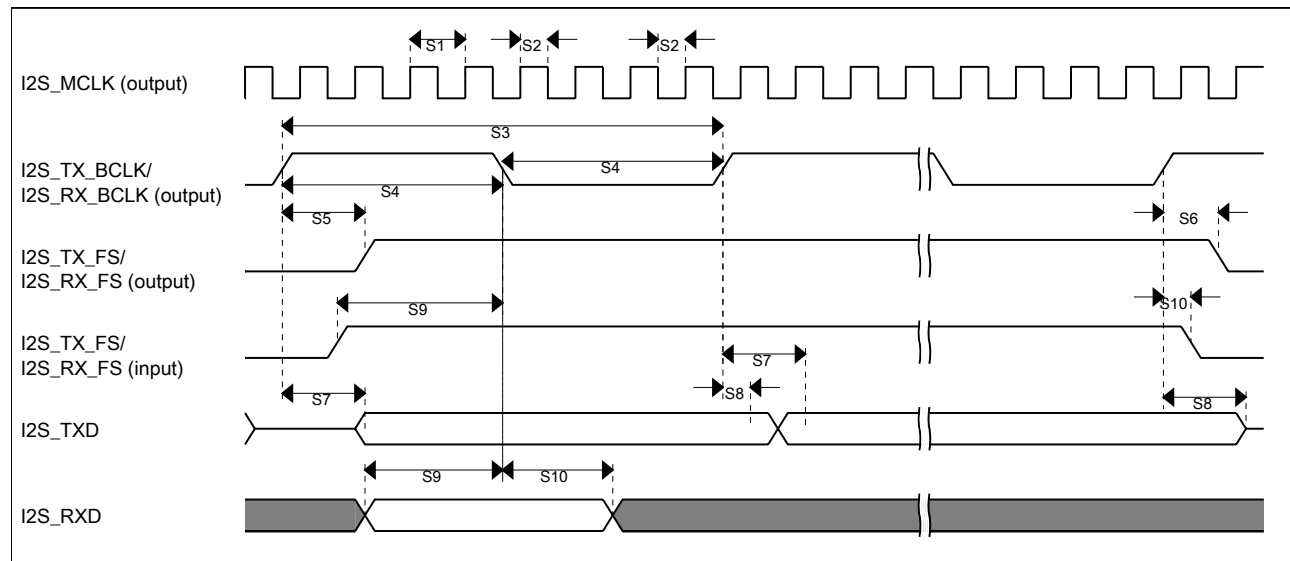
**Table 45. I2S/SAI master mode timing in Normal Run, Wait and Stop modes (full voltage range)**

| Num. | Characteristic                | Min. | Max. | Unit        |
|------|-------------------------------|------|------|-------------|
|      | Operating voltage             | 1.71 | 3.6  | V           |
| S1   | I2S_MCLK cycle time           | 40   | —    | ns          |
| S2   | I2S_MCLK pulse width high/low | 45%  | 55%  | MCLK period |

Table continues on the next page...

**Table 45. I2S/SAI master mode timing in Normal Run, Wait and Stop modes (full voltage range) (continued)**

| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
| S3   | I2S_TX_BCLK/I2S_RX_BCLK cycle time (output)                       | 80   | —    | ns          |
| S4   | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low                      | 45%  | 55%  | BCLK period |
| S5   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output valid   | —    | 15   | ns          |
| S6   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output invalid | -1.0 | —    | ns          |
| S7   | I2S_TX_BCLK to I2S_TXD valid                                      | —    | 15   | ns          |
| S8   | I2S_TX_BCLK to I2S_TXD invalid                                    | 0    | —    | ns          |
| S9   | I2S_RXD/I2S_RX_FS input setup before<br>I2S_RX_BCLK               | 27   | —    | ns          |
| S10  | I2S_RXD/I2S_RX_FS input hold after I2S_RX_BCLK                    | 0    | —    | ns          |

**Figure 26. I2S/SAI timing — master modes****Table 46. I2S/SAI slave mode timing in Normal Run, Wait and Stop modes (full voltage range)**

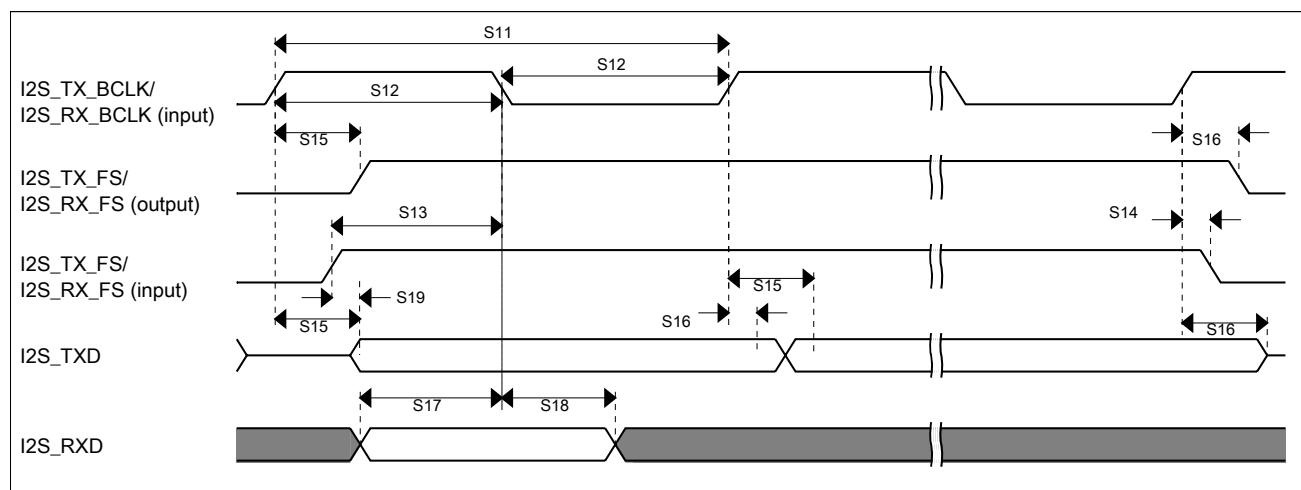
| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
|      | Operating voltage                                                 | 1.71 | 3.6  | V           |
| S11  | I2S_TX_BCLK/I2S_RX_BCLK cycle time (input)                        | 80   | —    | ns          |
| S12  | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low (input)              | 45%  | 55%  | MCLK period |
| S13  | I2S_TX_FS/I2S_RX_FS input setup before<br>I2S_TX_BCLK/I2S_RX_BCLK | 5.8  | —    | ns          |

Table continues on the next page...

**Table 46. I2S/SAI slave mode timing in Normal Run, Wait and Stop modes (full voltage range) (continued)**

| Num. | Characteristic                                                 | Min. | Max. | Unit |
|------|----------------------------------------------------------------|------|------|------|
| S14  | I2S_TX_FS/I2S_RX_FS input hold after I2S_TX_BCLK/I2S_RX_BCLK   | 2    | —    | ns   |
| S15  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output valid                  | —    | 28.5 | ns   |
| S16  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output invalid                | 0    | —    | ns   |
| S17  | I2S_RXD setup before I2S_RX_BCLK                               | 5.8  | —    | ns   |
| S18  | I2S_RXD hold after I2S_RX_BCLK                                 | 2    | —    | ns   |
| S19  | I2S_TX_FS input assertion to I2S_TXD output valid <sup>1</sup> | —    | 26.3 | ns   |

1. Applies to first bit in each frame and only if the TCR4[FSE] bit is clear

**Figure 27. I2S/SAI timing — slave modes**

### 3.8.7.3 VLPR, VLPW, and VLPS mode performance over the full operating voltage range

This section provides the operating performance over the full operating voltage for the device in VLPR, VLPW, and VLPS modes.

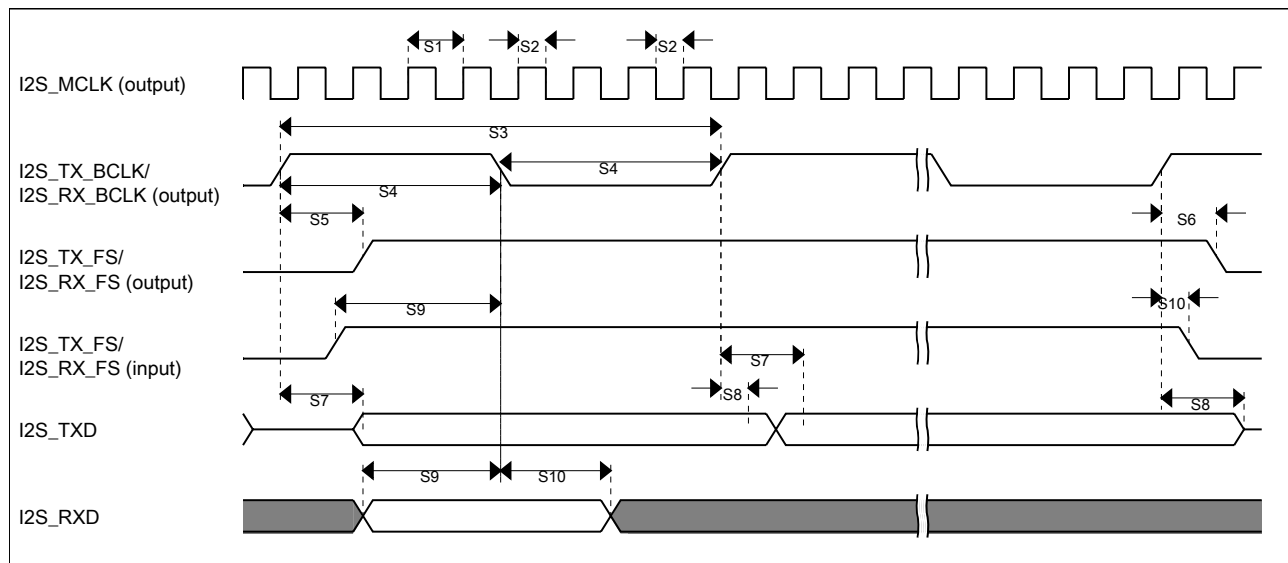
**Table 47. I2S/SAI master mode timing in VLPR, VLPW, and VLPS modes (full voltage range)**

| Num. | Characteristic                              | Min. | Max. | Unit        |
|------|---------------------------------------------|------|------|-------------|
|      | Operating voltage                           | 1.71 | 3.6  | V           |
| S1   | I2S_MCLK cycle time                         | 62.5 | —    | ns          |
| S2   | I2S_MCLK pulse width high/low               | 45%  | 55%  | MCLK period |
| S3   | I2S_TX_BCLK/I2S_RX_BCLK cycle time (output) | 250  | —    | ns          |

Table continues on the next page...

**Table 47. I2S/SAI master mode timing in VLPR, VLPW, and VLPS modes (full voltage range) (continued)**

| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
| S4   | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low                      | 45%  | 55%  | BCLK period |
| S5   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output valid   | —    | 45   | ns          |
| S6   | I2S_TX_BCLK/I2S_RX_BCLK to I2S_TX_FS/<br>I2S_RX_FS output invalid | -1   | —    | ns          |
| S7   | I2S_TX_BCLK to I2S_TXD valid                                      | —    | 45   | ns          |
| S8   | I2S_TX_BCLK to I2S_TXD invalid                                    | 0    | —    | ns          |
| S9   | I2S_RXD/I2S_RX_FS input setup before<br>I2S_RX_BCLK               | 45   | —    | ns          |
| S10  | I2S_RXD/I2S_RX_FS input hold after I2S_RX_BCLK                    | 0    | —    | ns          |

**Figure 28. I2S/SAI timing — master modes****Table 48. I2S/SAI slave mode timing in VLPR, VLPW, and VLPS modes (full voltage range)**

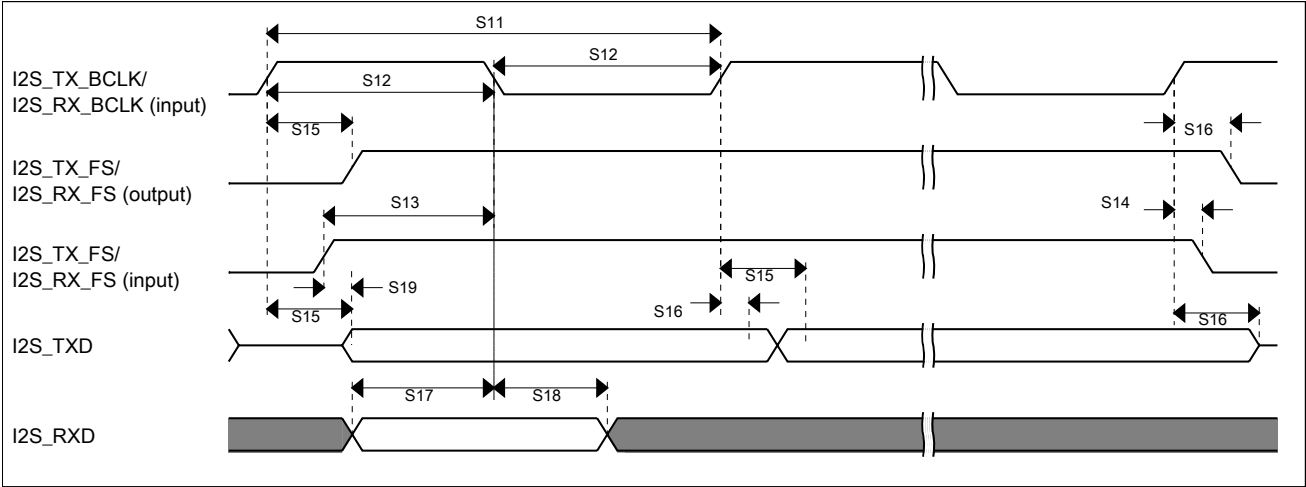
| Num. | Characteristic                                                    | Min. | Max. | Unit        |
|------|-------------------------------------------------------------------|------|------|-------------|
|      | Operating voltage                                                 | 1.71 | 3.6  | V           |
| S11  | I2S_TX_BCLK/I2S_RX_BCLK cycle time (input)                        | 250  | —    | ns          |
| S12  | I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low<br>(input)           | 45%  | 55%  | MCLK period |
| S13  | I2S_TX_FS/I2S_RX_FS input setup before<br>I2S_TX_BCLK/I2S_RX_BCLK | 30   | —    | ns          |
| S14  | I2S_TX_FS/I2S_RX_FS input hold after<br>I2S_TX_BCLK/I2S_RX_BCLK   | 7    | —    | ns          |
| S15  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output valid                     | —    | 63   | ns          |

Table continues on the next page...

**Table 48. I2S/SAI slave mode timing in VLPR, VLPW, and VLPS modes (full voltage range) (continued)**

| Num. | Characteristic                                                 | Min. | Max. | Unit |
|------|----------------------------------------------------------------|------|------|------|
| S16  | I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output invalid                | 0    | —    | ns   |
| S17  | I2S_RXD setup before I2S_RX_BCLK                               | 30   | —    | ns   |
| S18  | I2S_RXD hold after I2S_RX_BCLK                                 | 4    | —    | ns   |
| S19  | I2S_TX_FS input assertion to I2S_TXD output valid <sup>1</sup> | —    | 72   | ns   |

1. Applies to first bit in each frame and only if the TCR4[FSE] bit is clear



**Figure 29. I2S/SAI timing — slave modes**

4 Dimensions

4.1 Obtaining package dimensions

Package dimensions are provided in package drawings.

To find a package drawing, go to [nxp.com](http://nxp.com) and perform a keyword search for the drawing’s document number:

| If you want the drawing for this package | Then use this document number |
|------------------------------------------|-------------------------------|
| 64-pin WLCSP                             | 98ASA00650D                   |

## 5 Pinout

### 5.1 K22F Signal Multiplexing and Pin Assignments

The following table shows the signals available on each pin and the locations of these pins on the devices supported by this document. The Port Control Module is responsible for selecting which ALT functionality is available on each pin.

| 64 WLC SP | Pin Name                                | Default                                 | ALT0                                    | ALT1           | ALT2      | ALT3     | ALT4 | ALT5 | ALT6     | ALT7       | EzPort |
|-----------|-----------------------------------------|-----------------------------------------|-----------------------------------------|----------------|-----------|----------|------|------|----------|------------|--------|
| A8        | PTE0/CLKOUT32K                          | ADC1_SE4a                               | ADC1_SE4a                               | PTE0/CLKOUT32K | SPI1_PCS1 | UART1_TX |      |      | I2C1_SDA | RTC_CLKOUT |        |
| B8        | PTE1/LLWU_P0                            | ADC1_SE5a                               | ADC1_SE5a                               | PTE1/LLWU_P0   | SPI1_SOUT | UART1_RX |      |      | I2C1_SCL | SPI1_SIN   |        |
| D5        | VDD                                     | VDD                                     | VDD                                     |                |           |          |      |      |          |            |        |
| D6        | VSS                                     | VSS                                     | VSS                                     |                |           |          |      |      |          |            |        |
| C8        | USB0_DP                                 | USB0_DP                                 | USB0_DP                                 |                |           |          |      |      |          |            |        |
| D8        | USB0_DM                                 | USB0_DM                                 | USB0_DM                                 |                |           |          |      |      |          |            |        |
| C7        | VOUT33                                  | VOUT33                                  | VOUT33                                  |                |           |          |      |      |          |            |        |
| D7        | VREGIN                                  | VREGIN                                  | VREGIN                                  |                |           |          |      |      |          |            |        |
| E8        | ADC0_DP1                                | ADC0_DP1                                | ADC0_DP1                                |                |           |          |      |      |          |            |        |
| F8        | ADC0_DM1                                | ADC0_DM1                                | ADC0_DM1                                |                |           |          |      |      |          |            |        |
| E7        | ADC0_DP0/ADC1_DP3                       | ADC0_DP0/ADC1_DP3                       | ADC0_DP0/ADC1_DP3                       |                |           |          |      |      |          |            |        |
| F7        | ADC0_DM0/ADC1_DM3                       | ADC0_DM0/ADC1_DM3                       | ADC0_DM0/ADC1_DM3                       |                |           |          |      |      |          |            |        |
| G8        | VDDA                                    | VDDA                                    | VDDA                                    |                |           |          |      |      |          |            |        |
| F6        | VREFH                                   | VREFH                                   | VREFH                                   |                |           |          |      |      |          |            |        |
| G7        | VREFL                                   | VREFL                                   | VREFL                                   |                |           |          |      |      |          |            |        |
| H8        | VSSA                                    | VSSA                                    | VSSA                                    |                |           |          |      |      |          |            |        |
| G6        | VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18 | VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18 | VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18 |                |           |          |      |      |          |            |        |
| G5        | DAC0_OUT/ CMP1_IN3/ ADC0_SE23           | DAC0_OUT/ CMP1_IN3/ ADC0_SE23           | DAC0_OUT/ CMP1_IN3/ ADC0_SE23           |                |           |          |      |      |          |            |        |
| H7        | XTAL32                                  | XTAL32                                  | XTAL32                                  |                |           |          |      |      |          |            |        |
| H6        | EXTAL32                                 | EXTAL32                                 | EXTAL32                                 |                |           |          |      |      |          |            |        |
| H5        | VBAT                                    | VBAT                                    | VBAT                                    |                |           |          |      |      |          |            |        |

## Pinout

| 64<br>WLC<br>SP | Pin Name          | Default                               | ALT0                   | ALT1              | ALT2            | ALT3            | ALT4             | ALT5 | ALT6             | ALT7                   | EzPort   |
|-----------------|-------------------|---------------------------------------|------------------------|-------------------|-----------------|-----------------|------------------|------|------------------|------------------------|----------|
| F5              | PTA0              | JTAG_TCLK/<br>SWD_CLK/<br>EZP_CLK     |                        | PTA0              | UART0_<br>CTS_b | FTM0_CH5        |                  |      |                  | JTAG_TCLK/<br>SWD_CLK  | EZP_CLK  |
| E6              | PTA1              | JTAG_TDI/<br>EZP_DI                   |                        | PTA1              | UART0_RX        | FTM0_CH6        |                  |      |                  | JTAG_TDI               | EZP_DI   |
| E5              | PTA2              | JTAG_TDO/<br>TRACE_<br>SWO/<br>EZP_DO |                        | PTA2              | UART0_TX        | FTM0_CH7        |                  |      |                  | JTAG_TDO/<br>TRACE_SWO | EZP_DO   |
| E4              | PTA3              | JTAG_TMS/<br>SWD_DIO                  |                        | PTA3              | UART0_<br>RTS_b | FTM0_CH0        |                  |      |                  | JTAG_TMS/<br>SWD_DIO   |          |
| H4              | PTA4/<br>LLWU_P3  | NMI_b/<br>EZP_CS_b                    |                        | PTA4/<br>LLWU_P3  |                 | FTM0_CH1        |                  |      |                  | NMI_b                  | EZP_CS_b |
| G4              | PTA5              | DISABLED                              |                        | PTA5              | USB_CLKIN       | FTM0_CH2        |                  |      | I2S0_TX_<br>BCLK | JTAG_TRST_<br>b        |          |
| F4              | PTA12             | DISABLED                              |                        | PTA12             |                 | FTM1_CH0        |                  |      | I2S0_TXD0        | FTM1_QD_<br>PHA        |          |
| H3              | PTA13/<br>LLWU_P4 | DISABLED                              |                        | PTA13/<br>LLWU_P4 |                 | FTM1_CH1        |                  |      | I2S0_TX_FS       | FTM1_QD_<br>PHB        |          |
| G3              | VDD               | VDD                                   | VDD                    |                   |                 |                 |                  |      |                  |                        |          |
| H2              | VSS               | VSS                                   | VSS                    |                   |                 |                 |                  |      |                  |                        |          |
| H1              | PTA18             | EXTAL0                                | EXTAL0                 | PTA18             |                 | FTM0_FLT2       | FTM_CLKIN0       |      |                  |                        |          |
| G1              | PTA19             | XTAL0                                 | XTAL0                  | PTA19             |                 | FTM1_FLT0       | FTM_CLKIN1       |      | LPTMR0_<br>ALT1  |                        |          |
| G2              | RESET_b           | RESET_b                               | RESET_b                |                   |                 |                 |                  |      |                  |                        |          |
| F3              | PTB0/<br>LLWU_P5  | ADC0_SE8/<br>ADC1_SE8                 | ADC0_SE8/<br>ADC1_SE8  | PTB0/<br>LLWU_P5  | I2C0_SCL        | FTM1_CH0        |                  |      | FTM1_QD_<br>PHA  |                        |          |
| F2              | PTB1              | ADC0_SE9/<br>ADC1_SE9                 | ADC0_SE9/<br>ADC1_SE9  | PTB1              | I2C0_SDA        | FTM1_CH1        |                  |      | FTM1_QD_<br>PHB  |                        |          |
| E3              | PTB2              | ADC0_SE12                             | ADC0_SE12              | PTB2              | I2C0_SCL        | UART0_<br>RTS_b |                  |      | FTM0_FLT3        |                        |          |
| E1              | PTB3              | ADC0_SE13                             | ADC0_SE13              | PTB3              | I2C0_SDA        | UART0_<br>CTS_b |                  |      | FTM0_FLT0        |                        |          |
| E2              | PTB16             | DISABLED                              |                        | PTB16             | SPI1_SOUT       | UART0_RX        | FTM_CLKIN0       |      | EWM_IN           |                        |          |
| D1              | PTB17             | DISABLED                              |                        | PTB17             | SPI1_SIN        | UART0_TX        | FTM_CLKIN1       |      | EWM_OUT_b        |                        |          |
| D2              | PTB18             | DISABLED                              |                        | PTB18             |                 | FTM2_CH0        | I2S0_TX_<br>BCLK |      | FTM2_QD_<br>PHA  |                        |          |
| D3              | PTB19             | DISABLED                              |                        | PTB19             |                 | FTM2_CH1        | I2S0_TX_FS       |      | FTM2_QD_<br>PHB  |                        |          |
| C1              | PTC0              | ADC0_SE14                             | ADC0_SE14              | PTC0              | SPI0_PCS4       | PDB0_<br>EXTRG  | USB_SOF_<br>OUT  |      |                  |                        |          |
| C2              | PTC1/<br>LLWU_P6  | ADC0_SE15                             | ADC0_SE15              | PTC1/<br>LLWU_P6  | SPI0_PCS3       | UART1_<br>RTS_b | FTM0_CH0         |      | I2S0_TXD0        | LPUART0_<br>RTS_b      |          |
| C3              | PTC2              | ADC0_SE4b/<br>CMP1_IN0                | ADC0_SE4b/<br>CMP1_IN0 | PTC2              | SPI0_PCS2       | UART1_<br>CTS_b | FTM0_CH1         |      | I2S0_TX_FS       | LPUART0_<br>CTS_b      |          |

| 64 WLC SP | Pin Name           | Default                | ALT0                   | ALT1               | ALT2      | ALT3            | ALT4             | ALT5   | ALT6              | ALT7           | EzPort |
|-----------|--------------------|------------------------|------------------------|--------------------|-----------|-----------------|------------------|--------|-------------------|----------------|--------|
| B1        | PTC3/<br>LLWU_P7   | CMP1_IN1               | CMP1_IN1               | PTC3/<br>LLWU_P7   | SPI0_PCS1 | UART1_RX        | FTM0_CH2         | CLKOUT | I2S0_TX_<br>BCLK  | LPUART0_<br>RX |        |
| F1        | VSS                | VSS                    | VSS                    |                    |           |                 |                  |        |                   |                |        |
| D4        | VDD                | VDD                    | VDD                    |                    |           |                 |                  |        |                   |                |        |
| A1        | PTC4/<br>LLWU_P8   | DISABLED               |                        | PTC4/<br>LLWU_P8   | SPI0_PCS0 | UART1_TX        | FTM0_CH3         |        | CMP1_OUT          | LPUART0_TX     |        |
| B2        | PTC5/<br>LLWU_P9   | DISABLED               |                        | PTC5/<br>LLWU_P9   | SPI0_SCK  | LPTMR0_<br>ALT2 | I2S0_RXD0        |        | CMP0_OUT          | FTM0_CH2       |        |
| B3        | PTC6/<br>LLWU_P10  | CMP0_IN0               | CMP0_IN0               | PTC6/<br>LLWU_P10  | SPI0_SOUT | PDB0_<br>EXTRG  | I2S0_RX_<br>BCLK |        | I2S0_MCLK         |                |        |
| A2        | PTC7               | CMP0_IN1               | CMP0_IN1               | PTC7               | SPI0_SIN  | USB_SOF_<br>OUT | I2S0_RX_FS       |        |                   |                |        |
| C4        | PTC8               | ADC1_SE4b/<br>CMP0_IN2 | ADC1_SE4b/<br>CMP0_IN2 | PTC8               |           |                 | I2S0_MCLK        |        |                   |                |        |
| A3        | PTC9               | ADC1_SE5b/<br>CMP0_IN3 | ADC1_SE5b/<br>CMP0_IN3 | PTC9               |           |                 | I2S0_RX_<br>BCLK |        | FTM2_FLT0         |                |        |
| B4        | PTC10              | ADC1_SE6b              | ADC1_SE6b              | PTC10              | I2C1_SCL  |                 | I2S0_RX_FS       |        |                   |                |        |
| A4        | PTC11/<br>LLWU_P11 | ADC1_SE7b              | ADC1_SE7b              | PTC11/<br>LLWU_P11 | I2C1_SDA  |                 |                  |        |                   |                |        |
| D6        | VSS                | VSS                    | VSS                    |                    |           |                 |                  |        |                   |                |        |
| D5        | VDD                | VDD                    | VDD                    |                    |           |                 |                  |        |                   |                |        |
| A5        | PTD0/<br>LLWU_P12  | DISABLED               |                        | PTD0/<br>LLWU_P12  | SPI0_PCS0 | UART2_<br>RTS_b |                  |        | LPUART0_<br>RTS_b |                |        |
| B5        | PTD1               | ADC0_SE5b              | ADC0_SE5b              | PTD1               | SPI0_SCK  | UART2_<br>CTS_b |                  |        | LPUART0_<br>CTS_b |                |        |
| C5        | PTD2/<br>LLWU_P13  | DISABLED               |                        | PTD2/<br>LLWU_P13  | SPI0_SOUT | UART2_RX        |                  |        | LPUART0_<br>RX    | I2C0_SCL       |        |
| A6        | PTD3               | DISABLED               |                        | PTD3               | SPI0_SIN  | UART2_TX        |                  |        | LPUART0_TX        | I2C0_SDA       |        |
| B6        | PTD4/<br>LLWU_P14  | DISABLED               |                        | PTD4/<br>LLWU_P14  | SPI0_PCS1 | UART0_<br>RTS_b | FTM0_CH4         |        | EWM_IN            | SPI1_PCS0      |        |
| C6        | PTD5               | ADC0_SE6b              | ADC0_SE6b              | PTD5               | SPI0_PCS2 | UART0_<br>CTS_b | FTM0_CH5         |        | EWM_OUT_b         | SPI1_SCK       |        |
| A7        | PTD6/<br>LLWU_P15  | ADC0_SE7b              | ADC0_SE7b              | PTD6/<br>LLWU_P15  | SPI0_PCS3 | UART0_RX        | FTM0_CH6         |        | FTM0_FLT0         | SPI1_SOUT      |        |
| B7        | PTD7               | DISABLED               |                        | PTD7               |           | UART0_TX        | FTM0_CH7         |        | FTM0_FLT1         | SPI1_SIN       |        |

## 5.2 Recommended connection for unused analog and digital pins

The following table shows the recommended connections for analog interface pins if those analog interfaces are not used in the customer's application.

**Table 49. Recommended connection for unused analog interfaces**

| Pin Type        |                | Short recommendation                  | Detailed recommendation                      |
|-----------------|----------------|---------------------------------------|----------------------------------------------|
| Analog/non GPIO | PGAx/ADCx      | Float                                 | Analog input - Float                         |
| Analog/non GPIO | ADCx/CMPx      | Float                                 | Analog input - Float                         |
| Analog/non GPIO | VREF_OUT       | Float                                 | Analog output - Float                        |
| Analog/non GPIO | DACx_OUT       | Float                                 | Analog output - Float                        |
| Analog/non GPIO | RTC_WAKEUP_B   | Float                                 | Analog output - Float                        |
| Analog/non GPIO | XTAL32         | Float                                 | Analog output - Float                        |
| Analog/non GPIO | EXTAL32        | Float                                 | Analog input - Float                         |
| GPIO/Analog     | PTA18/EXTAL0   | Float                                 | Analog input - Float                         |
| GPIO/Analog     | PTA19/XTAL0    | Float                                 | Analog output - Float                        |
| GPIO/Analog     | PTx/ADCx       | Float                                 | Float (default is analog input)              |
| GPIO/Analog     | PTx/CMPx       | Float                                 | Float (default is analog input)              |
| GPIO/Digital    | PTA0/JTAG_TCLK | Float                                 | Float (default is JTAG with pulldown)        |
| GPIO/Digital    | PTA1/JTAG_TDI  | Float                                 | Float (default is JTAG with pullup)          |
| GPIO/Digital    | PTA2/JTAG_TDO  | Float                                 | Float (default is JTAG with pullup)          |
| GPIO/Digital    | PTA3/JTAG_TMS  | Float                                 | Float (default is JTAG with pullup)          |
| GPIO/Digital    | PTA4/NMI_b     | 10kΩ pullup or disable and float      | Pull high or disable in PCR & FOPT and float |
| GPIO/Digital    | PTx            | Float                                 | Float (default is disabled)                  |
| USB             | USB0_DP        | Float                                 | Float                                        |
| USB             | USB0_DM        | Float                                 | Float                                        |
| USB             | VOOUT33        | Tie to input and ground through 10kΩ  | Tie to input and ground through 10kΩ         |
| USB             | VREGIN         | Tie to output and ground through 10kΩ | Tie to output and ground through 10kΩ        |
| VBAT            | VBAT           | Float                                 | Float                                        |
| VDDA            | VDDA           | Always connect to VDD potential       | Always connect to VDD potential              |
| VREFH           | VREFH          | Always connect to VDD potential       | Always connect to VDD potential              |
| VREFL           | VREFL          | Always connect to VSS potential       | Always connect to VSS potential              |
| VSSA            | VSSA           | Always connect to VSS potential       | Always connect to VSS potential              |

## 5.3 K22F Pinouts

The following figure shows the pinout diagram for the devices supported by this document. Many signals may be multiplexed onto a single pin. To determine what signals can be used on which pin, see the previous section.

|   | 1                | 2                | 3                 | 4                  | 5                                   | 6                                                | 7                     | 8                  |   |
|---|------------------|------------------|-------------------|--------------------|-------------------------------------|--------------------------------------------------|-----------------------|--------------------|---|
| A | PTC4/<br>LLWU_P8 | PTC7             | PTC9              | PTC11/<br>LLWU_P11 | PTD0/<br>LLWU_P12                   | PTD3                                             | PTD6/<br>LLWU_P15     | PTE0/<br>CLKOUT32K | A |
| B | PTC3/<br>LLWU_P7 | PTC5/<br>LLWU_P9 | PTC6/<br>LLWU_P10 | PTC10              | PTD1                                | PTD4/<br>LLWU_P14                                | PTD7                  | PTE1/<br>LLWU_P0   | B |
| C | PTC0             | PTC1/<br>LLWU_P6 | PTC2              | PTC8               | PTD2/<br>LLWU_P13                   | PTD5                                             | VOUT33                | USB0_DP            | C |
| D | PTB17            | PTB18            | PTB19             | VDD                | VDD                                 | VSS                                              | VREGIN                | USB0_DM            | D |
| E | PTB3             | PTB16            | PTB2              | PTA3               | PTA2                                | PTA1                                             | ADC0_DP0/<br>ADC1_DP3 | ADC0_DP1           | E |
| F | VSS              | PTB1             | PTB0/<br>LLWU_P5  | PTA12              | PTA0                                | VREFH                                            | ADC0_DM0/<br>ADC1_DM3 | ADC0_DM1           | F |
| G | PTA19            | RESET_b          | VDD               | PTA5               | DAC0_OUT/<br>CMP1_IN3/<br>ADC0_SE23 | VREF_OUT/<br>CMP1_IN5/<br>CMP0_IN5/<br>ADC1_SE18 | VREFL                 | VDDA               | G |
| H | PTA18            | VSS              | PTA13/<br>LLWU_P4 | PTA4/<br>LLWU_P3   | VBAT                                | EXTAL32                                          | XTAL32                | VSSA               | H |
|   | 1                | 2                | 3                 | 4                  | 5                                   | 6                                                | 7                     | 8                  |   |

Figure 30. K22F 64 WLCSP pinout diagram (transparent top view)

## 6 Part identification

### 6.1 Description

Part numbers for the chip have fields that identify the specific part. You can use the values of these fields to determine the specific part you have received.

## 6.2 Format

Part numbers for this device have the following format:

Q K## A M FFF R T PP CC N

## 6.3 Fields

This table lists the possible values for each field in the part number (not all combinations are valid):

| Field | Description                 | Values                                                                                                                                                                                                      |
|-------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Q     | Qualification status        | <ul style="list-style-type: none"> <li>• M = Fully qualified, general market flow, full reel</li> <li>• P = Prequalification</li> <li>• K = Fully qualified, general market flow, 100 piece reel</li> </ul> |
| K##   | Kinetis family              | <ul style="list-style-type: none"> <li>• K22</li> </ul>                                                                                                                                                     |
| A     | Key attribute               | <ul style="list-style-type: none"> <li>• D = Cortex-M4 w/ DSP</li> <li>• F = Cortex-M4 w/ DSP and FPU</li> </ul>                                                                                            |
| M     | Flash memory type           | <ul style="list-style-type: none"> <li>• N = Program flash only</li> <li>• X = Program flash and FlexMemory</li> </ul>                                                                                      |
| FFF   | Program flash memory size   | <ul style="list-style-type: none"> <li>• 128 = 128 KB</li> <li>• 256 = 256 KB</li> <li>• 512 = 512 KB</li> </ul>                                                                                            |
| R     | Silicon revision            | <ul style="list-style-type: none"> <li>• Z = Initial</li> <li>• (Blank) = Main</li> <li>• A = Revision after main</li> </ul>                                                                                |
| T     | Temperature range (°C)      | <ul style="list-style-type: none"> <li>• V = -40 to 105</li> <li>• C = -40 to 85</li> </ul>                                                                                                                 |
| PP    | Package identifier          | <ul style="list-style-type: none"> <li>• AH = 64 WLCSP (3.36 mm x 3.33 mm)</li> </ul>                                                                                                                       |
| CC    | Maximum CPU frequency (MHz) | <ul style="list-style-type: none"> <li>• 5 = 50 MHz</li> <li>• 7 = 72 MHz</li> <li>• 10 = 100 MHz</li> <li>• 12 = 120 MHz</li> <li>• 15 = 150 MHz</li> </ul>                                                |
| N     | Packaging type              | <ul style="list-style-type: none"> <li>• R = Tape and reel</li> </ul>                                                                                                                                       |

## 6.4 Example

This is an example part number:

MK22FN256CAH12R

## 6.5 64-pin WLCSP part marking

The 64-pin WLCSP package parts follow the part-marking scheme in the following table.

**Table 50. 64-pin WLCSP part marking**

| MK Part number  | MK Part Marking |
|-----------------|-----------------|
| MK22FN256CAH12R | MK22FN256CAH12  |
| MK22FN128CAH12R | MK22FN128CAH12  |

## 7 Terminology and guidelines

### 7.1 Definitions

Key terms are defined in the following table:

| Term                  | Definition                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rating                | <p>A minimum or maximum value of a technical characteristic that, if exceeded, may cause permanent chip failure:</p> <ul style="list-style-type: none"> <li>• <i>Operating ratings</i> apply during operation of the chip.</li> <li>• <i>Handling ratings</i> apply when the chip is not powered.</li> </ul> <p><b>NOTE:</b> The likelihood of permanent chip failure increases rapidly as soon as a characteristic begins to exceed one of its operating ratings.</p> |
| Operating requirement | A specified value or range of values for a technical characteristic that you must guarantee during operation to avoid incorrect operation and possibly decreasing the useful life of the chip                                                                                                                                                                                                                                                                          |
| Operating behavior    | A specified value or range of values for a technical characteristic that are guaranteed during operation if you meet the operating requirements and any other specified conditions                                                                                                                                                                                                                                                                                     |
| Typical value         | <p>A specified value for a technical characteristic that:</p> <ul style="list-style-type: none"> <li>• Lies within the range of values specified by the operating behavior</li> <li>• Is representative of that characteristic during operation when you meet the <a href="#">typical-value conditions</a> or other specified conditions</li> </ul> <p><b>NOTE:</b> Typical values are provided as design guidelines and are neither tested nor guaranteed.</p>        |

## 7.2 Examples

*Operating rating:*

| Symbol   | Description               | Min. | Max. | Unit |
|----------|---------------------------|------|------|------|
| $V_{DD}$ | 1.0 V core supply voltage | -0.3 | 1.2  | V    |

*Operating requirement:*

| Symbol   | Description               | Min. | Max. | Unit |
|----------|---------------------------|------|------|------|
| $V_{DD}$ | 1.0 V core supply voltage | 0.9  | 1.1  | V    |

*Operating behavior that includes a typical value:*

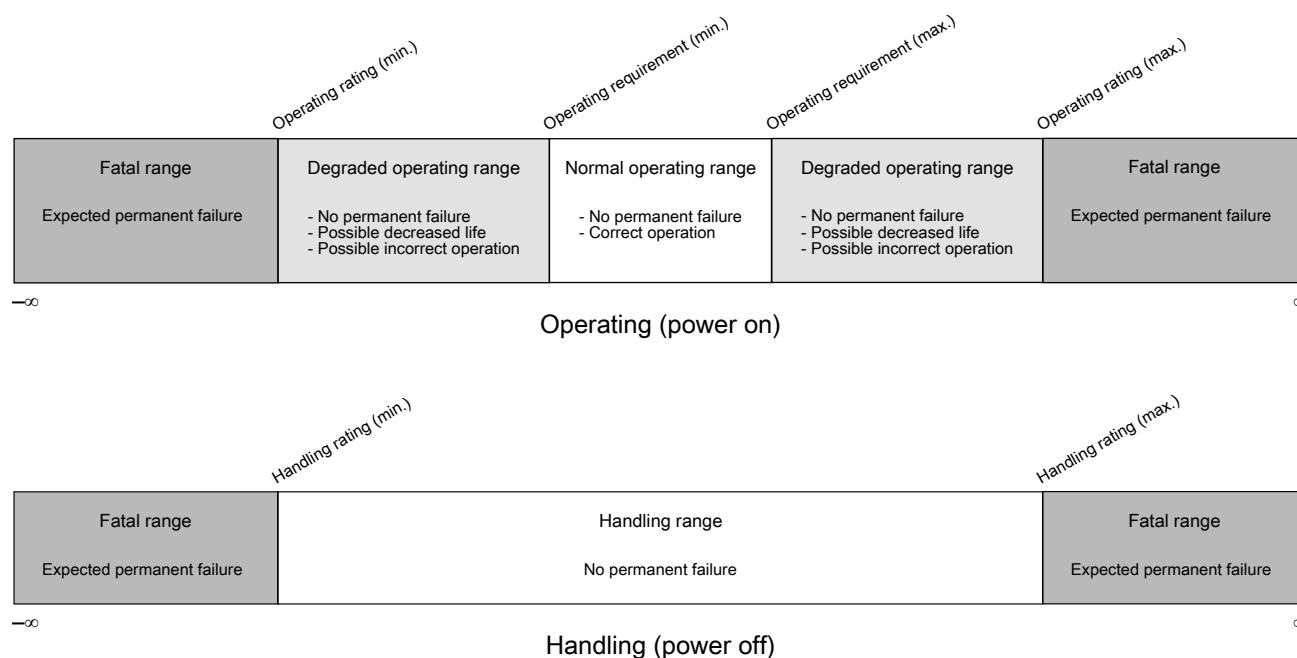
| Symbol   | Description                              | Min. | Typ. | Max. | Unit    |
|----------|------------------------------------------|------|------|------|---------|
| $I_{WP}$ | Digital I/O weak pullup/pulldown current | 10   | 70   | 130  | $\mu A$ |

## 7.3 Typical-value conditions

Typical values assume you meet the following conditions (or other conditions as specified):

| Symbol   | Description         | Value | Unit        |
|----------|---------------------|-------|-------------|
| $T_A$    | Ambient temperature | 25    | $^{\circ}C$ |
| $V_{DD}$ | Supply voltage      | 3.3   | V           |

## 7.4 Relationship between ratings and operating requirements



## 7.5 Guidelines for ratings and operating requirements

Follow these guidelines for ratings and operating requirements:

- Never exceed any of the chip's ratings.
- During normal operation, don't exceed any of the chip's operating requirements.
- If you must exceed an operating requirement at times other than during normal operation (for example, during power sequencing), limit the duration as much as possible.

## 8 Revision History

The following table provides a revision history for this document.

**Table 51. Revision History**

| Rev. No. | Date    | Substantial Changes                                                                                                                                                                                                                               |
|----------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7        | 08/2016 | <ul style="list-style-type: none"> <li>• Added Terminology and Guideline section</li> <li>• Added Device Revision Number Table</li> <li>• Editorial Updates</li> <li>• Updated Chip Errata naming convention in Related Resource table</li> </ul> |

*Table continues on the next page...*

**Table 51. Revision History (continued)**

| Rev. No. | Date    | Substantial Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|----------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6        | 10/2015 | <ul style="list-style-type: none"> <li>In "Power consumption operating behaviors" section, added "Low power mode peripheral adders—typical value" table</li> <li>In "Thermal operating requirements" table, in footnote, corrected "<math>T_J = T_A + \Theta_{JA}</math>" to "<math>T_J = T_A + R_{\Theta JA}</math>"</li> <li>Updated "IRC48M specifications" table</li> <li>Updated "NVM program/erase timing specifications" table; updated values for <math>t_{hversall}</math> (Erase All high-voltage time)</li> <li>In "Slave mode DSPI timing (limited voltage range)" table, added footnote regarding maximum frequency of operation</li> <li>Added new section, "Recommended connections for unused analog and digital pins"</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 5        | 4/2015  | <ul style="list-style-type: none"> <li>On page 1: <ul style="list-style-type: none"> <li>In first bullet of introduction, updated power consumption data to align with the data in the "Power consumption operating behaviors" table</li> <li>In second bullet of introduction, added "USB FS device crystal-less functionality"</li> <li>Under "Security and integrity modules" added "Hardware random-number generator"</li> <li>Under "Communication interfaces," updated I<sup>2</sup>C bullet to indicate support for up to 1 Mbps operation</li> <li>Under "Operating characteristics," specified that voltage range includes flash writes</li> </ul> </li> <li>In figure, "Functional block diagram," added "Random-number generator."</li> <li>In "Voltage and current operating requirements" table: <ul style="list-style-type: none"> <li>Removed content related to positive injection</li> <li>Updated footnote 1 to say that all analog and I/O pins are internally clamped to <math>V_{SS}</math> only (not <math>V_{SS}</math> and <math>V_{DD}</math>) through ESD protection diodes.</li> </ul> </li> <li>In "Power consumption operating behaviors" table: <ul style="list-style-type: none"> <li>Added additional temperature data in power consumption table</li> <li>Added Max IDD values based on characterization results equivalent to mean + 3 sigma</li> </ul> </li> <li>Updated "EMC radiated emissions operating behaviors" table</li> <li>In "Thermal operating requirements" table, added the following footnote for ambient temperature: "Maximum <math>T_A</math> can be exceeded only if the user ensures that <math>T_J</math> does not exceed maximum <math>T_J</math>. The simplest method to determine <math>T_J</math> is: <math>T_J = T_A + \Theta_{JA} \times</math> chip power dissipation"</li> <li>Updated "IRC48M Specifications": <ul style="list-style-type: none"> <li>Updated maximum values for <math>\Delta_{firc48m\_ol\_lv}</math> and <math>\Delta_{firc48m\_ol\_hv}</math> (full temperature)</li> <li>Added specifications for <math>\Delta_{firc48m\_ol\_hv}</math> (-40°C to 85°C)</li> </ul> </li> <li>Updated notes in "USB electrical specifications" section</li> <li>In "I<sup>2</sup>C timing" table, <ul style="list-style-type: none"> <li>Added the following footnote on maximum Fast mode value for SCL Clock Frequency: "The maximum SCL Clock Frequency in Fast mode with maximum bus loading can only be achieved when using the High drive pins across the full voltage range and when using the Normal drive pins and <math>V_{DD} \geq 2.7</math> V."</li> <li>Updated minimum Fast mode value for LOW period of the SCL clock to 1.25 <math>\mu</math></li> </ul> </li> <li>Added "I<sup>2</sup>C 1 Mbps timing" table</li> <li>Removed Section 6, "Ordering parts."</li> <li>Added "64-pin WLCSP part marking" section</li> </ul> |
| 4        | 12/2014 | Initial public release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |

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